

Click here to ask an associate for production status of specific part numbers.

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

General Description

The MAX77714 is a complete power-management IC (PMIC) for portable devices using System-on-Chip (SoC) applications processors.

Two 2A (SD2/3), one 3A (SD1), and one 4A (SD0) stepdown regulator switch at 2MHz, allowing the use of small magnetic components. The output voltages for SD0 and SD1 are programmable from 0.26V to 1.52V in 10mV steps. The output voltage for SD2 is programmable from 0.6V to 2.194V in 6.5mV steps. The output voltage for SD3 is programmable from 0.6V to 3.78V in 12.5mV steps.

Nine low-dropout (LDO) linear regulators supply power to various system blocks. Each LDO features a programmable active-discharge circuit in shutdown. All LDOs feature two soft-start rates to limit inrush current during startup.

Eight programmable GPIOs can be programmed as general purpose inputs (GPI), general purpose outputs (GPO), or alternate modes for additional functionalities.

The real-time clock (RTC) with an external crystal oscillator provides time keeping and alarm wake-up functions. An internal silicon oscillator is available for systems that do not want to use the crystal oscillator. In addition, a watchdog timer is integrated for system monitoring purposes.

An integrated ON/OFF controller, in combination with flexible power sequencer (FPS), provides maximum flexibility in setting power-up/down sequences with minimal intervention from the applications processor.

The 70-bump, 4.1mm x 3.25mm x 0.7mm, 0.4mm pitch wafer-level package (WLP) is ideal for space constrained applications.

Factory-programmable options allow the MAX77714 to be tailored for many applications. Contact the factory for more information about programmable options; minimum order quantities may apply.

Applications

- Drones
- Smartphones/Tablet PCs
- Handheld Gaming Devices
- AR/VR Headsets
- Streaming Devices/Set-Top Boxes
- Home Automation Hubs
- Digital Cameras
- Automotive Aftermarket Accessories

Benefits and Features

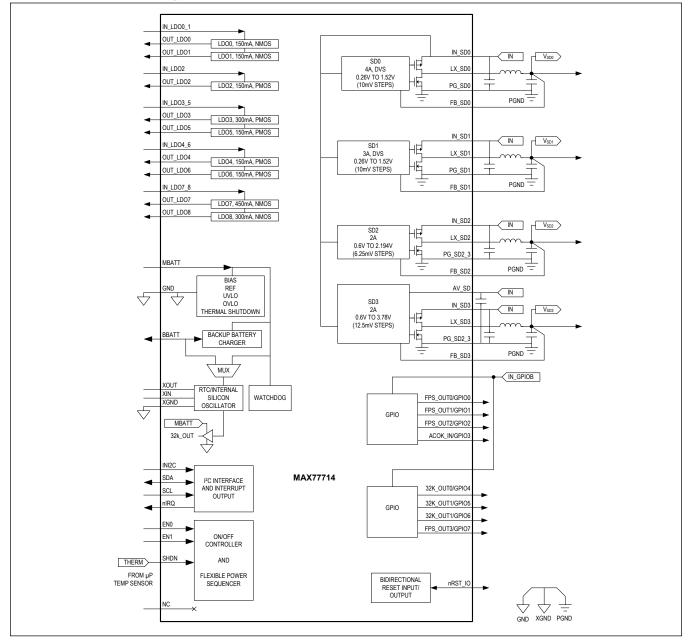
- Highly Integrated
 - 4x Buck Regulators
 - SD0/1 Peak Efficiency > 90% at 3.6V_{IN}, 1.1V_{OUT}
 - SD2/3 Peak Efficiency > 93% at 3.6V_{IN}, 1.8V_{OUT}
 - Supports LDDR4x Memory requirements
 - 9x Low-Dropout Linear Regulator
 - Eight GPIOs
 - Real-Time Clock
 - Backup Battery Charger
 - Bidirectional Reset I/O
 - Interrupt Output
 - System Watchdog Timer
- Flexible and Configurable
 - I²C-Compatible Interface
 - Factory OTP Options Available
 - Flexible Power Sequencer
 - Configurable Power-Up/Power-Down/Sleep Mode Entry/Exit Timing
 - Highly Configurable GPIO ALT Modes
 - Three Resources Can Be Configured as 32kHz
 Oscillator Output
 - Four Resources Can Be Configured on FPS
 - One Resource Can Be Configured as ACOK Input
- Low Power
 - Low I_O of 85µA in Sleep Mode
 - SD0/1 Low-Power Quiescent Current is 10µA
 - SD2/3 Low-Power Quiescent Current is 5µA
 - LDO Low-Power Quiescent Current is 1.5µA
- Small Size
 - 70-Bump, 0.4mm Pitch, 10x7 Ball Array WLP, 4.1mm x 3.25mm x 0.7mm Package Size
 - 230mm² Total Solution Size

Ordering Information appears at end of data sheet.

© 2023 Analog Devices, Inc. All rights reserved. Trademarks and registered trademarks are the property of their respective owners.

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Simplified Block Diagram



Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

TABLE OF CONTENTS

General Description	. 1
Applications	. 1
Benefits and Features	. 1
Simplified Block Diagram	. 2
Absolute Maximum Ratings	. 8
Package Information	. 8
WLP	. 8
Electrical Characteristics—Global Resources	10
Electrical Characteristics—ON/OFF Controller	14
Electrical Characteristics—Flexible Power Supply (FPS)	15
Electrical Characteristics—Step-Down Regulators (SD0–4A Output)	15
Electrical Characteristics—Step-Down Regulators (SD1–3A Output)	17
Electrical Characteristics—Step-Down Regulators (SD2/3–2A Output)	19
Electrical Characteristics—150mA PMOS LDO (LDO2, LDO4, LDO5, LDO6)	21
Electrical Characteristics—300mA PMOS LDO (LDO3)	23
Electrical Characteristics—150mA NMOS LDO (LDO0, LDO1)	25
Electrical Characteristics—300mA NMOS LDO (LDO8)	26
Electrical Characteristics—450mA NMOS LDO (LDO7)	28
Electrical Characteristics—GPIO	30
Electrical Characteristics—32kHz Oscillator	31
Electrical Characteristics—Backup Battery Charger	31
Typical Operating Characteristics	33
Bump Configuration	38
MAX77714	38
Bump Description	38
Detailed Description	42
OTP Options.	42
Detailed Description—Global Resources	43
Voltage References, Bias Currents, and Timing References.	43
Voltage Monitors	43
Thermal Monitors	43
Bidirectional Reset Input/Output.	43
Global Shutdown	45
Global Shutdown Events with Sequenced Shutdown and Automatic Wakeup	45
Global Shutdown Events with Sequenced Shutdown to the OFF State	45
Global Shutdown Events with Immediate Shutdown	46
System Watchdog Timer	46
EN0 Functionality	47
Interrupt Logic	47

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

TABLE OF CONTENTS (CONTINUED)

Detailed Description—ON/OFF Controller	48
ON/OFF Controller	48
Power-Up/Down Sequence	51
Immediate Shutdown	53
RESET	54
EN0	54
EN1	54
ACOK	54
SHDN	55
SMPL, ALARM1, and ALARM2	55
MBATT_OK and MBATTLOW	55
Resource Power Mode	55
Detailed Description—Flexible Power Supply (FPS).	56
Power-Off Event Recorder	56
Flexible Power Sequencer (FPS)	56
Features	57
FPS0	57
FPS1	58
FPS Sequence Power-Up/Down	58
FPS Sequence Sleep Entry/Exit.	59
Detailed Description—Step-Down Regulators (SD0–4A Output)	59
Active Discharge	59
Output Monitoring.	60
Enable and Power Mode Control	60
PCB Layout Guidelines	61
Detailed Description—Step-Down Regulators (SD1–3A Output)	61
Active Discharge	61
Output Monitoring.	61
Enable and Power Mode Control	62
Detailed Description—Step-Down Regulators (SD2/3–2A Output).	62
Output Monitoring.	62
Enable and Power Mode Control	63
Active Discharge Resistor	63
Soft-Start	64
Register and Reset Conditions.	64
Detailed Description—150mA PMOS LDO (LDO2, LDO4, LDO5, LDO6)	64
Features and Benefits	64
Simplified Block Diagram	65
Active-Discharge Resistor	66

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

TABLE OF CONTENTS (CONTINUED)

Input Capacitor Selection	67
Output Capacitor Selection	67
P-Channel Linear Regulator Output Capacitor.	67
N-Channel Linear Regulator Output Capacitor	67
Bias	68
LDO Power Modes	68
Soft-Start and Dynamic Voltage Scaling (DVS)	68
Power-OK (POK) Comparators for Linear Regulators	68
Overvoltage Clamp	69
Detailed Description—GPIO	70
GPIO	70
Alternate Mode	70
Features and Benefits	70
GPIO Programming Matrix	71
Detailed Description—32kHz Oscillator	72
Features: 32kHz Oscillator	72
Operation Modes	72
Low-Jitter Mode and Low-Power Mode	73
Internal Ballast Capacitors	73
Buffered Output	73
Silicon Oscillator	73
Detailed Description—Backup Battery Charger	74
Features	75
Detailed Description—Real-Time Clock (RTC)	75
Features	75
Writing to RTC	75
Reading from RTC	76
Sudden Momentary Power Loss (SMPL)	77
Detailed Description—I ² C Interface	77
I ² C Slave Address	77
Register Map	78
RTC	78
Register Details	79
Register Details	
Typical Application Circuit	
Ordering Information	
Revision History	

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

LIST OF FIGURES

Figure 1. Global Resource Logic	44
Figure 2. System Watchdog Timer	46
Figure 3. EN0 Functionality Options	47
Figure 4. Simplified Interrupt Status and Mask Logic	48
Figure 5. State Diagram: ON/OFF Controller Top Level	49
Figure 6. Flow Chart—Power-Up Sequence	51
Figure 7. Flow Chart—Power-Down Sequence	52
Figure 8. Flow Diagram: Immediate Shutdown	53
Figure 9. Reset Flow Diagram	54
Figure 10. Flexible Power Sequencer	57
Figure 11. FPS Sequence Power-Up/Down	58
Figure 12. FPS Sleep Entry/Exit	59
Figure 13. Linear Regulator Functional Diagram	66
Figure 14. Block Diagram—32kHz Normal-Mode Operation	72
Figure 15. Flow Chart—Silicon Oscillator	74

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

LIST OF TABLES

Table 1. OTP Options	42
Table 2. ON/OFF Controller Transition Conditions	49
Table 3. LDO and Step-Down Resource Power Mode	55
Table 4. 32k Resource Power Mode	55
Table 5. Basic LDO Topologies.	65
Table 6. GPIO Alternate Modes	70
Table 7. GPIO Programming Matrix	71
Table 8. 32kHz Crystal Oscillator Load Capacitance	73
Table 9. MAX77714 Slave Addresses.	77

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Absolute Maximum Ratings

Тор		Step-Down	
EN0 to GND0.3V to V _{MBA}	TT + 0.3V	IN_SD0 to PG_SD0	-0.3V to +6.0V
EN1 to GND0.3V to V _{MBA}	TT + 0.3V	IN_SD1 to PG_SD1	0.3V to +6.0V
SHDN to GND0.3V to V _{MBA}		IN_SD2 to PG_SD2	0.3V to +6.0V
nRST_IO to GND0.3V to V _{MBA}	TT + 0.3V	LX_SD0 to PG_SD0 (Note 1)	0.3V to V _{IN SD0} + 0.3V
nIRQ to GND0.3V to VINI		LX_SD1 to PG_SD1 (Note 1)	0.3V to V _{IN SD1} + 0.3V
XOUT to XGND (Note1)0.3V to VR1		LX_SD2 to PG_SD2 (Note 1)	0.3V to V _{IN SD2} + 0.3V
XIN to XGND (Note 1)0.3V to VR	TC + 0.3V		$Imp (T_J = +110^{\circ}C) (RMS Current)$
BBATT to GND0.3V		per Pin (T _J = +110°C))	1.6A
MBATT to GND0.3V			0.3V to V _{MBATT} + 0.3V
nRST_IO Sink Current		PG_SDx to GND	0.3V to +0.3V
nIRQ Sink Current		IN_SD3 to PG_SD3	0.3V to +6.0V
DGND to GND			0.3V to V _{IN_SD3} + 0.3V
XGND to GND	/ to +0.3V		0.3V to V _{IN_SD2} + 0.3V
LDO			0.3V to V _{IN_SD3} + 0.3V
IN_LDO0_1 to GND0.3V	/ to +6.0V	l ² C	
OUT_LDO0 to GND0.3V to VIN_LDO0	₀₋₁ + 0.3V	SDA, SCL to GND	0.3V to V _{INI2C} + 0.3V
IN_LDO2 to GND0.3V	∕ to +6.0V		25mA
OUT_LDO1 to GND0.3V to V _{IN_LDO0}	₀₋₁ + 0.3V	GPIO	
IN_LDO3_5 to GND ⁻ -0.3V	/ to +6.0V	GPIO_INB to GND	0.3V to +6.0V
OUT_LDO2 to GND0.3V to V _{IN_LD0}	_{O2} + 0.3V	GPIO4-7 to GND	0.3V to V _{GPIO_INB} + 0.3V
IN_LDO4_6 to GND	/ to +6.0V	GPIO0-3 to GND	0.3V to V _{MBATT} + 0.3V
OUT_LDO3 to GND0.3V to V _{IN_LDO3}	₃₋₅ + 0.3V	GPIOx Source Current	
IN_LDO7_8 to GND	/ to +6.0V		20mA
OUT_LDO4 to GND0.3V to V _{IN_LDO4}	₄₋₆ + 0.3V		40°C to +85°C
OUT_LDO5 to GND0.3V to VIN_LDO3	₃₋₅ + 0.3V	Junction Temperature	+150°C
OUT_LDO6 to GND0.3V to VIN_LDO4	₄₋₆ + 0.3V		40°C to +150°C
OUT_LDO7 to GND0.3V to V _{IN_LDO7}		Soldering Temperature (reflow)	+260°C
OUT_LDO8 to GND0.3V to V _{IN_LDO7}	₇₋₈ + 0.3V		

Note 1: The specified voltage limitation is for steady state conditions. Dead times of a few nano seconds exist as the dynamic stepdown regulator transitions from inductor charging to inductor discharging and vice versa. These dead times allow internal clamping diodes to PGNDx and INBx to forward bias (Vf~1V). When the LXx waveform is observed on a high-bandwidth oscilloscope (≥ 100MHz), the LXx transition edges are commonly seen with 1.5V spikes. These spikes are due to (1) the internal clamping diode forward voltage and (2) the high rate of current change through the current loop's inductance (V = L x di/dt). Designs must follow the recommended printed circuit board (PCB) layout in order to minimize this current loop's inductance.

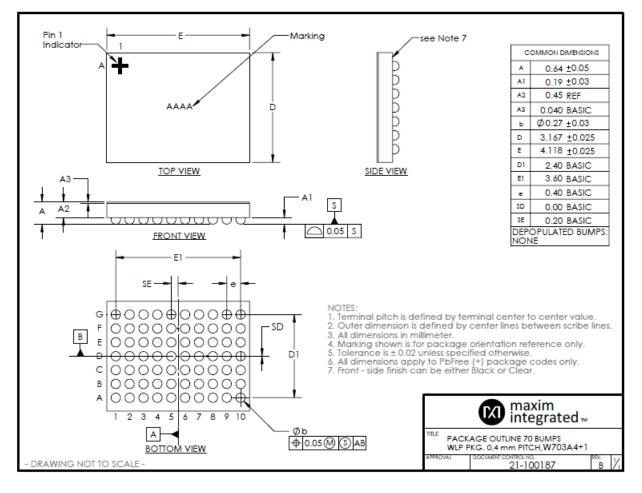
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Package Information

WLP

Package Code	W703A4+1			
Outline Number	<u>21-100187</u>			
Land Pattern Number Refer to <u>Application Note 1891</u>				
Thermal Resistance, Four-Layer Board:				
Junction to Ambient (0 _{JA})	37.43°C/W			
Junction to Case (θ_{JC})	NA			

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications



For the latest package outline information and land patterns (footprints), go to <u>www.maximintegrated.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to <u>www.maximintegrated.com/thermal-tutorial</u>.

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Electrical Characteristics—Global Resources

(Limits are 100% tested at $T_A = +25^{\circ}$ C. Limits over the operating temperature range ($T_A = -40^{\circ}$ C to $+85^{\circ}$ C) and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

PARAMETER	SYMBOL	COND	MIN	TYP	MAX	UNITS	
MAIN BATTERY POWER	R INPUT (MBATT)					
MBATT Operating Voltage Range	V _{MBATT}			2.6		5.5	V
MBATT Undervoltage- Lockout Threshold	V _{MBATTUVLO}	V _{MBATT} falling, 200r		2.5		V	
MBATT Overvoltage Lockout Threshold	V _{MBATTOVLO}	V _{MBATT} rising, 200n	יV hysteresis	5.70	5.85	6.00	V
		All regulators off, 321 power mode (PWR_ V _{MBATT} = 3.6V, I _{BB} ,	MD_32k = 0b1),	0.8	12	25	
Quiescent Supply Current		All regulators off, 32kHz oscillator in low- power mode (PWR_MD_32k = 0b1), internal reference and bias circuitry active (L_B_EN = 1), V _{MBATT} = $3.6V$, I _{BBATT} = 0μ A			42		μA
		Current into MBATT and all LDO power inputs,	Normal-power mode, all LDOs enabled		265		
No-Load LDO Supply Current		V _{MBATT} = 3.6V. All LDO power inputs are 3.6V, I _{BBATT} = 0µA, LDOs set to minimum output voltage, all step- down regulators disabled, 32kHz clock buffer disabled, 32kHz oscillator in low- power mode (PWR_MD_32k = 0b1), VIN_GPIOB = 0V. This does not include any current into nRST_IO or nIRQ	Low-power mode, LDO2-LDO6 enabled (PMOS)		58		μΑ

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Electrical Characteristics—Global Resources (continued)

(Limits are 100% tested at $T_A = +25^{\circ}$ C. Limits over the operating temperature range ($T_A = -40^{\circ}$ C to +85°C) and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

PARAMETER	SYMBOL	COND	ITIONS	MIN	TYP	MAX	UNITS
	Current into MBATT and all step-down power inputs, V _{MBATT} =	Normal-power mode, all step- down regulators enabled		145			
No-Load Step-Down Supply Current		3.6V, all regulator inputs are 3.6V, IBBATT = 0 μ A, all step-downs enabled with their minimum output voltages, all LDOs disabled, 32kHz clock buffer disabled, 32kHz oscillator in low- power mode (PWR_MD_32k = 0b01), VIN_GPIOB = 0V. This does not include any current into nRST_IO or nIRQ	Low-power mode, all step-down regulators enabled		82.5		μA

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Electrical Characteristics—Global Resources (continued)

(Limits are 100% tested at $T_A = +25^{\circ}$ C. Limits over the operating temperature range ($T_A = -40^{\circ}$ C to +85°C) and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

PARAMETER	SYMBOL	COND	MIN	TYP	MAX	UNITS	
		Current into MBATT all step- down power inputs, and all LDO power inputs, $V_{MBATT} =$ 3.6V, all regulator inputs are 3.6V, IBBATT = 0µA, all regulators set to minimum output voltage. 32kHz clock buffer disabled, 32kHz oscillator in low- power mode (PWR_MD_32k = 0b01), VIN_GPIOB = 0V. This does not include any current into nRST_IO or nIRQ	Normal-power mode, all regulators enabled		375	520	
No-Load LDO and Step- Down Supply Current		Current into MBATT all step- down power inputs, and all LDO power inputs, VMBATT = 3.6V, all regulator inputs are 3.6V, IBBATT = 0µA, all regulators set to minimum output voltage. 32kHz clock buffer disabled, 32kHz oscillator in low- power mode (PWR_MD_32k = 0b01), VIN_GPIOB = 0V. This does not include any current into nRST_IO or nIRQ	Low-power mode, all regulators except LDO0/1/7/8 (NMOS)		110	165	μΑ

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Electrical Characteristics—Global Resources (continued)

(Limits are 100% tested at $T_A = +25^{\circ}$ C. Limits over the operating temperature range ($T_A = -40^{\circ}$ C to $+85^{\circ}$ C) and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
MBATT RESET COMPA	RATOR		ì				
		MBATT_RESET[2:0] = 0b000		2.7			
		MBATT_RESET[2:0] = 0b001		2.8			
		MBATT_RESET[2:0] = 0b010		2.9			
Reset Falling Threshold	V _{MBATT_RESE}	MBATT_RESET[2:0] = 0b011	2.95	3.0	3.05		
Range	T	MBATT_RESET[2:0] = 0b100		3.1		V	
		MBATT_RESET[2:0] = 0b101		3.2		1	
		MBATT_RESET[2:0] = 0b110		3.3		1	
		MBATT_RESET[2:0] = 0b111		3.4			
		MBATT_HYS[1:0] = b00		0.1			
Reset Threshold	V _{MBATT_RES}	MBATT_HYS[1:0] = 0b01		0.2		1	
Hysteresis	ET_HYS	MBATT_HYS[1:0] = 0b10		0.3		V	
		MBATT_HYS[1:0] = 0b11		0.4			
BIDIRECTIONAL RESET		(nRST_IO)					
		OTP_TRSTO[1:0] = 0b00	0.8	1.0	1.2		
Reset Output Deassert Delay Time	eassert t _{RST_O}	OTP_TRSTO[1:0] = 0b01		8		- ms	
		OTP_TRSTO[1:0] = 0b10		32			
		OTP_TRSTO[1:0] = 0b11		64		1	
Reset Input Debounce Timer	^t DBNC_nRST_I O		24	30	36	ms	
Input High Voltage	VIH	RSO = 0	1.4			V	
Input Low Voltage	VIL	RSO = 0			0.4	V	
Input Hysteresis	V _{HYS}	RSO = 0		50		mV	
		V _{MBATT} = 5.5V, V _{nRST_IO} = 0V and 5.5V, RSO = 0, T _A = +25°C		0.001	1		
Input Leakage Current		V _{MBATT} = 5.5V, V _{nRST_IO} = 0V and 5.5V, RSO = 0, T _A = +85°C		0.01		μA	
Output Voltage Low	V _{OL}	I _{SINK} = 4mA, RSO = 1			0.4	V	
Output High Leakage		V _{MBATT} = 5.5V, V _{nRST_IO} = 0V and 5.5V, RSO = 0, T _A = +25°C		0.001	1		
Current		V _{MBATT} = 5.5V, V _{nRST_IO} = 0V and 5.5V, RSO = 0, T _A = +85°C		0.01		μA	
DEDICATED ACTIVE-LC	W OPEN-DRAIN	OUTPUTS (nIRQ)					
Output Voltage Low	V _{OL}	I _{SINK} = 4mA, RSO = 1			0.4	V	
Output High Leakage		V_{MBATT} = 5.5V, V_{nIRQ} = 0V and 5.5V, RSO = 0, T _A = +25°C		0.001	1		
Current	Іодн	V _{MBATT} = 5.5V, V _{nIRQ} = 0V and 5.5V, RSO = 0, T _A = +85°C		0.01		μA	
THERMAL ALARM AND	SHUTDOWN						
Thermal Alarm 1	T _{J110}	T _{.1} rising, +5°C hysteresis	1	110		°C	

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Electrical Characteristics—Global Resources (continued)

(Limits are 100% tested at $T_A = +25^{\circ}$ C. Limits over the operating temperature range ($T_A = -40^{\circ}$ C to +85°C) and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

PARAMETER	SYMBOL	COND	MIN	TYP	MAX	UNITS	
Thermal Alarm 2	T _{J130}	T _J rising, +5°C hysteresis			130		°C
Thermal Shutdown Temperature	T _{JSHDN}	T _J rising, +10°C hysteresis			145		°C
BACKUP-BATTERY POW	BACKUP-BATTERY POWER INPUT						
BBATT Current	I _{BBATT}	V _{MBATT} = 0V, PWR_MD_32k = 0b0	V _{BBATT} = 3.00V		4.2	8	μΑ

Electrical Characteristics—ON/OFF Controller

 $(V_{SYS} = 3.6V, T_A = -40^{\circ}C$ to +85°C, limits are 100% tested at $T_A = +25^{\circ}C$. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
ON/OFF CONTROLLER						
Input Voltage High	VIH		1.4			V
Input Voltage Low	VIL				0.4	V
Input Hysteresis	V _{HYS}			0.05		V
Manual Reset Time		MRT[2:0] = 0b000		2		
		MRT[2:0] = 0b001		3		
		MRT[2:0] = 0b010		4]
	.	MRT[2:0] = 0b011		5]
	^t HRDRST	MRT[2:0] = 0b100		6		S
		MRT[2:0] = 0b101		8		
		MRT[2:0] = 0b110		10		
		MRT[2:0] = 0b111		12		-
		MRT[2:0] = 0b000		2		
		MRT[2:0] = 0b001		2]
		MRT[2:0] = 0b010		3		7
Manual Reset Warning		MRT[2:0] = 0b011		4]
Time (MRWRN)	t _{MRWRN}	MRT[2:0] = 0b100		5		S
		MRT[2:0] = 0b101		6		1
		MRT[2:0] = 0b110		8		
		MRT[2:0] = 0b111		10]

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Electrical Characteristics—Flexible Power Supply (FPS)

 $(V_{SYS} = 3.6V, T_A = -40^{\circ}C$ to +85°C, limits are 100% tested at $T_A = +25^{\circ}C$. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

PARAMETER	SYMBOL	CONDITIONS	MIN TYP MAX		UNITS	
FLEXIBLE POWER SEQ	UENCE					
Flexible Power Sequencer Enable Delay	^t FSDON	MAX77714 reference is already powered up prior to the enable command	91.5			μs
Flexible Power Sequencer Disable Delay	^t FPSDOFF			152		μs
		MSTR_PU[2:0], MSTR_PD[2:0] = 0b000		31		
		MSTR_PU[2:0], MSTR_PD[2:0] = 0b001		63		
		MSTR_PU[2:0], MSTR_PD[2:0] = 0b010		127		
Flexible Power		MSTR_PU[2:0], MSTR_PD[2:0] = 0b011		256		
Sequencer Event Period	t _{FST}	MSTR_PU[2:0], MSTR_PD[2:0] = 0b100		508		μs
		MSTR_PU[2:0], MSTR_PD[2:0] = 0b101		984		
		MSTR_PU[2:0], MSTR_PD[2:0] = 0b110		1936		
		MSTR_PU[2:0], MSTR_PD[2:0] = 0b111		3904		
Flexible Power Sequencer Event Period Timer Accuracy		Accuracy of the flexible power sequencer clock	-15		+15	%

Electrical Characteristics—Step-Down Regulators (SD0-4A Output)

 $(V_{SYS} = 3.6V, T_A = -40^{\circ}C$ to +85°C, limits are 100% tested at $T_A = +25^{\circ}C$. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS	
SUPPLY VOLTAGE ANI	CURRENT	· · · · · · · · · · · · · · · · · · ·				1	
Input Voltage Range	V _{INSD0}		2.6		5.5	V	
OUTPUT VOLTAGE							
Output Voltage Range	V _{OUT_SD0}	I ² C programmable in 10mV steps (SD0VOUT[6:0] = 0x01 to 0x7F)	0.26		1.52	V	
Output Voltage Accuracy	VOUT_ACC_N M_SD0	FPWM mode, normal-power mode, no load, $T_A = +25^{\circ}C$, $V_{OUT_SD0} = 1.0V$	-2		+2	- %	
	VOUT_ACC_LP M_SD0	Low-power mode, no load, $T_A = +25^{\circ}C$, $V_{OUT_SD0} = 1.000V$	-4		+4	/0	
PERFORMANCE							
Switching Frequency	fsw	V _{SYS} = 3.6V	1.8	2	2.2	MHz	
Line Regulation		V _{INSD0} = 2.6V to 5.5V, V _{OUT_SD0} = 1.0V		0.2		%/V	
Soft-Start Slew Rate		SD0_SSRAMP = 0		2.5		m)//uo	
Soll-Start Siew Rate		SD0_SSRAMP = 1		10		- mV/μs	
Output Voltage Ramp- Up/Down Slew Rate (DVS)				10		mV/µs	

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Electrical Characteristics—Step-Down Regulators (SD0–4A Output) (continued)

 $(V_{SYS} = 3.6V, T_A = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ limits are } 100\% \text{ tested at } T_A = +25^{\circ}C. \text{ Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)$

PARAMETER	SYMBOL	CONDITIONS	CONDITIONS MIN TYP MAX		UNITS	
DMOS ON Desistance	D	V _{SYS} = V _{IN_SD0} = 5V, I _{OUT} = 150mA		38	60	
PMOS ON Resistance	R _{ON_PCH}	V _{SYS} = V _{IN_SD0} = 3.6V, I _{OUT} = 150mA		48	60	- mΩ
NMOS ON Resistance	Davasa	$V_{SYS} = V_{IN}SD0} = 5V, I_{OUT} = 150mA$		18	40	
NINOS ON Resistance	R _{ON_NCH}	V _{SYS} = V _{IN_SD0} = 3.6V, I _{OUT} = 150mA		24	40	- mΩ
NMOS Zero-Crossing	IZX_SKIP	SKIP mode		20		mA
Threshold	IZX_PWM	Low-power mode		20		
	IL_LX_25C	V_{LXSD0} = 5.5V or 0V, T_A = +25°C		0.1		
LX Leakage	IL_LX_85C	V _{LXSD0} = 5.5V or 0V, T _A = +85°C (Note 2)	1			μA
Output Active Discharge Resistance	R _{DISCHG_SD0}	Resistance from FBB0 to PGND0, output disabled		100		Ω
Turn-On Delay Time	tON_DLY_SD0	EN signal to LX switching with bias on		200		μs
OUTPUT CURRENT	· <u> </u>					
Maximum Output Current	I _{OUT_MAX_NM} SD0	RMS, normal mode	4000			mA
PMOS Peak Current		T _A = +25°C	4825	4825 5250	5675	
Limit	ILIMP	T _A = -40°C to +85°C	4825	4825 5250		– mA
NMOS Valley Current Limit	I _{LIMV}		3000			mA
NMOS (Negative) Current Limit	I _{LIMN}			2000		mA
BROWNOUT COMPARA	TOR					
		Normal-power mode, falling threshold, SD0_BO_THR[1:0] = 0b00		77		
Output-Brownout		Normal-power mode, falling threshold, SD0_BO_THR[1:0] = 0b01	81			
Threshold	V _{BO_SD0}	Normal-power mode, falling threshold, SD0_BO_THR[1:0] = 0b10		85.7		- %
		Normal-power mode, falling threshold, SD0_BO_THR[1:0] = 0b11		91		
Output-Brownout Accuracy		Normal-power mode. V _{OUT_SD0} = 1.0V (SD0_VOUT[6:0])	-4.5		+4.5	%
Output-Brownout Threshold (Low-Power Mode)	V _{BO_SD0}	Falling threshold, low-power mode		86.0		%
Output-Brownout Accuracy		Low-power mode. V _{OUT_SD0} = 1.0V (SD0_VOUT[6:0])	-4		+4	%
Output-Brownout Hysteresis Range	VBO_HYS_SD0	2-Bit control over I ² C. Max rising threshold limited to 96%	5		20	%
Brownout-Voltage Hysteresis Programming Step Size		Programmable with SD0_BO_HYS[1:0]		5		%

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Electrical Characteristics—Step-Down Regulators (SD0–4A Output) (continued)

 $(V_{SYS} = 3.6V, T_A = -40^{\circ}C$ to $+85^{\circ}C$, limits are 100% tested at $T_A = +25^{\circ}C$. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output-Brownout Hysteresis (Low-Power Mode)	V _{BO_HYS_SD0} _LPM			5		%
OV COMPARATOR	•					
Output OV Trip Level	VOUT_SD0_OV	Rising edge, SD0_OV_THR = 1		117.1		%
Output OV Hysteresis		SD0_OV_THR = 1		8.6		%
Output OV Trip Level	VOUT_SD0_OV	Rising edge, SD0_OV_THR = 0		108.5		%
Output OV Hysteresis		SD0_OV_THR = 0		3.9		%
Output OV Trip Level (Low-Power Mode)	V _{OUT_SD0_OV}	Rising edge, low-power mode		108.3		%
Output OV Hysteresis (Low-Power Mode)		Low-power mode		3.9		%

Note 2: Design guidance only and is not production tested.

Electrical Characteristics—Step-Down Regulators (SD1–3A Output)

 $(V_{SYS} = 3.6V, T_A = -40^{\circ}C$ to +85°C, limits are 100% tested at $T_A = +25^{\circ}C$. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
SUPPLY VOLTAGE AN	DCURRENT						
Input Voltage Range	V _{IN_SD1}		2.6		5.5	V	
OUTPUT VOLTAGE	•						
Output Voltage Range	VOUT_SD1	I ² C programmable in 10mV steps (SD1VOUT[6:0] = 0x01 to 0x7F)	0.26		1.52	V	
Output Voltage Accuracy	VOUT_ACC_N M_SD1	FPWM mode, normal mode, no load, T_A = +25°C, V _{OUT_SD1} = 1.0V	-2		+2	- %	
	V _{OUT_ACC_LP} M_SD1	Low-power mode, no load, $T_A = +25^{\circ}C$, $V_{OUT_SD1} = 1.000V$	-4		+4	70	
PERFORMANCE							
Switching Frequency	f _{SW}	V _{MBATT} = 3.6V	1.8	2	2.2	MHz	
Line Regulation		V _{INSD1} = 2.6V to 5.5V, V _{OUT_SD1} = 1.0V		0.2		%/V	
PMOS ON Resistance	Paul Paul	V _{MBATT} = V _{INSD1} = 5V, I _{OUT} = 150mA		45	90	mΩ	
FINOS ON RESISTANCE	R _{ON_PCH}	V _{MBATT} = V _{INSD1} = 3.6V, I _{OUT} = 150mA		58	90		
NMOS ON Resistance	Development	V _{MBATT} = V _{INSD1} = 5V, I _{OUT} = 150mA		28	60	- mΩ	
NIVIOS ON RESIStance	R _{ON_NCH}	V _{MBATT} = V _{INSD1} = 3.6V, I _{OUT} = 150mA		35	60		
NMOS Zero-Crossing	IZX_SKIP	Skip mode		20		m 4	
Threshold	IZX_PWM	Low-power mode		20		– mA	
	IL_LX_25C	V _{LXSD1} = 5.5V or 0V, T _A = +25°C		0.1	1		
LX Leakage	IL_LX_85C	V _{LXSD1} = 5.5V or 0V, T _A = +85°C (Note 3)		1		μA	

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Electrical Characteristics—Step-Down Regulators (SD1–3A Output) (continued)

 $(V_{SYS} = 3.6V, T_A = -40^{\circ}C$ to +85°C, limits are 100% tested at $T_A = +25^{\circ}C$. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Active Discharge Resistance	RDISCHG_SD1	Resistance from FB_SD1 to PG_SD1, output disabled		100		Ω
Turn-On Delay Time	tON_DLY_SD1	EN signal to LX switching with bias on		200		μs
BROWNOUT COMPARA	TOR					
		Normal-power mode, falling threshold, SD1_BO_THR[1:0] = 0b00		77		
Output-Brownout		Normal-power mode, falling threshold, SD1_BO_THR[1:0] = 0b01		81		%
Threshold	V _{BO_SD1}	Normal-power mode, falling threshold, SD1_BO_THR[1:0] = 0b10		85.7		70
		Normal-power mode, falling threshold, SD1_BO_THR[1:0] = 0b11		91		
Output-Brownout Accuracy		Normal-power mode. V _{OUT_SD1} = 1.0V (SD1_VOUT[6:0])	-4.5		+4.5	%
Output-Brownout Threshold (Low-Power Mode)	V _{BO_SD1}	Falling threshold, low-power mode		86.0		%
Output-Brownout Accuracy		Low-power mode, V _{OUT_SD1} = 1.0V (SD1_VOUT[6:0])	-4		+4	%
Output-Brownout Hysteresis Range	V _{BO_HYS_SD1}	2-Bit control over I ² C. Max rising threshold limited to 96%	5		20	%
Brownout-Voltage Hysteresis Programming Step Size		Programmable with SD1_BO_HYS[1:0]		5		%
Output-Brownout Hysteresis (Low-Power Mode)	V _{BO_HYS_SDx} _LPM			5		%
OUTPUT CURRENT						
Maximum Output Current	IOUT_MAX_NM _SD1	RMS, normal mode	3000			mA
PMOS Peak Current	l	T _A = +25°C	3825	4250	5100	mA
Limit	LIMP	T _A = -40°C to +85°C	3825	4250	5200	
NMOS Valley Current Limit	I _{LIMV}			3000		mA
NMOS (Negative) Current Limit	I _{LIMN}			2000		mA
OV COMPARATOR						
Output OV Trip Level	VOUTSD1_OV	Rising edge, SD1_OV_THR = 1		117.1		%
Output OV Hysteresis		SD1_OV_THR = 1		8.6		%
Output OV Trip Level	VOUTSD1_OV	Rising edge, SD1_OV_THR = 0		108.5		%
Output OV Hysteresis		SD1_OV_THR = 0		3.9		%
Output OV Trip Level (Low-Power Mode)	VOUTSD1_OV	Rising edge, low-power mode		108.3		%

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Electrical Characteristics—Step-Down Regulators (SD1–3A Output) (continued)

 $(V_{SYS} = 3.6V, T_A = -40^{\circ}C$ to +85°C, limits are 100% tested at $T_A = +25^{\circ}C$. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output OV hysteresis (Low-Power Mode)		Low-power mode		3.9		%

Note 3: Design guidance only and is not production tested.

Electrical Characteristics—Step-Down Regulators (SD2/3–2A Output)

 $(V_{SYS} = 3.6V, T_A = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ limits are } 100\% \text{ tested at } T_A = +25^{\circ}C. \text{ Limits over the operating temperature range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)$

PARAMETER	SYMBOL	CONDITIONS	MIN TYP MAX		UNITS	
SUPPLY VOLTAGE AND	CURRENT					
Input Voltage Range	V _{IN_SDx}		2.6		5.5	V
OUTPUT VOLTAGE						
	V _{OUT_SD2}	Programmable in 6.25mV steps with SD2VOUT[7:0]	0.600		2.194	v
Output Voltage Range	V _{OUT_SD3}	Programmable in 12.5mV steps with SD3VOUT[7:0]	0.600		3.78	
	VOUT_ACC_N M_SD2	FPWM mode, normal-power mode, no load, V _{OUT_SD2} = 1.1V	-2		+2	
Output Voltage	V _{OUT_ACC_LP} M_SD2	Low-power mode, no load, V _{OUT_SD2} = 1.1V	-4		+4	%
Accuracy	VOUT_ACC_N M_SD3	FPWM mode, normal mode, no load, $V_{OUT_SD3} = 1.1V$	-2		+2	70
	V _{OUT_ACC_LP} M_SD3	Low-power mode, no Load, V _{OUT_SD3} = 1.1V	-4		+4	
OUTPUT CURRENT						
Maximum Output Current	IOUT_MAX_NM _SD2_3	RMS, normal mode, L = 1µH	2000			mA
PMOS Peak Current	h	V _{MBATT} = 3.6V	2300	2875	4200	m 4
Limit	ILIMP	V _{MBATT} = 5V	2300	2875	4200	- mA
NMOS Valley Current	h u n i	V _{SYS} = 3.6V		2125		mA
Limit	ILIMV	V _{SYS} = 5V		2125		IIIA
NMOS Negative Current	h	V _{SYS} = 3.6V		800		mA
Limit	LIMN	V _{SYS} = 5V		800		
PERFORMANCE						
Line Regulation		$V_{MBATT} = V_{IN}SD2_3 = 2.6V$ to 5.5V		0.2		%/V
Switching Frequency	form	V _{MBATT} = 3.3V	1.8	2	2.2	MHz
ownening riequency	f _{SW} V _{MBATT} = 5V	V _{MBATT} = 5V	1.8	2	2.2	
Soft-Start Slew Rate		Fixed for SD2		6.5		mV/µs
		Fixed for SD3		17		l mv/µs
Output Voltage Ramp- Up Slew Rate		Fixed for SD2, 3 (Notes 4, 7, 8), C_{OUT} = 22µF		40		mV/µs

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Electrical Characteristics—Step-Down Regulators (SD2/3–2A Output) (continued)

 $(V_{SYS} = 3.6V, T_A = -40^{\circ}C$ to +85°C, limits are 100% tested at $T_A = +25^{\circ}C$. Limits over the operating temperature range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
Output Voltage Ramp- Down Slew Rate		Fixed for SD2, 3 (Notes 4, 7), C_{OUT} = 22µF, SDxFPWMEN = 1 (x = 1, 2), no load		18		mV/µs	
PMOS ON Resistance	Rou pou	$V_{SYS} = V_{IN}SDx} = 3.6V, I_{OUT} = 150mA$		100	150	mΩ	
F WOS ON Resistance	R _{ON_PCH}	$V_{SYS} = V_{IN}SDx} = 5V, I_{OUT} = 150mA,$		100	150	11152	
NMOS ON Resistance	Row Nou	$V_{SYS} = V_{IN}SDx} = 3.6V, I_{OUT} = 150mA$		60	100	mΩ	
	R _{ON_NCH}	$V_{SYS} = V_{IN}SDx} = 5V, I_{OUT} = 150mA$		60	100	11152	
NMOS Zero-Crossing Threshold	I _{ZX}	SKIP mode		20		mA	
	IL_LX_25C	V _{LX2_3} = 5.5V or 0V, T _A = +25°C		0.1	1		
LX Leakage	IL_LX_85C	$V_{LX2_3} = 5.5V \text{ or } 0V, T_A = +85^{\circ}C \text{ (Note 4)}$		1		μA	
Output Active Discharge Resistance	R _{DISCHG_SDx}	Resistance from FBBx to PGNDx, output disabled, (Note 6)		100		Ω	
Turn-On Delay Time	tON_DLY_SDx	EN Signal to LX Switching with Bias ON		30		μs	
BROWNOUT COMPARA	TOR						
		Normal-power mode, falling threshold, SDx_BO_THR[1:0] = 0b00		75			
Output-Brownout	V _{BO_SDx}	Normal-power mode, falling threshold, SDx_BO_THR[1:0] = 0b01		80			
Threshold		Normal-power mode, falling threshold, SDx_BO_THR[1:0] = 0b10		85		- %	
		Normal-power mode, falling threshold, SDx_BO_THR[1:0] = 0b11		90			
Output-Brownout Accuracy		Normal-power mode. V _{OUT_SDx} = 1.0V (SDxVOUT[7:0])	-4		+4	%	
Output-Brownout Threshold (Low-Power Mode)	V _{BO_SDx}	Falling threshold, low-power mode		86.0		%	
Output-Brownout Accuracy		Low-power mode. V _{OUT_SDx} = 1.0V (SDxVOUT[7:0])	-4		+4	%	
Output-Brownout Hysteresis Range	V _{BO_HYS_SDx}	2-Bit control over I ² C. Max rising threshold limited to 96%	5		20	%	
Brownout-Voltage Hysteresis Programming Step Size		Programmable with SDx_BO_HYS[1:0]		5		%	
Output-Brownout Hysteresis (Low-Power Mode)	V _{BO_HYS_SDx} _LPM			5		%	
OV COMPARATOR							
Output OV Trip Level	VOUTSDX_OV	Rising edge, SDx_OV_THR = 1, referenced to output voltage setting		116.6		%	
Output OV Hysteresis		SDx_OV_THR = 1		9.1		%	

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Electrical Characteristics—Step-Down Regulators (SD2/3–2A Output) (continued)

 $(V_{SYS} = 3.6V, T_A = -40^{\circ}C$ to +85°C, limits are 100% tested at $T_A = +25^{\circ}C$. Limits over the operating temperature range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

PARAMETER	SYMBOL	CONDITIONS	MIN TYP MAX			UNITS
Output OV Trip Level	V _{OUTSDx_OV}	Rising edge, SDx_OV_THR = 0 referenced to output voltage setting		108.3		%
Output OV Hysteresis		SDx_OV_THR = 0		2.8		%
Output OV Trip Level (Low-Power Mode)	V _{OUTSDx_OV}	Rising edge, low-power mode		108.3		%
Output OV Hysteresis (Low-Power Mode)		Low-power mode		2.8		%

Note 4: Design guidance only and is not production tested.

- Note 5: Individual step-down supply current is not production tested. It is covered by a combined test by turning on all step-down regulators.
- Note 6: There is an n-channel MOSFET in series with the output active discharge resistance. This NMOS requires V_{SYS} > 1.2V to be enhanced.
- Note 7: The ramp-down slew rate when the output voltage is decreased via I²C is a function of the negative current limit and the output capacitance. With no load, forced PWM mode, and 22μF output capacitor, the ramp-down slew rate is dv/dt = i / C = 0.4A / 22μF = 18mV/μs.
- **Note 8:** DVS and soft-start ramp rates can be expected to vary by up to 30%.
- **Note 9:** The input and output voltage range of SD2/3 ensure that the 90% duty cycle limitation can never practically be reached. Additionally, SD2/3 is capable of 100% duty cycle for output voltages above 1.9V.

Electrical Characteristics—150mA PMOS LDO (LDO2, LDO4, LDO5, LDO6)

 $(V_{SYS} = 3.7V, V_{IN_LDO} = 3.7V, C_{IN_LDO} = 1\mu F, C_{OUT_LDO} = 2.2\mu F$. Limits are 100% production tested at T_A = +25°C. Limits over the operating temperature range (T_A=-40°C to +85°C) are guaranteed by design and characterization, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
GENERAL CHARACTER	ISTICS			•			
Input Voltage Range	V _{IN_LDOx}	Guaranteed by output	ut accuracy	1.7		5.5	V
Undervoltage Lockout	V _{UVLOxx}	Rising, 100mV hyste	eresis		1.6	1.7	V
		V., is the	50mV/step (6-bit), LDO2, LDO5, LDO6	0.8		3.95	
Output Voltage Range	V _{OUTxx}	V _{OUT} +0.3V	50mV step from 0.4V to 0.5V and 12.5mV step (7-bit), LDO4 from 0.5 to 1.275V	0.4		1.275	V
Maximum Output		Guaranteed by	Normal mode	150			mA
Current	IMAXxx	output accuracy	Low-power mode		5		

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Electrical Characteristics—150mA PMOS LDO (LDO2, LDO4, LDO5, LDO6) (continued)

 $(V_{SYS} = 3.7V, V_{IN_LDO} = 3.7V, C_{IN_LDO} = 1\mu F, C_{OUT_LDO} = 2.2\mu F$. Limits are 100% production tested at T_A = +25°C. Limits over the operating temperature range (T_A=-40°C to +85°C) are guaranteed by design and characterization, unless otherwise noted.)

PARAMETER	SYMBOL	COND	ITIONS	MIN	TYP	MAX	UNITS
CORE PERFORMANCE	SPECIFICATIO	NS					
		Normal mode	$V_{IN} = V_{NOM} + 0.3V$ to 5.5V with 1.7V minimum, I _{OUT} = 0.1mA to I _{MAX} , V _{NOM} set to any voltage	-3		+3	
Output Voltage Accuracy		LDO4 Normal mode	$V_{IN} = V_{NOM} + 0.3V$ to 5.5V with 1.7V minimum, I _{OUT} = 0.1mA to I _{MAX} , V _{NOM} set to any voltage	-4.5		+4.5	%
		Low-power mode	$V_{IN} = V_{NOM} + 0.3V$ to 5.5V with 1.7V minimum, I _{OUT} = 0.1mA to 5mA, V _{NOM} set to any voltage	-5		+5	
oad Regulation (Note		Normal mode	$I{OUT} = 0.1 \text{mA to}$ $I_{MAX}, VIN =$ $V_{NOM}+0.3 \text{V with}$ 1.7V minimum $V_{NOM} \text{ set to any}$ voltage		0.05		%
15)		Low-power mode	$I_{OUT} = 0.1 \text{mA to}$ 5mA, V _{IN} = V _{NOM} +0.3V with 1.7V minimum, V _{NOM} set to any voltage		0.05		70
Line Regulation (Note 15)		Normal mode	$V_{IN} = V_{NOM} + 0.3V$ to 5.5V with 1.7V minimum, I _{OUT} = 0.1mA, V _{NOM} set to any voltage		0.01		%/V
Line Regulation (Note15)		Low-power mode	$V_{IN} = V_{NOM} + 0.3 \text{ to}$ 5.5V with 1.7V minimum. I _{OUT} = 0.1mA, V _{NOM} set to any voltage		0.01		%/V
		Normal mode, IOUT	V _{IN} = 3.7V		50	100]
		= I _{MAX} , LDO4 not tested	V _{IN} = 1.7V		150	300	
Dropout Voltage	V _{DOxx}	Low-power mode, I _{OUT} = 5mA, V _{IN} = 3.7V			150	300	mV
Output Current Limit	ILIMxx	V _{OUT} = 0V, % of I _{MA}	X	110	180	250	%

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Electrical Characteristics—150mA PMOS LDO (LDO2, LDO4, LDO5, LDO6) (continued)

 $(V_{SYS} = 3.7V, V_{IN_LDO} = 3.7V, C_{IN_LDO} = 1\mu F, C_{OUT_LDO} = 2.2\mu F$. Limits are 100% production tested at T_A = +25°C. Limits over the operating temperature range (T_A=-40°C to +85°C) are guaranteed by design and characterization, unless otherwise noted.)

PARAMETER	SYMBOL	COND	ITIONS	MIN	TYP	MAX	UNITS
DYNAMIC CHARACTER	STICS						
Soft-Start and Dynamic	_	After enabling, SS_L	x = 1 (Note 10)		5		
Voltage Change Ramp Rate	t _{SSxx}	After enabling, SS_L	_x = 0 (Note 10)			mV/µs	
Active Discharge Resistance		Output disabled, V _O from OUT_LDOx to discharge enabled (I	GND, active		65		Ω
THERMAL SHUTDOWN							
Thermal Shutdown		Output disabled or	T _J rising		165		3°
		enabled	T _J falling		150		
POWER-OK COMPARAT	OR						
Power-OK Threshold		V _{OUT} when V _{POK}	V _{OUT} falling	84	87		%
Fower-OK Intestion	VPOKTHL	switches	V _{OUT} rising		92	96	/0

Note 10: Limits are 100% production tested at $T_A = +25$ °C. Limits over the operating temperature range are guaranteed through correlation using statistical quality control methods.

Note 11: Does not include ESR of the capacitance or trace resistance of the PCB.

Electrical Characteristics—300mA PMOS LDO (LDO3)

 $(V_{SYS} = 3.7V, V_{IN_LDO} = 3.7V, C_{IN_LDO} = 1\mu F, C_{OUT_LDO} = 2.2\mu F$. Limits are 100% production tested at T_A = +25°C. Limits over the operating temperature range (T_A = -40°C to +85°C) are guaranteed by design and characterization, unless otherwise noted.)

PARAMETER	SYMBOL	COND	ITIONS	MIN	TYP	MAX	UNITS
GENERAL CHARACTER	RISTICS						
Input Voltage Range	V _{IN_LDOx}	Guaranteed by output	ut accuracy	1.7		5.5	V
Undervoltage Lockout	V _{UVLOxx}	Rising, 100mV hyste	eresis		1.6	1.7	V
Output Voltage Range	V _{OUTxx}	V _{INxx} is the maximum of 3.7 or V _{OUT} +0.3V	50mV/step (6-bit), LDO3	0.8		3.95	v
Maximum Output		Guaranteed by	Normal mode	300			mA
Current	IMAXxx	output accuracy	Low-power mode		5		
CORE PERFORMANCE	SPECIFICATION	IS					
Output Voltage		Normal mode	$\begin{array}{c} V_{IN} = V_{NOM} + 0.3V\\ to 5.5V \mbox{ with } 1.7V\\ minimum, I_{OUT} = \\ 0.1mA \mbox{ to } I_{MAX},\\ V_{NOM} \mbox{ set to any}\\ voltage \end{array}$	-3		+3	- %
Accuracy		Low-power mode	$\label{eq:VIN} \begin{array}{l} V_{IN} = V_{NOM} + 0.3V \\ \text{to } 5.5V \text{ with } 1.7V \\ \text{minimum, } I_{OUT} = \\ 0.1\text{mA to } 5\text{mA,} \\ V_{NOM} \text{ set to any} \\ \text{voltage} \end{array}$	-5		+5	70

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Electrical Characteristics—300mA PMOS LDO (LDO3) (continued)

 $(V_{SYS} = 3.7V, V_{IN_LDO} = 3.7V, C_{IN_LDO} = 1\mu F, C_{OUT_LDO} = 2.2\mu F$. Limits are 100% production tested at T_A = +25°C. Limits over the operating temperature range (T_A = -40°C to +85°C) are guaranteed by design and characterization, unless otherwise noted.)

PARAMETER	SYMBOL	COND	ITIONS	MIN	TYP	MAX	UNITS
Load Regulation (Note		Normal mode	$I_{OUT} = 0.1 \text{mA to}$ $I_{MAX}, VIN =$ $V_{NOM}+0.3V \text{ with}$ $1.7V \text{ minimum}$ $V_{NOM} \text{ set to any}$ voltage		0.05		- %
15)		Low-power mode	$I_{OUT} = 0.1 \text{mA to}$ $5 \text{mA, } V_{\text{IN}} =$ $V_{\text{NOM}} + 0.3 \text{V with}$ 1.7V minimum, $V_{\text{NOM}} \text{ set to any}$ $voltage$		0.05		70
Line Regulation (Note 15)		Normal mode	$V_{IN} = V_{NOM} + 0.3V$ to 5.5V with 1.7V minimum, I _{OUT} = 0.1mA, V _{NOM} set to any voltage		0.01		%/V
Line Regulation (Note15)		Low-power mode	$V_{IN} = V_{NOM} + 0.3 \text{ to}$ 5.5V with 1.7V minimum. I _{OUT} = 0.1mA, V _{NOM} set to any voltage		0.01		%/V
		Normal mode, I _{OUT}	V _{IN} = 3.7V		50	100	
		= I _{MAX}	V _{IN} = 1.7V		150	450	
Dropout Voltage	V _{DOxx}	Low-power mode, I _{OUT} = 5mA, V _{IN} = 3.7V			150	300	mV
Output Current Limit	I _{LIMxx}	V _{OUT} = 0V, % of I _{MA}	X	110	180	250	%
DYNAMIC CHARACTER	STICS						
Soft-Start and Dynamic- Voltage-Change Ramp	t _{SSxx}	After enabling (Note 12)	SS_Lx = 1		5		− mV/µs
Rate	USSXX	After enabling, (Note 12)	SS_Lx = 0		100		Πν/μ5
Active Discharge Resistance		Output disabled, V _{OI} from OUT_LDOx to 0 discharge enabled (A	GND, active		65		Ω
THERMAL SHUTDOWN			TT				1
Thermal Shutdown		Output disabled or	T _J rising		165		- °C
		enabled	T _J falling		150		
POWER-OK COMPARAT	OR	1	1 1				
Power-OK Threshold	V _{POKTHL}	V _{OUT} when V _{POK}	V _{OUT} falling	84	87		%
		switches	V _{OUT} rising		92	96	

Note 12: Limits are 100% production tested at $T_A = +25^{\circ}C$. Limits over the operating temperature range are guaranteed through correlation using statistical quality control methods.

Note 13: Does not include ESR of the capacitance or trace resistance of the PCB.

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Electrical Characteristics—150mA NMOS LDO (LDO0, LDO1)

 $(V_{SYS} = 3.7V, V_{IN_LDO} = 3.7V, C_{IN_LDO} = 1\mu F, C_{OUT_LDO} = 2.2\mu F.$ Limits are 100% production tested at T_A = +25°C. Limits over the operating temperature range (T_A = -40°C to +85°C) are guaranteed by design and characterization, unless otherwise noted.)

PARAMETER	SYMBOL	COND	ITIONS	MIN	TYP	MAX	UNITS
GENERAL CHARACTER	RISTICS						
Input Voltage Range	V _{IN_LDOx}	Guaranteed by outp	ut accuracy	VOUT		5.5	V
Output Voltage Range	V _{OUTxx}	V _{INxx} is the maximum of 3.7 or V _{OUT} +0.3V	25mV/step (6-bit), LDO0, LDO1	0.8		2.375	v
Maximum Output	have	Guaranteed by	Normal mode	150			mA
Current	IMAXXX	output accuracy	Low-power mode		5		
CORE PERFORMANCE	SPECIFICATION	NS					
Output Voltage		Normal mode	$V_{IN} = V_{NOM} + 0.3V$ to 5.5V, I _{OUT} = 0.1mA to I _{MAX} , V _{NOM} set to any voltage, V _{MBATT} = V _{NOM} +1.5V with 2.45V minimum	-3		+3	~ %
Accuracy		Low-power mode	$\begin{array}{c} V_{IN} = V_{NOM} + 0.3V\\ to 5.5V, I_{OUT} = \\ 0.1mA to 5mA,\\ V_{NOM} set to any\\ voltage, V_{MBATT} = \\ V_{NOM} + 1.5V \ with\\ 2.45V \ minimum \end{array}$	-5		+5	- %
Load Regulation (Note		Normal mode	$I_{OUT} = 0.1 \text{mA to}$ $I_{MAX}, V_{IN} =$ $V_{NOM}+0.3V,$ $V_{MBATT} =$ $V_{NOM}+1.5V \text{ with}$ 2.45V minimum		0.05		
15)		Low-power mode	$I_{OUT} = 0.1\text{mA to}$ $5\text{mA}, V_{IN} =$ $V_{NOM}+0.3V,$ $V_{MBATT} =$ $V_{NOM}+1.5V \text{ with}$ $2.45V \text{ minimum}$		0.05		- %
Line Regulation (Note 15)		Normal mode	V _{IN} = V _{NOM} +0.3V to 5.5V, I _{OUT} = 0.1mA		0.01		%/V
Line Regulation (Note15)		Low-power mode	$V_{MBATT} = V_{NOM}+0.3V \text{ to} \\ 5.5V \text{ with } 2.45V \\ \text{minimum, } V_{IN} = V_{NOM}+0.3V \text{ to} \\ 5.5V, I_{OUT} = \\ 0.1\text{mA}$		0.01		%/V

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Electrical Characteristics—150mA NMOS LDO (LDO0, LDO1) (continued)

 $(V_{SYS} = 3.7V, V_{IN_LDO} = 3.7V, C_{IN_LDO} = 1\mu F, C_{OUT_LDO} = 2.2\mu F$. Limits are 100% production tested at $T_A = +25^{\circ}C$. Limits over the operating temperature range ($T_A = -40^{\circ}C$ to +85°C) are guaranteed by design and characterization, unless otherwise noted.)

PARAMETER	SYMBOL	COND	ITIONS	MIN	TYP	MAX	UNITS
		Normal mode, I _{OUT}	V _{MBATT-VOUT} = 2.5V		50	100	
Dropout Voltage	V _{DOxx}	= I _{MAX}	V _{MBATT-} V _{OUT} = 1.7V		150	300	mV
		Low-power mode, I _{OUT} = 5mA, V _{IN} = 3.7V			150	300	
Output Current Limit	ILIMxx	V_{OUT} = 0V, % of I _{MA}	X	103	180	250	%
DYNAMIC CHARACTER	ISTICS						
Soft-Start and Dynamic-	t	After enabling, (Note 14)	SS_Lx = 0		100		m)//uo
Voltage-Change Ramp Rate	t _{SSxx}	After enabling (Note 14)	SS_Lx = 1		5		mV/µs
Active Discharge Resistance		Output disabled, V _O from OUT_LDOx to discharge enabled (<i>i</i>	GND, active		65		Ω
THERMAL SHUTDOWN							
Thermal Shutdown		Output disabled or	T _J rising		165		- °C
mermai Shuluown		enabled	T _J falling		150		
POWER-OK COMPARAT	ror						
Power-OK Threshold	Vaavatu	V _{OUT} when V _{POK}	V _{OUT} falling	84	87		%
	VPOKTHL	switches	V _{OUT} rising		92	96	/0

Note 14: Limits are 100% production tested at $T_A = +25^{\circ}C$. Limits over the operating temperature range are guaranteed through correlation using statistical quality control methods.

Note 15: Does not include ESR of the capacitance or trace resistance of the PCB.

Electrical Characteristics—300mA NMOS LDO (LDO8)

 $(V_{SYS} = 3.7V, V_{IN_LDO} = 3.7V, C_{IN_LDO} = 1\mu F, C_{OUT_LDO} = 2.2\mu F$. Limits are 100% production tested at $T_A = +25^{\circ}C$ Limits over the operating temperature range ($T_A = -40^{\circ}C$ to $+85^{\circ}C$) are guaranteed by design and characterization, unless otherwise noted.)

PARAMETER	SYMBOL	COND	CONDITIONS MIN TYP MAX		UNITS		
GENERAL CHARACTER	ISTICS						
Input Voltage Range	V _{IN_LDOx}	Guaranteed by output	ut accuracy	V _{OUT}		5.5	V
Output Voltage Range	V _{OUTxx}	V _{INxx} is the maximum of 3.7 or V _{OUT} +0.3V	50mV/step (6-bit), LDO8	0.8		3.95	V
Maximum Output		Guaranteed by	Normal mode	300			
Current	IMAXxx	output accuracy	Low-power mode		5		mA

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Electrical Characteristics—300mA NMOS LDO (LDO8) (continued)

 $(V_{SYS} = 3.7V, V_{IN_LDO} = 3.7V, C_{IN_LDO} = 1\mu$ F, $C_{OUT_LDO} = 2.2\mu$ F. Limits are 100% production tested at T_A = +25°C Limits over the operating temperature range (T_A = -40°C to +85°C) are guaranteed by design and characterization, unless otherwise noted.)

PARAMETER	SYMBOL	COND	ITIONS	MIN	TYP	MAX	UNITS
CORE PERFORMANCE	SPECIFICATIO	NS					,
Output Voltage		Normal mode	$V_{IN} = V_{NOM} + 0.3V$ to 5.5V, I _{OUT} = 0.1mA to I _{MAX} , V _{NOM} set to any voltage, V _{MBATT} = V _{NOM} + 1.5V with 2.45V minimum	-3		+3	- %
Accuracy		Low-power mode	$V_{IN} = V_{NOM} + 0.3V$ to 5.5V, I _{OUT} = 0.1mA to 5mA, V _{NOM} set to any voltage, V _{MBATT} = V _{NOM} + 1.5V with 2.45V minimum	-5		+5	7 70
Load Regulation (Note		Normal mode	$I_{OUT} = 0.1 \text{mA to}$ $I_{MAX}, V_{IN} =$ $V_{NOM}+0.3 \text{V},$ $V_{MBATT} =$ $V_{NOM}+1.5 \text{V with}$ 2.45 V minimum		0.05		- %
15)		Low-power mode	$I_{OUT} = 0.1mA \text{ to}$ $5mA, V_{IN} =$ $V_{NOM}+0.3V,$ $V_{MBATT} =$ $V_{NOM}+1.5V \text{ with}$ 2.45V minimum		0.05		70
Line Regulation (Note 15)		Normal mode	V _{IN} = V _{NOM} +0.3V to 5.5V, I _{OUT} = 0.1mA		0.01		%/V
Line Regulation (Note15)		Low-power mode	$V_{MBATT} = V_{NOM} +$ 0.3V to 5.5V with 2.45V minimum, $V_{IN} = V_{NOM} + 0.3V$ to 5.5V, I _{OUT} = 0.1mA		0.01		%/V
		Normal mode, I _{OUT}	V _{MBATT-VOUT} = 2.5V		50	100	
Dropout Voltage	V _{DOxx}	= I _{MAX}	V _{MBATT-} V _{OUT} = 1.7V		150	450	mV
		Low-power mode, I_{OUT} = 5mA, V_{IN} = 3.7V			150	300	
Output Current Limit	I _{LIMxx}	V _{OUT} = 0V, % of I _{MA}	X	110	180	250	%
DYNAMIC CHARACTERI	STICS						
Soft-Start and Dynamic- Voltage-Change Ramp	tor	After enabling, (Note 16)	SS_Lx = 0		100		mV/µs
Rate	t _{SSxx}	After enabling (Note 16)	SS_Lx = 1		5		

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Electrical Characteristics—300mA NMOS LDO (LDO8) (continued)

 $(V_{SYS} = 3.7V, V_{IN_LDO} = 3.7V, C_{IN_LDO} = 1\mu$ F, $C_{OUT_LDO} = 2.2\mu$ F. Limits are 100% production tested at T_A = +25°C Limits over the operating temperature range (T_A = -40°C to +85°C) are guaranteed by design and characterization, unless otherwise noted.)

PARAMETER	SYMBOL	COND	ITIONS	MIN	TYP	MAX	UNITS
Active Discharge Resistance		Output disabled, V _O from OUT_LDOx to discharge enabled (<i>i</i>	GND, active	65			Ω
THERMAL SHUTDOWN							
Thermal Shutdown		Output disabled or	T _J rising		165		3°
mermai Shuluown		enabled	T _J falling		150		
POWER-OK COMPARAT	OR						
Dower OK Threehold	M	VOUT when VPOK	V _{OUT} falling	84	87		%
Power-OK Threshold	V _{POKTHL}	switches	V _{OUT} rising		92	96	70

Note 16: Limits are 100% production tested at $T_A = +25^{\circ}C$. Limits over the operating temperature range are guaranteed through correlation using statistical quality control methods.

Note 17: Does not include ESR of the capacitance or trace resistance of the PCB.

Electrical Characteristics—450mA NMOS LDO (LDO7)

 $(V_{SYS} = 3.7V, V_{IN_LDO} = 3.7V, C_{IN_LDO} = 1\mu F, C_{OUT_LDO} = 2.2\mu F$. Limits are 100% production tested at T_A = +25°C. Limits over the operating temperature range (T_A = -40°C to +85°C) are guaranteed by design and characterization, unless otherwise noted.)

PARAMETER	SYMBOL	COND	ITIONS	MIN	TYP	MAX	UNITS
GENERAL CHARACTER	RISTICS						
Input Voltage Range	V _{IN_LDOx}	Guaranteed by outp	ut accuracy	VOUT		5.5	V
Output Voltage Range	V _{OUTxx}	V _{INxx} is the maximum of 3.7 or V _{OUT} +0.3V	50mV/step (6-bit), LDO7	0.8		3.95	v
Maximum Output		Guaranteed by	Normal mode	450			
Current	IMAXxx	output accuracy	Low-power mode		5		- mA
CORE PERFORMANCE	SPECIFICATION	IS					
Output Voltage		Normal mode	$\begin{array}{c} V_{IN} = V_{NOM} + 0.3V\\ to 5.5V, I_{OUT} =\\ 0.1mA to I_{MAX},\\ V_{NOM} set to any\\ voltage, V_{MBATT} =\\ V_{NOM} + 1.5V \mbox{ with}\\ 2.45V \mbox{ minimum} \end{array}$	-3		+3	
Accuracy		Low-power mode	$\begin{array}{c} V_{IN} = V_{NOM} + 0.3V\\ to 5.5V, I_{OUT} =\\ 0.1mA to 5mA,\\ V_{NOM} set to any\\ voltage, V_{MBATT} =\\ V_{NOM} + 1.5V \mbox{ with}\\ 2.45V \mbox{ minimum} \end{array}$	-5		+5	- %

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Electrical Characteristics—450mA NMOS LDO (LDO7) (continued)

 $(V_{SYS} = 3.7V, V_{IN_LDO} = 3.7V, C_{IN_LDO} = 1\mu F, C_{OUT_LDO} = 2.2\mu F$. Limits are 100% production tested at T_A = +25°C. Limits over the operating temperature range (T_A = -40°C to +85°C) are guaranteed by design and characterization, unless otherwise noted.)

PARAMETER	SYMBOL	COND	ITIONS	MIN	ТҮР	MAX	UNITS
Load Regulation (Note		Normal mode	$I_{OUT} = 0.1mA to$ $I_{MAX}, V_{IN} =$ $V_{NOM}+0.3V,$ $V_{MBATT} =$ $V_{NOM}+1.5V with$ $2.45V minimum$		0.05		- %
15)		Low-power mode	$I_{OUT} = 0.1mA \text{ to}$ 5mA, V _{IN} = V _{NOM} +0.3V, V _{MBATT} = V _{NOM} + 1.5V with 2.45V minimum		0.05		70
		Normal mode	V _{IN} = V _{NOM} +0.3V to 5.5V, I _{OUT} = 0.1mA		0.01		
Line Regulation (Note 15)		Low-power mode	$V_{MBATT} = V_{NOM}+0.3V \text{ to} 5.5V \text{ with } 2.45V \text{ minimum, } V_{IN} = V_{NOM}+0.3V \text{ to} 5.5V, I_{OUT} = 0.1mA$		0.01		%/V
		Normal mode, I _{OUT}	V _{MBATT-VOUT} = 2.5V		50	100	
Dropout Voltage	V _{DOxx}	= I _{MAX}	V _{MBATT-} V _{OUT} = 1.5V		150	450	mV
		Low-power mode, I _{OUT} = 5mA, V _{IN} = 3.7V			150	300	-
Output Current Limit	ILIMXX	V _{OUT} = 0V, % of I _{MA}	X	110	180	250	%
DYNAMIC CHARACTER	ISTICS		·				
Soft-Start and Dynamic-	t	After enabling, (Note 18)	SS_Lx = 0		100		m)//uo
Voltage-Change Ramp Rate	t _{SSxx}	After enabling (Note 18)	SS_Lx = 1		5		− mV/µs
Active Discharge Resistance		Output disabled, V _{OI} from OUT_LDOx to 0 discharge enabled (#	GND, active		65		Ω
THERMAL SHUTDOWN			I				
Thermal Shutdown		Output disabled or enabled			165		°C
			T _J falling		150		
POWER-OK COMPARA					07		1
Power-OK Threshold	VPOKTHL	V _{OUT} when V _{POK} switches	V _{OUT} falling	84	87		- %
		SWILLIES	V _{OUT} rising		92	96	

Note 18: Does not include ESR of the capacitance or trace resistance of the PCB.

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Note 19: During a soft-start event or a DVS transition, the regulators output current increases by C_{OUT} x dV/dt. In the event that the load current plus the additional current imposed by the soft-start or DVS transition reach the regulator's current limit, the current limit is enforced. When the current limit is enforced, the advertised transition rate (dV/dt) does not occur.

Electrical Characteristics—GPIO

 $(V_{SYS} = 3.6V, T_A = -40^{\circ}C$ to +85°C, limits are 100% tested at $T_A = +25^{\circ}C$. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

PARAMETER	SYMBOL	COND	CONDITIONS		TYP	MAX	UNITS
POWER SUPPLY		•					
	V _{MBATT}	GPIO0-3 (Note 20)		2.6		5.5	v
Power-Supply Voltage	V _{GPIO} INB	GPIO4-7 (Note 20)		1.7		5.5	- V
Supply Current	I _{GPIO_INB}	GPIO configured as to ground	input and connected			1	μA
GPIO INPUT							
Input Voltage Low	VIL	GPIO0-3, V _{MBATT} = GPIO4-7, V _{IN_GPIOE}				0.5	V
		GPIO0-3, V _{MBATT} =	2.6V to 5.5V	0.7 x V _{MBATT}			
Input Voltage High	V _{IH}	GPIO4-7, V _{IN_GPIOE}	₃ = 1.7V to 5.5V	0.7 x V _{GPIO_I} NB			V
Input Hysteresis	V _{HYS_GPIO}				0.25		V
		V _{IN_GPIOB} =	T _A = +25°C		0.001	1	
Input Leakage Current	ILKG_GPIOx	V _{MBATT} = 5.5V, VGPIOx = 0V and 5.5V, internal pull- up/down disabled	T _A = +85°C		0.01		μΑ
GPIO OUTPUT							
	Mar	I _{SINK} = 4mA, open-o mode	Irain and push-pull			0.08	v
Output Voltage Low	V _{OL}	I _{SINK} = 12mA, open- mode	-drain and push-pull			0.25	
Output Voltage High	V _{OH}	GPIO4-7	V _{IN_GPIOB} = 1.7V, I _{SOURCE} = 4mA	0.7 x V _{IN_GPI} OB			v
		GPIO0-3	V _{MBATT} = 3.6, I _{SOURCE} = 4mA	0.7 x V _{MBATT}			
GPIO Open Leakage		V _{IN GPIOB} =	T _A = +25°C		0.01	1	
Current		V _{MBATT} = 5.5V	T _A = +85°C		0.1		μA
INTERNAL RESISTANC	E						
Pullup Resistance	R _{PU_GPIO}			50	100	160	kΩ
Pulldown Resistance	R _{PD GPIO}			50	100	160	kΩ

Note 20: Guaranteed by V_{IH} and V_{IL} tests.

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Electrical Characteristics—32kHz Oscillator

 $(V_{SYS} = 3.6V, T_A = -40^{\circ}C$ to +85°C, limits are 100% tested at $T_A = +25^{\circ}C$. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
CRYSTAL OSCILLATOR							
Crystal-Oscillator Supply Voltage	V _{RTC}	(Note 21)	1.71	2.5		V	
Crystal Loading		32KLOAD = 0b01 (Note 22)		6.5		pF	
		32KLOAD = 0b10 (Note 22)		7.5			
		32KLOAD = 0b11 (Note 22)		12.5			
BYPASS MODE							
XIN I/O Voltage	V _{RTC}	Maximum V _{RTC} external load of 1mA		V _{RTC}		V	
XIN Input Low Voltage	$V_{XIN_{IL}}$		0		0.4	V	
XIN Input High Voltage	V _{XIN_IH}		V _{RTC} - 0.4		V _{RTC}	V	
XIN Input Hysteresis				400		mV	
XIN Input Leakage Current		T _A = +25°C	-1		+1	μA	
SILICON OSCILLATOR			·				
Silicon-Oscillator Supply Voltage	V _{RTC}		1.71	2.5		V	
Silicon Oscillator Output Frequency				32768		Hz	
VALID FREQUENCY DET	ECTOR		·				
Valid XOSCOK Signal Minimum Frequency	fDET_MIN			10		kHz	
Valid XOSCOK Signal Maximum Frequency	fDET_MAX			110		kHz	
OK32K Signal Debounce (Note 23)		Primary crystal oscillator (XOSCOK)		256		cycles	
		Backup silicon oscillator (XOSCOK)		32		cycles	

Note 21: Minimum supply for basic functionality with reduced accuracy.

Note 22: Includes 3pF of parasitic capacitance on XIN and XOUT.

Note 23: Number of valid cycles the frequency detector needs to count before it asserts OK32K.

Electrical Characteristics—Backup Battery Charger

 $(V_{SYS} = 3.6V, T_A = -40^{\circ}C$ to +85°C, limits are 100% tested at $T_A = +25^{\circ}C$. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS		
BACKUP BATTERY CHARGER									
Programmable Output Voltage Range		I _{LOAD} = 1μA	BBCVS[1:0] = 0x00	2.420	2.500	2.580	- V		
			BBCVS[1:0] = 0x01	2.910	3.000	3.090			
			BBCVS[1:0] = 0x02	3.200	3.300	3.400			
			BBCVS[1:0] = 0x03	3.395	3.500	3.605			

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Electrical Characteristics—Backup Battery Charger (continued)

 $(V_{SYS} = 3.6V, T_A = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ limits are 100\% tested at } T_A = +25^{\circ}C. \text{ Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)$

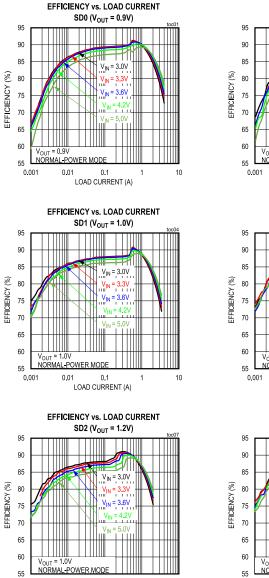
PARAMETER	SYMBOL	COND	MIN	ТҮР	MAX	UNITS	
Constant Current Limit		V _{BBATT} short to GND, BBCLOWIEN = 0	BBCCS[1:0] = 0x00, 0x01, 0x02		50		
			BBCCS[1:0] = 0x03		100		
			BBCCS[1:0] = 0x00		200		Α
		V _{BBATT} short to	BBCCS[1:0] = 0x00		600		
		GND, BBCLOWIEN = 1	BBCCS[1:0] = 0x02		800		
			BBCCS[1:0] = 0x03		400		
Output Resistance		BBCRS[1:0] = 0x00 BBCRS[1:0] = 0x01 BBCRS[1:0] = 0x02 BBCRS[1:0] = 0x03			0.1		
					1		- LO
					3		kΩ
					6		
Reverse Leakage Current from BBATT to VMBATT	Input = = 3.0V	Input = 0V, V _{BBATT} = 3.0V	T _A = +25°C		0.01	10	
			T _A = +85°C		0.1		μA

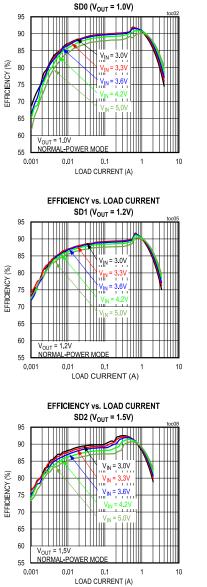
Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

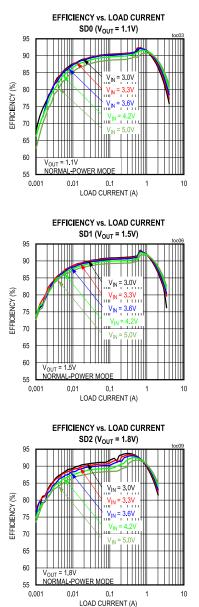
Typical Operating Characteristics

 $(AV_{VDD} = +3.3V, V_{DDIO} = +1.8V, V_{REFP} - V_{REFN} = V_{REF} = 2.5V$; No Line-Frequency Rejection, Continuous-Conversion Mode, Internal Clock; $T_A = T_{MIN}$ to T_{MAX} unless otherwise noted.)

EFFICIENCY vs. LOAD CURRENT







0.001

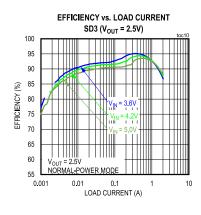
0.01

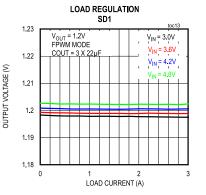
I 0.1 LOAD CURRENT (A) 10

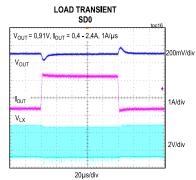
Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

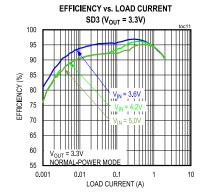
Typical Operating Characteristics (continued)

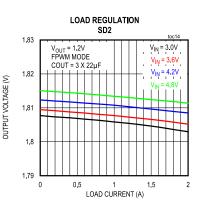
 $(AV_{VDD} = +3.3V, V_{DDIO} = +1.8V, V_{REFP} - V_{REFN} = V_{REF} = 2.5V$; No Line-Frequency Rejection, Continuous-Conversion Mode, Internal Clock; $T_A = T_{MIN}$ to T_{MAX} unless otherwise noted.)

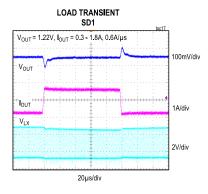


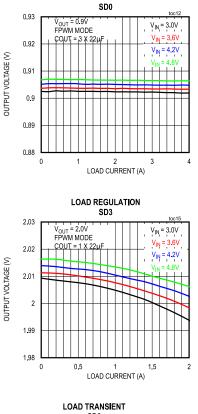




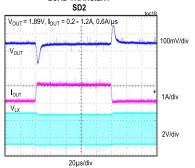








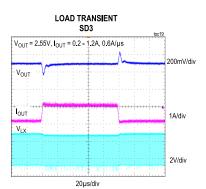
LOAD REGULATION

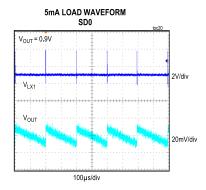


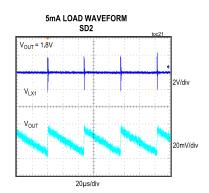
Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

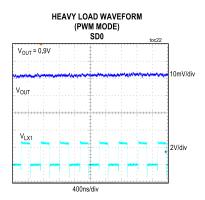
Typical Operating Characteristics (continued)

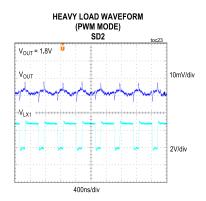
 $(AV_{VDD} = +3.3V, V_{DDIO} = +1.8V, V_{REFP} - V_{REFN} = V_{REF} = 2.5V$; No Line-Frequency Rejection, Continuous-Conversion Mode, Internal Clock; $T_A = T_{MIN}$ to T_{MAX} unless otherwise noted.)

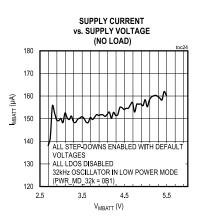


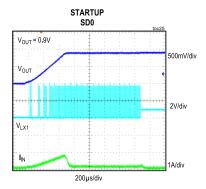


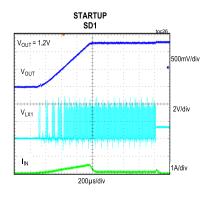


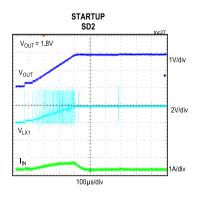








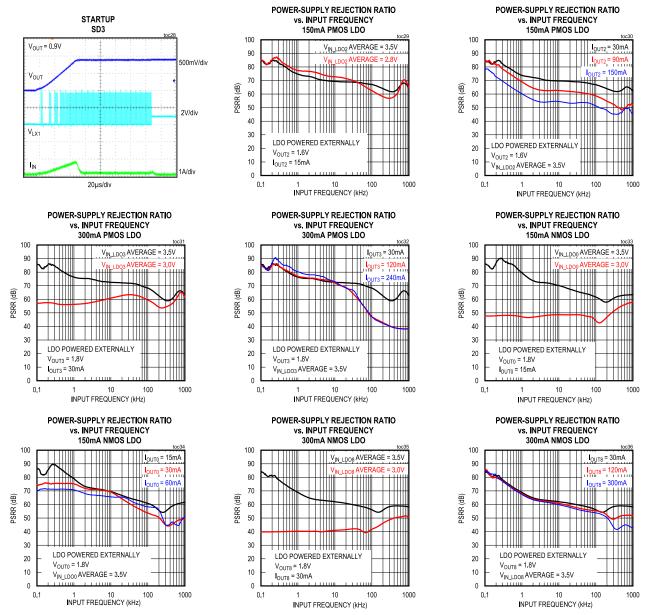




Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Typical Operating Characteristics (continued)

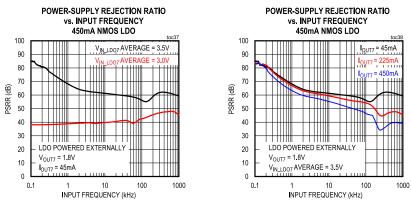
 $(AV_{VDD} = +3.3V, V_{DDIO} = +1.8V, V_{REFP} - V_{REFN} = V_{REF} = 2.5V$; No Line-Frequency Rejection, Continuous-Conversion Mode, Internal Clock; $T_A = T_{MIN}$ to T_{MAX} unless otherwise noted.)



Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Typical Operating Characteristics (continued)

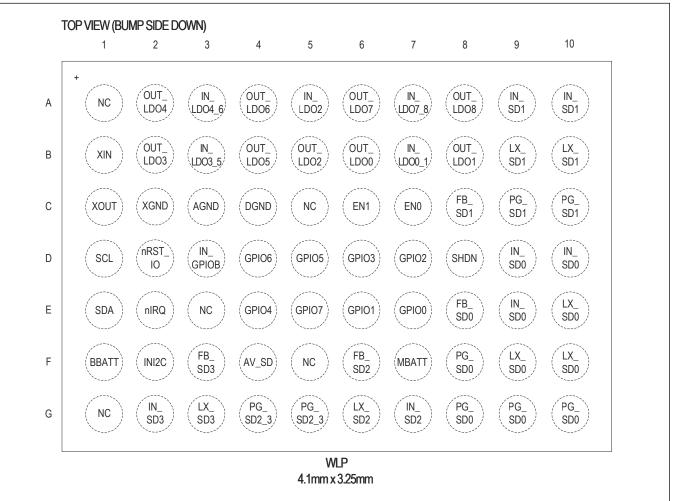
 $(AV_{VDD} = +3.3V, V_{DDIO} = +1.8V, V_{REFP} - V_{REFN} = V_{REF} = 2.5V;$ No Line-Frequency Rejection, Continuous-Conversion Mode, Internal Clock; $T_A = T_{MIN}$ to T_{MAX} unless otherwise noted.)



Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Bump Configuration

MAX77714



Bump Description

PIN	NAME	FUNCTION	TYPE	
ТОР			·	
F7	MBATT	Low-Noise PMIC Power Input. Bypass MBATT with a 0.1µF ceramic capacitor to ground.		
F1	BBATT	Backup Battery Connection. Bypass BBATT with a 0.1µF ceramic capacitor to ground.		
C1	XOUT	32.768kHz Crystal Oscillator Output. XOUT has on-chip programmable load capacitors for the crystal oscillator.		
B1	XIN	32.768kHz Crystal Oscillator Input. XIN has on-chip programmable load capacitors for the crystal oscillator.		
C2	XGND	Crystal Oscillator Ground. All XGND pins must be connected together. Gro		
E2	nIRQ	Active-Low Interrupt Output. nIRQ is an open-drain output.	Digital Output	

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Bump Description (continued)

PIN NAME FUNCTION		FUNCTION	TYPE
C7	EN0	Enable Input 0 to the Flexible Power Sequencer. EN0 is typically connected to the system's ONKEY.	Digital Input
C6	EN1	Enable Input 1 to the Flexible Power Sequencer. EN1 is typically connected to the system's AP.	Digital Input
D8	SHDN	The shutdown input (SHDN) is a digital input to the ON/OFF controller that causes the device to reset through a global shutdown event. The signal for SHDN typically comes from a temperature sensor that measures the internal die temperature of the AP.	Digital Input
D2	nRST_IO	This is a bidirectional, active-low, open-drain, reset input/output.	Digital I/O
C3	AGND	Analog Ground. All GND pins must be connected together.	Ground
C4	DGND	Digital Ground. DGND carries ground current for digital circuits such as the I ² C.	Ground
A1, G1, E3, F5, C5	NC	No Connect. This bump is not internally connected to any node. This can be connected to GND to help improve thermal performance.	Ground
LDO		1	L
B7	IN_LDO0_1	Linear Regulator 0 and 1 Power Input. Bypass IN_LDOx to GND with a $2.2\mu\text{F}$ ceramic capacitor.	Power Input
B6	OUT_LDO0	150mA NMOS LDO Output. If the LDO is not used, it is recommended to either ground OUT_LDO0 or leave it unconnected.	Power Output
B8	OUT_LDO1	150mA NMOS LDO1 Output. If the LDO1 is not used, it is recommended to either ground OUT_LDO1 or leave it unconnected.	Power Output
A5	IN_LDO2	Linear Regulator 2 Power Input. Bypass IN_LDO2 to GND with a 2.2 μ F ceramic capacitor.	Power Input
B5	OUT_LDO2	150mA PMOS LDO Output. If the LDO is not used, it is recommended to either ground OUT_LDO2 or leave it unconnected.	Power Output
B3	IN_LDO3_5	Linear Regulator 3 and 5 Power Input. Bypass IN_LDO3_5 to GND with a 2.2 μF ceramic capacitor.	Power Input
B2	OUT_LDO3	300mA PMOS LDO Output. If the LDO is not used, it is recommended to either ground OUT_LDO3 or leave it unconnected.	Power Output
B4	OUT_LDO5	150mA PMOS LDO Output. If the LDO is not used, it is recommended to either ground OUT_LDO5 or leave it unconnected.	Power Output
A3	IN_LDO4_6	Linear Regulator 4 and 6 Power Input. Bypass IN_LDO4_6 to GND with a $2.2\mu\text{F}$ ceramic capacitor.	Power Input
A2	OUT_LDO4	150mA PMOS LDO Output. If the LDO is not used, it is recommended to either ground OUT_LDO4 or leave it unconnected.	Power Output
A4	OUT_LDO6	150mA PMOS LDO Output. If the LDO is not used, it is recommended to either ground OUT_LDO6 or leave it unconnected.	Power Output
A6	OUT_LDO7	450mA NMOS LDO Output. If the LDO is not used, it is recommended to either ground OUT_LDO7 or leave it unconnected.	Power Output
A7	IN_LDO7_8	Linear Regulator 7 and 8 Power Input. Bypass IN_LDO7_8 to GND with a $2.2\mu F$ ceramic capacitor.	Power Input
A8	OUT_LDO8	300mA NMOS LDO Output. If the LDO is not used, it is recommended to either ground OUT_LDO8 or leave it unconnected.	Power Output
STEP-DOWN			
D9, E9, D10	IN_SD0	SD0 Power Input. IN_SD0 is the drain connection of BUCK0's main power FET. IN_SD0 is a critical discontinuous-current node that requires careful PCB layout. See the <u>PCB Layout Guidelines</u> section for advice on how to connect IN_SD01 and its bypass capacitor.	Power Input

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Bump Description (continued)

PIN	NAME	FUNCTION	TYPE
F9, F10, E10	LX_SD0	SD0 Switching Node. Connect the required inductor between LX_SD0 and the output capacitor. LX_SD0 is a critical node that requires careful PCB layout. See the <u>PCB Layout Guidelines</u> section for advice on how to connect LX_SD0 to the power inductor.	Power I/O
F8, G8, G9, G10	PG_SD0	SD0 Power Ground are internally combined. PG_SD0 is the source connection of BUCK0's synchronous rectifier. PG_SD0 is a critical discontinuous current node that requires careful PCB layout. See the <u>PCB Layout Guidelines</u> section for advice on how to connect the various ground nodes of this device.	Ground
E8	FB_SD0	SD0 Output Voltage Feedback Node. Connect FB_SD0 to the local output capacitor at the Buck output. In addition to setting the output voltage regulation threshold, FB_SD0 can also be programmed to discharges the output capacitor when the converter is shutdown. FB_SD0 is a critical analog input that requires careful PCB layout. See the <u>PCB Layout Guidelines</u> section for advice on how to connect FB_SD0 to the regulator output.	Analog Input
A9, A10	IN_SD1	SD1 Power Input. IN_SD1 is the drain connection of BUCK1's main power FET. IN_SD1 is a critical discontinuous-current node that requires careful PCB layout. See the <u>PCB Layout Guidelines</u> section for advice on how to connect IN_SD1 and its bypass capacitor.	Power Input
B9, B10	LX_SD1	SD1 Switching Node. Connect the required inductor between LX_SD1 and the output capacitor. LX_SD1 is a critical node that requires careful PCB layout. See the <u>PCB Layout Guidelines</u> section for advice on how to connect LX_SD1 to the power inductor.	Power I/O
C9, C10	PG_SD1	SD1 Power Ground are internally combined. PG_SD1 is the source connection of BUCK1's synchronous rectifier. PG_SD1 is a critical discontinuous-current node that requires careful PCB layout. See the <u>PCB Layout Guidelines</u> section for advice on how to connect the various ground nodes of this device.	Ground
C8	FB_SD1	SD1 Output Voltage Feedback Node. Connect FB_SD1 to the local output capacitor at the Buck output. In addition to setting the output voltage regulation threshold, FB_SD1 can also be programmed to discharge the output capacitor when the converter is shutdown. FB_SD1 is a critical analog input that requires careful PCB layout. See the <u>PCB Layout Guidelines</u> section for advice on how to connect FB_SD1 to the regulator output.	Analog Input
G7	IN_SD2	SD2 Power Input. IN_SD2 is the drain connection of BUCK2's main power FET. IN_SD2 is a critical discontinuous-current node that requires careful PCB layout. See the <u>PCB Layout Guidelines</u> section for advice on how to connect IN_SD2 and its bypass capacitor.	
G6	LX_SD2	SD2 Switching Node. Connect the required inductor between LX_SD2 and the output capacitor. LX_SD2 is a critical node that requires careful PCB layout. See the <u>PCB Layout Guidelines</u> section for advice on how to connect LX_SD2 to the power inductor.	
G4, G5	PG_SD2_3	SD2 and SD3 Power Ground are internally combined. PG_SD2_3 is the source connection of SD2 and 3's synchronous rectifier. PG_SD2_3 is a critical discontinuous-current node that requires careful PCB layout. See the <u>PCB Layout</u> <u>Guidelines</u> section for advice on how to connect the various ground nodes of this device.	
F6	FB_SD2	SD2 Output Voltage Feedback Node. Connect FB_SD2 to the local output capacitor at the Buck output. In addition to setting the output voltage regulation threshold, FB_SD2 can also be programmed to discharge the output capacitor when the converter is shutdown. FB_SD2 is a critical analog input that requires careful PCB layout. See the <u>PCB Layout Guidelines</u> section for advice on how to connect FB_SD2 to the regulator output.	Analog Input

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Bump Description (continued)

PIN	NAME	FUNCTION	TYPE
G2	IN_SD3	SD3 Power Input. IN_SD3 is the drain connection of BUCK1's main power FET. IN_SD3 is a critical discontinuous-current node that requires careful PCB layout. See the <u>PCB Layout Guidelines</u> section for advice on how to connect IN_SD3 and its bypass capacitor.	Power Input
G3	LX_SD3	SD3 Switching Node. Connect the required inductor between LX_SD3 and the output capacitor. LX_SD3 is a critical node that requires careful PCB layout. See the <u>PCB Layout Guidelines</u> section for advice on how to connect LX_SD3 to the power inductor.	Power I/O
F3	FB_SD3	SD3 Output Voltage Feedback Node. Connect FB_SD3 to the local output capacitor at the Buck output. In addition to setting the output voltage regulation threshold, FB_SD3 can also be programmed to discharge the output capacitor when the converter is shutdown. FB_SD3 is a critical analog input that requires careful PCB layout. See the <u>PCB Layout Guidelines</u> section for advice on how to connect FB_SD3 to the regulator output.	Analog Input
F4	AV_SD	SD3 Analog Power input. Connect AV_SD to the local output capacitor at the Buck Input. This supply powers the internal analog circuit.	Analog Input
l ² C			
E1	SDA	Serial Interface Data Bidirectional Open-Drain.	Digital I/O
D1	SCL	Serial Interface Clock Input. Open-Drain Output.	Digital Input
F2	INI2C	Internal Logic Supply for SDA and SCL.	
GPIO			
E7	GPIO0	General Purpose Input Output resource can be controlled using the Flexible Power Sequencer.	Digital I/O
E6	GPIO1	General Purpose Input Output resource can be controlled using the Flexible Power Sequencer.	Digital I/O
D7	GPIO2	General Purpose Input Output resource can be controlled using the Flexible Power Sequencer.	Digital I/O
D6	GPIO3	General Purpose Input Output resource and can be configured as an ACOK input when configured in ALT mode.	Digital I/O
E4	GPIO4	General Purpose Input Output resource and can be confirgure to output 32kHz clock when configured in ALT mode.	Digital I/O
D5	GPIO5	General Purpose Input Output resource and can be configured to output 32kHz clock when configured in ALT mode.	Digital I/O
D4	GPIO6	General Purpose Input Output resource and can be configured to output 32kHz clock when configured in ALT mode.	Digital I/O
E5	GPIO7	General Purpose Input Output resource can be controlled using the Flexible Power Sequencer.	Digital I/O
D3	IN_GPIOB	Input for the General Purpose Input Output resource 4-7.	Digital I/O

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Detailed Description

OTP Options

Refer to <u>Table 1</u> for the default register settings.

Table 1. OTP Options

RESOURCE	MAX77714EWC+	MAX77714FEWC+	MAX77714GEWC+
CID4	0x01	0x06	0x08
MSTR_PU[2:0]	3904µs	984µs	984µs
MSTR_PD[2:0]	3904µs	31µs	31µs
MSTR_SLPENTY[2:0]	3904µs	984µs	984µs
MSTR_SLPEXT[2:0]	3904µs	31µs	31µs
SD0	0.90V, FPS0, UPSLT1, DNSLT1	1.20V, FPS1, UPSLT1, DNSLT0	1.20V, FPS1, UPSLT1, DNSLT0
SD1	1.29V, FPS0, UPSLT3, DNSLT3	0.90V, FPS1, UPSLT3, DNSLT0	0.90V, FPS1, UPSLT3, DNSLT0
SD2	1.80V, FPS0, UPSLT5, DNSLT5	0.625V, FPS0, UPSLT5, DNSLT0	0.625V, FPS0, UPSLT5, DNSLT0
SD3	0.90V, FPS0, UPSLT4, DNSLT4	3.6V, NOT CONFIGURED IN FPS, OUTPUT DISABLED	3.6V, NOT CONFIGURED IN FPS, OUTPUT DISABLED
LDO0	1.80V, FPS0, UPSLT6, DNSLT6	0.8V, FPS1, UPSLT6, DNSLT0, OUTPUT DISABLED	0.8V, FPS1, UPSLT6, DNSLT0, OUTPUT DISABLED
LDO1	0.90V, FPS0, UPSLT6, DNSLT6	0.8V, FPS1, UPSLT6, DNSLT0, OUTPUT DISABLED	0.8V, FPS1, UPSLT6, DNSLT0, OUTPUT DISABLED
LDO2	3.30V, FPS0, UPSLT6, DNSLT6	2.5V, FPS1, UPSLT2, DNSLT0, NORMAL-POWER MODE	2.5V, FPS1, UPSLT4, DNSLT6, NORMAL POWER MODE
LDO3	2.90V, FPS0, UPSLT6, DNSLT6	3.3V, FPS1, UPSLT6, DNSLT0, GLOBAL LOW-POWER MODE	3.3V, FPS1, UPSLT6, DNSLT0, OUTPUT DISABLED
LDO4	0.90V, FPS0, UPSLT6, DNSLT6	0.4V, FPS1, UPSLT6, DNSLT0, OUTPUT DISABLED	0.4V, FPS1, UPSLT6, DNSLT0, OUTPUT DISABLED
LDO5	3.30V, FPS0, UPSLT6, DNSLT6	0.8V, FPS1, UPSLT6, DNSLT0, OUTPUT DISABLED	0.8V, FPS1, UPSLT6, DNSLT0, OUTPUT DISABLED
LDO6	1.80V, FPS0, UPSLT4, DNSLT4	0.8V, FPS1, UPSLT6, DNSLT0, OUTPUT DISABLED	0.8V, FPS1, UPSLT4, DNSLT0, OUTPUT DISABLED
LDO7	3.30V, FPS0, UPSLT6, DNSLT6	0.8V, FPS1, UPSLT6, DNSLT0, OUTPUT DISABLED	0.8V, FPS1, UPSLT6, DNSLT0, OUTPUT DISABLED
LDO8	2.90V, FPS0, UPSLT7, DNSLT7	0.8V, FPS1, UPSLT6, DNSLT0, OUTPUT DISABLED	0.8V, FPS1, UPSLT7, DNSLT0, GLOBAL LOW-POWER MODE
GPIO0	FPS0, UPSLT0, DNSLT0	NOT CONFIGURED IN FPS	FPS0, UPSLT7, DNSLT7
RSTIO	FPS0, UPSLT7, DNSLT7	FPS0, UPSLT4, DNSLT7	FPS0, UPSLT7, DNSLT7
32KSOURCE_OTP	0b1 (Silicon Oscillator)	0b1 (Silicon Oscillator)	0b1 (Silicon Oscillator)
OTP_EN0[1:0]	0b10 (ON/OFF Software)	0b01 (Slide Switch)	0b01 (Slide Switch)
OTP_MR	0b0 (Manual reset with no wakeup)	0b0 (Manual reset with no wakeup)	0b0 (Manual reset with no wakeup)
OTP_I2CADDR[1:0]	0b00 PMIC 7-bit address = 0x38 RTC 7-bit slave address = 0x90	0b00 PMIC 7-bit address = 0x38 RTC 7-bit slave address = 0x90	0b01 PMIC 7-bit slave address = 0x3C RTC 7-bit slave address = 0x94

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

OTP_MBATT	0b0 (MBATT wakeup signal disabled)	0b0 (MBATT wakeup signal disabled)	0b0 (MBATT wakeup signal disabled)
OTP_TRSTO[1:0]	0b10 (32ms)	0b00 (1ms)	0b00 (1ms)
OTP_SHDNAL	0b0 (Active-high)	0b0 (Active-high)	0b0 (Active-high)
OTP_BBATT	0b0 (BBCVS[0] will always reset to 1b0)	0b0 (BBCVS[0] will always reset to 1b0)	0b0 (BBCVS[0] will always reset to 1b0)
OTP_ACOKAL	0b0 (Active-high)	0b0 (Active-high)	0b0 (Active-high)
OTP_EN1AL	0b0 (Active-high)	0b0 (Active-high)	0b1 (Active-low)
OTP_EN0AL	0b0 (Active-high)	0b0 (Active-high)	0b0 (Active-high)
OTP_WDTEN	0b0 (Watchdog default off, can be enabled with I ² C)	0b0 (Watchdog default off, can be enabled with I ² C)	0b0 (Watchdog default off, can be enabled with I ² C)

Table 1. OTP Options (continued)

Detailed Description—Global Resources

Voltage References, Bias Currents, and Timing References

Centralized voltage references, bias current, and timing references support all of the functional blocks within the MAX77714. These resources are automatically enabled when any of the peripheral functions within the device require them. The supply current associated with the minimum set of these resources make up the quiescent current (I_{Q MBATT}).

Voltage Monitors

The MBATT undervoltage lockout (UVLO) and MBATT overvoltage lockout (OVLO) comparators force the entire device off when the supply voltage (V_{MBATT}) is not within the acceptable window of operation (2.6V to 5.5V). Disabling the device when the supply is outside of its acceptable range ensures reliable consistent behavior when the supply voltage is removed/applied and prevents overvoltage stress to the device. The main-battery low signal is also available through the nRST_IO signal when LBRSTEN = 1. With all peripheral blocks of the device disabled, the quiescent current of the device is 12µA (I_{Q MBATT}).

Thermal Monitors

Several on-chip thermal sensors force the device to shutdown if the junction temperature exceeds +165°C (T_{JSHDN}). In addition to the +165°C shutdown threshold, these thermal sensors also provide interrupts when the temperature exceeds +120°C (thermal alarm 1) and +140°C (thermal alarm 2).

Bidirectional Reset Input/Output

The device has a bidirectional, active-low, open-drain, reset input/output (nRST_IO). The RSO signal within the bidirectional reset IO logic is asserted by the device when it needs to drive nRST_IO low. If the device is not driving nRST_IO low (i.e., RSO is low), and an external device such as a reset button pulls nRST_IO low, then the RSI signal within the bidirectional reset IO logic is asserted. If RSI is asserted for longer than t_{DBNC}, then a global shutdown event is triggered (GLBALSHDN). A global shutdown due to RSI is recorded in the POERC register such that when the system's microprocessor recovers from the reset it can recognize that the cause of the power down was due to RSI. If a global shutdown event is triggered by RSI, then the deviceautomatically generates a wakeup event after the global shutdown event has completed.

The reset output is a programmable slave to the flexible power sequencer. Allowing the RSO to respond to the flexible power sequencer gives it the capability to drive the nRST_IO line low as the first action in the power down sequence. The RSTIOFPS register configures how nRST_IO behaves with respect to the flexible power sequencer.

Once all conditions for allowing the reset output to go high-impedance have been met, a reset delay timer is initiated before RSO is deasserted (t_{RST} O).

The following bulleted list summarizes all the conditions required for the device to set RSO low and allow nRST_IO to go high-impedance.

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

- The device must not be in a global shutdown state.
- The 32kHz oscillator must be stable (32K_OK).
- The flexible power sequencer (FPS_RSO) must be satisfied.
- Reset timer has expired (t_{RST O}).

An example configuration that allows nRST_IO to go high-impedance is:

- No global shutdown events.
- The main-battery voltage is within the valid region.
- The 32kHz clock is stable.
- FPS0 (flexible power sequencer 0) has gotten past power-up cycle 4 (FPS_RSO).
- t_{RST O} expired.
- No external device such as a reset button are pulling nRST_IO low.

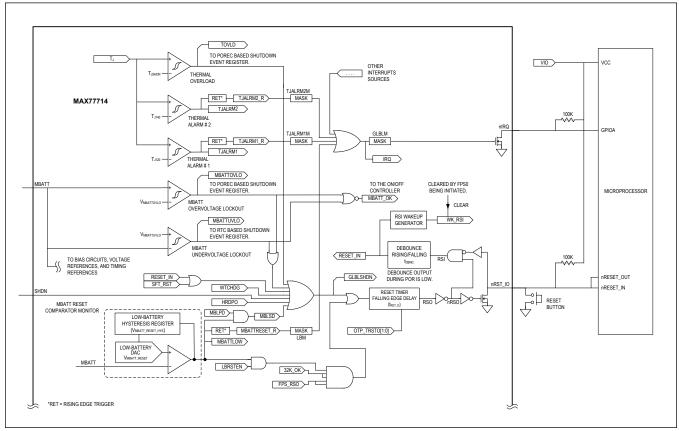


Figure 1. Global Resource Logic

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Global Shutdown

This document uses the term "global shutdown" to refer to any event that causes a shutdown of all regulators and a reset for most of the registers within the device. The POERC register records the source of a "global shutdown" event. The various conditions which cause a global shutdown are as follows:

- The battery voltage is low (MBATT < MBATT_RESET falling)
- · Hardware reset input (RSI) event detected
- Manual Reset event detected
- Watchdog timer expires
- SFT_RST = 1
- PWR_OFF = 1
- The junction temperature is too high ($T_J > T_{JSHDN}$)
- SHDN pin is asserted (SHDN = 1)
- SRCFPS0 = 1 and ENFPS0 register transitions from HIGH to LOW

After a global shutdown occurs, the device can be powered up normally as long as the main-battery voltage and the die temperature are within their valid ranges. Although all regulators are forced off in response to a global shutdown, the RTC remains powered and continues to record the calendar.

From any state in the device, there are three ways of implementing a "global shutdown". The source of the global shutdown event determines how a global shutdown is implemented as described in the following:

Global Shutdown Events with Sequenced Shutdown and Automatic Wakeup

The events in this category are associated with faulty system states where the software may not be working properly but the system could potentially recover by powering down the microprocessor, resetting all the global shutdown registers, and then powering up the microprocessor again. The following events initiate a sequenced shutdown followed by automatic wakeup:

- RSI event (hardware reset input)
- SFT_RST event if SFT_RST_WK = 1 (software reset input)
- Watchdog timer expires if WD_RST_WK = 1
- Manual reset event if OTP_MR = 1

Global Shutdown Events with Sequenced Shutdown to the OFF State

Six events initiate "sequenced global shutdown to the off state." With the exception of PWR_OFF, which is a normal system function, the events in this category are associated with undesirable system states that may occur in a normally functioning product. Powering down the microprocessor and resetting all the global shutdown registers helps the system resolve these undesirable events. In general, a wakeup event such as an onkey press is required to power-up the microprocessor again.

In the case of a software reset input (SFT_RST) with SFT_RST_WK = 0, the global shutdown state machine results in the default state with the device off and waiting for a wakeup event. It is possible for the system software to program a wakeup event based on an RTC alarm. For example, once the state machine lands in the default state it waits there until the RTC alarm generates the wakeup event.

The following six conditions fall into this category:

- Watchdog timer expires if WD_RST_WK = 0
- Manual reset event if OTP_MR = 0
- SFT_RST event if SFT_RST_WK = 0 (software reset input)
- PWR_OFF = 1
- T_J > T_{JSHDN} (thermal overload)
- SHDN input event

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Global Shutdown Events with Immediate Shutdown

Four events initiate an "immediate shutdown." The events in this category are associated with potentially hazardous system events. Powering down the microprocessor and resetting all the registers helps mitigate any issues that may occur due to these potentially hazardous system events.

The following four events fall in this category:

- V_{MBATT} < V_{MBATTUVLO} (main-battery undervoltage)
- V_{MBATT} > V_{MBATTOVLO} (main-battery overvoltage)
- OK32K = 0 (in or after standby state)
- BRDY = 0 (in or after ready state)

System Watchdog Timer

The MAX77714 contains a system watchdog timer to ensure safe and reliable operation. The system watchdog timer prevents the device from powering a system in the event that the system controller (processor) hangs or otherwise isn't communicating correctly. The default state of the system watchdog timer enable bit (WDTEN) can be factory programmed with an OTP bit (OTP_WDTEN). To use the watchdog timer feature, enable the feature by setting WDTEN. While enabled, the system controller must reset the system watchdog timer within the timer period (t_{WD}) for the charger to operate normally. Reset the system watchdog timer by programming WDTC[1:0] = 0b01. t_{WD} is programmable from 2s to 128s with TWD[1:0].

With WDTEN set, an internal counter is incremented with the internal oscillator. When the internal counter matches a value programmed by TWD[1:0], the device asserts nRST_IO, powers down all of its regulators with a global shutdown condition, and sets the WDT bit in the non-volatile event recorder.

To prevent the system watchdog timer from initiating a global shutdown event and disabling the device, a properly operating processor clears the system watchdog timer within the timer period programmed by TWD[1:0]. The system watchdog time is cleared by setting WDTC[1:0] = 0b01.

The system watchdog timer can be set to automatically clear when the AP enters its sleep or off states. The device interprets the AP sleep state as FPS1 being disabled. The device interprets the off state as FPS1 being disabled.

Note that the device contains both a system watchdog timer and an I²C watchdog timer.

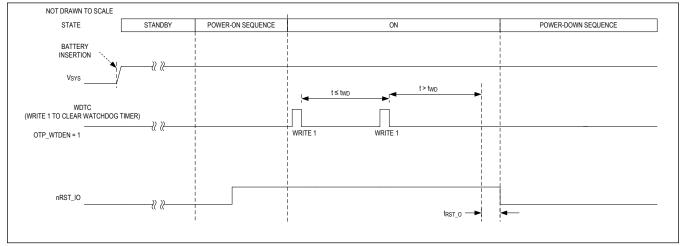


Figure 2. System Watchdog Timer

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

EN0 Functionality

The EN digital input can be configured to work with a push-button switch, a slide-switch, or a ON/OFF logic signal (e.g., PGOOD). (Figure 3) shows EN's functionality for power-on sequencing and manual reset. The default configuration of the device is pushbutton mode and no additional programming is necessary. Applications that use a slide-switch on-key or ON/OFF logic signal configuration must set OTP_EN0[1:0]. The polarity of EN0 can be controlled using the OTP_EN0AL bit. The default is active high.

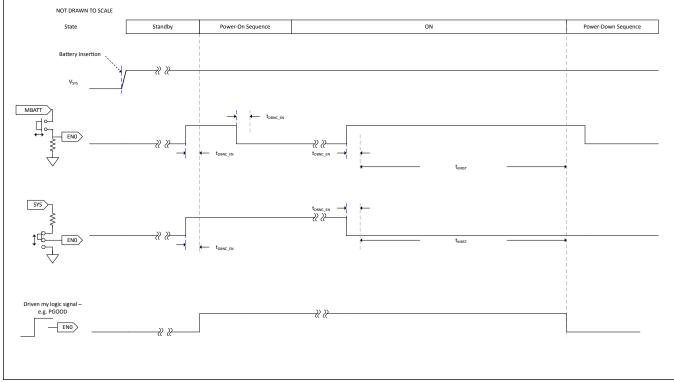


Figure 3. EN0 Functionality Options

Interrupt Logic

Several interrupt and interrupt mask registers monitor key information and assert the nIRQ output signal when an interrupt event has occured. nIRQ is an active-low, open-drain output that is typically routed to the processor's interrupt input to allow for quick notification of interrupt events. A pullup resistor is require for this signal. This pullup resistor is typically found inside the processor that interprets the interrupt signal, but a board-mounted pullup resistor is required if one is unavailable.

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

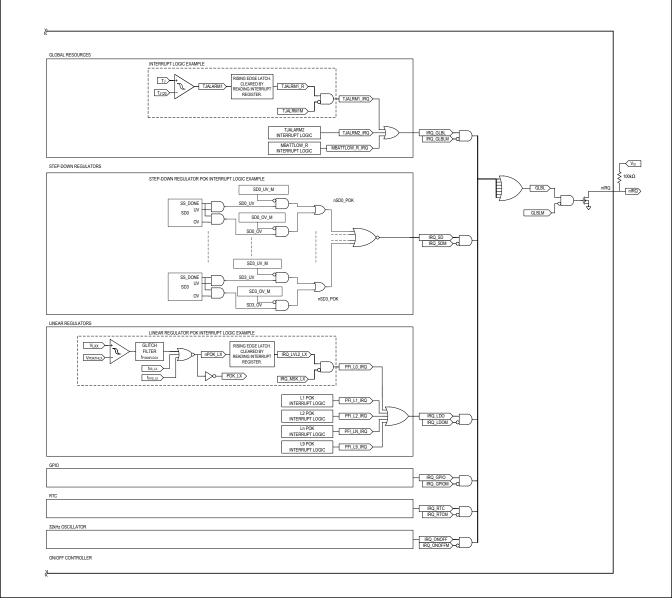


Figure 4. Simplified Interrupt Status and Mask Logic

Detailed Description—ON/OFF Controller

ON/OFF Controller

The ON/OFF controller monitors multiple wakeup sources to intelligently enable all resources that are necessary for the AP to boot (i.e., FPS0 and FPS1). The ON/OFF controller monitors wakeup events on the EN0, EN1, ACOK, and nRST_IO hardware inputs. Additionally, internal wakeup events are also monitored: SMPL, ALARM1, and ALARM2 internal signals. Wakeup events go through logic to affect flexible power sequencers 0 and 1 (FPS0, FPS1). Many wakeup signals can be masked (WK_ACOK, WK_ALARM1, WL_ALARM2, WK_EN0).

Many signals within the ON/OFF controller generate interrupts and are recorded in the status registers.

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

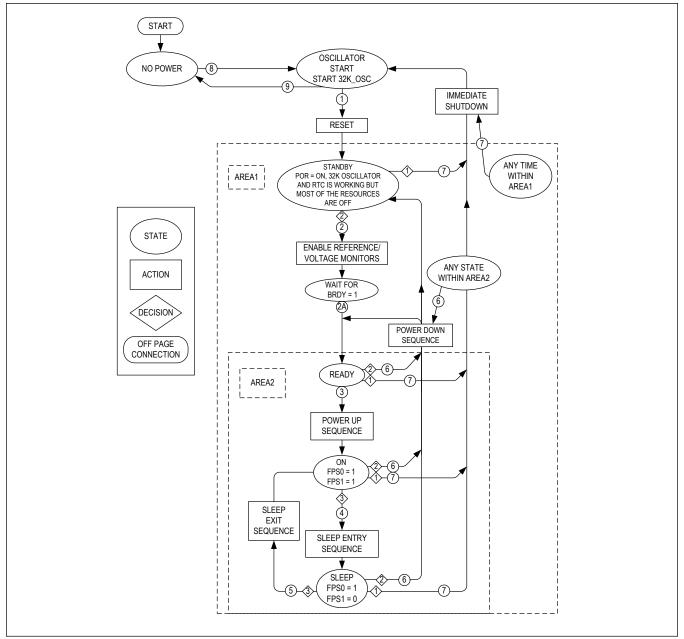


Figure 5. State Diagram: ON/OFF Controller Top Level

Table 2. ON/OFF Controller Transition Conditions

TRANSITION	CONDITION		
1	 The fundamental system voltages and resources are available. Move to the standby state. 32kHz oscillator is OK (OK32K = 1) OR The battery voltage is undervoltage (V_{MBATT} > V_{MBATTUVLO}) OR The battery voltage is overvoltage (V_{MBATT} < V_{MBATTOVLO}) 		

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Table 2. ON/OFF Controller Transition Conditions (continued)

2	 I²C Bias Enable Command OR A wakeup signal has been received from one of the following sources: A debounced EN0 press (i.e., edge) and WK_EN0 is SET has been detected OR ALARM1_R event occurs and WK_ALRM1R is set OR ALARM2_R event occurs and WK_ALRM2R is set OR SMPL_EVENT occurs and SMPL_EN is set OR ACOK event (i.e., level) occurs and WK_ACOK is set OR MBATT > MBATTUVLO rising and WK_MBATT is set OR WAKEUP flag is set by the previous sequenced shutdown (starts at STANDBY state post power-down event) SRCFPS0 = 1 and ENFPS0 register transitions from LOW to HIGH
2A	The basic system resources are okay • BRDY = 1 and t _{BRDY_TMR} not expired
3	If a wakeup signal was initiated at transition "2" then proceed to powerup sequence, else stay in Ready state and wait for wakeup
4	Enter Sleep Mode Sleep mode is enabled (SLPEN = 1) and EN1 transitions from high to low (OTP_EN1AL = 1) OR SRCFPS1 = 1 and ENFPS1 register transitions from HIGH to LOW
5	 Exit Sleep Mode Sleep mode is enabled (SLPEN = 1) and EN1 transitions from low to high OR A debounced EN0 press and WK_EN0 is SET has been detected OR ALARM1_R event occurs and WK_ALRM1R is set OR ALARM2_R event occurs and WK_ALRM2R is set OR ACOK event (i.e. level) occurs and WK_ACOK is set OR SRCFPS0 = 1 and ENFPS0 register transitions from LOW to HIGH SRCFPS1 = 1 and ENFPS1 register transitions from LOW to HIGH
6	Enter the Power-Down Sequence with Register Reset • The battery voltage is low (MBATT < MBATT_RESET falling) OR • Hardware reset input (RSI) event detected OR • Manual reset event detected OR • SFT_RST = 1 OR • PWR_OFF = 1 OR • The junction temperature is too high (T _J > T _{JSHDN}) OR • SHDN pin is asserted (SHDN = 1) • SRCFPS0 = 1 and ENFPS0 register transitions from HIGH to LOW
7	Immediate Shutdown • The battery voltage is undervoltage (V _{MBATT} < V _{MBATTUVLO}) OR • The battery voltage is overvoltage (V _{MBATT} > V _{MBATTOVLO}) OR • OK32K = 0 OR • BRDY = 0 t _{BRDY_TMR} expired
8	Oscillator Start • V _{MBATT} > V _{MBATTPOR}
9	No Power • V _{MBATT} < V _{MBATTPOR}

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Power-Up/Down Sequence

The device integrated a flexible power sequencer (FPS) that controls the power-up and power-down timing of the system. The functionality of the FPS is described as follows:

- The power-up/down sequence consists of two FPS masters (FPS0 and FPS1) each contains 8 slots.
- The 8 slots count sequentially in time during both power-up and power-down.
- During the power-up sequence (Figure 6), the slots count upwards from 0 to 7.
- During the power-down sequence (Figure 7), the slots count downwards from 7 to 0.
 - The events in this category are associated with faulty system states where the software may not be working
 properly but the system could potentially recover by powering down the microprocessor, resetting all the global
 shutdown registers, and then powering up the microprocessor again.
- Regulators enable in their assigned slots in the power-up sequence. Regulators disabled in their assigned slots in the power-down sequence.
- GPIOs assert logic-high in their assigned slot in the power-up sequence. GPIOs assert logic-low in their assigned slot in the power-down sequence.
- Three dedicated bits are available to program the slot pitch (t_{FPST}, time between slots) and are programmable between 31µs to 3904µs in eight binary weighted steps.
 - FPS0 power-up sequence (MSTR_PU[2:0]), power-down sequence (MSTR_PD[2:0]).
 - FPS1 sleep exit power-up sequence (MSTR_SLPEXT[2:0]), Sleep entry power-down sequence (MSTR_SLPENTY[2:0]).

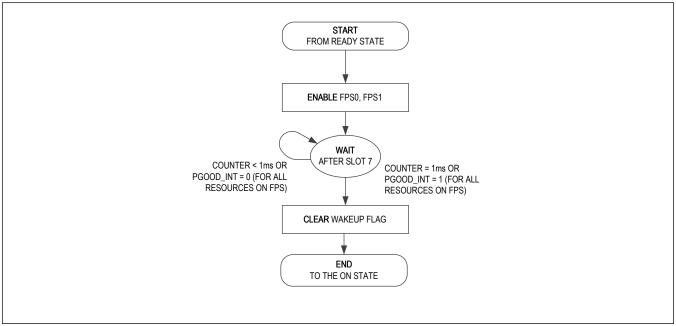


Figure 6. Flow Chart—Power-Up Sequence

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

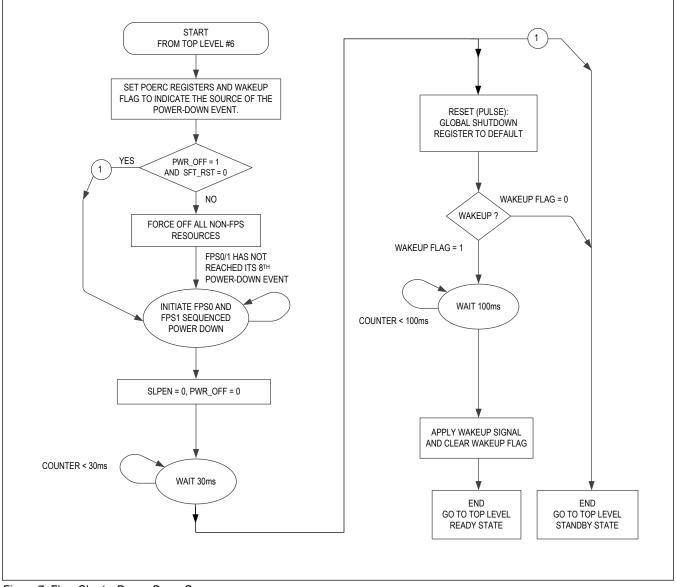


Figure 7. Flow Chart—Power-Down Sequence

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Immediate Shutdown

The events in this category are associated with potentially hazardous system events. Powering down the microprocessor and resetting all the device registers helps mitigate any issues that may occur due to these potentially hazardous system events.

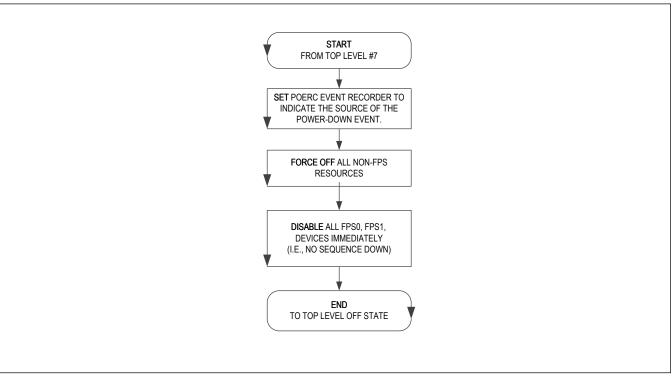


Figure 8. Flow Diagram: Immediate Shutdown

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

RESET

The reset state puts the PMIC in an initial known state by following the flow in (Figure 9).

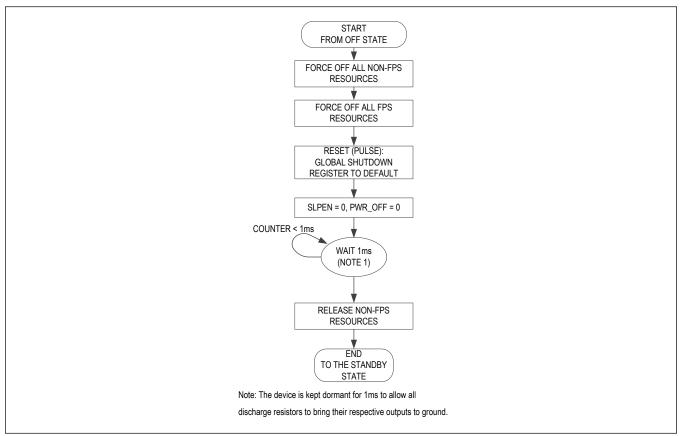


Figure 9. Reset Flow Diagram

EN0

EN0 is a digital input to the ON/OFF controller that typically comes from the system's on-key. The EN0 polarity is factoryprogrammable with OTP (OTP_EN0AL) to be active-high or active-low

EN1

EN1 is a digital input to the ON/OFF controller that typically comes from the system's AP. EN1 is used to control sleep modes. The EN1 polarity is factory-programmable with OTP (OTP_EN1AL) to be active-high or active-low.

ACOK

ACOK is a digital input (GPIO3 ALT mode) to the ON/OFF controller that typically comes from the system's battery charger. ACOK indicates the presence/absence of the external charge adapter. The ACOK polarity is factory-programmable with OTP (OTP_ACOKAL) to be active-high or active-low with the appropriate internal pull-up/down.

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

SHDN

The shutdown input (SHDN) is a digital input to the ON/OFF controller that causes the device to reset through a global shutdown event. The signal for SHDN typically comes from a temperatures sensor such as the MAX6642 that measures the internal die temperature of the AP. The SHDN polarity is factory-programmable with OTP (OTP_SHDNAL) to be active high or active low with the appropriate internal pull-up/down. A system shutdown based on SHDN is recorded in the non-volatile power-off event recorder.

SMPL, ALARM1, and ALARM2

SMPL, ALARM1, and ALARM2 are signal generated from the RTC and used by the ON/OFF controller. See the <u>RTC</u> section for more information on these signals.

MBATT_OK and MBATTLOW

MBATT_OK and MBATTLOW are digital signals that come from the systems' main-battery monitor. MBATT_OK gates several wakeup sources so that they cannot enable FPS0 and FPS1 until the battery is above the system undervoltage-lockout threshold (V_{MBATTUVLO}). MBATTLOW prevents FPS0 and FPS1 from being enabled when the main-battery is below a programmed minimum voltage.

Resource Power Mode

Table 3. LDO and Step-Down Resource Power Mode

#	REGISTER BIT	INTERNAL SIGNAL	REGISTER BIT	REGISTER BIT	REGISTER BIT		
#	FPSSRC_Lx = 0b11 or FPSSRC_SDx = 0b11	FPS_EN_SDx or FPS_EN_LDO	PWR_MD_SDx[1] or PWR_MD_LDOx[1]	PWR_MD_SDx[0] or PWR_MD_LDOx[0]	GLBL_LPM	ON/ OFF	POWER MODE
1	Y	х	0	0	х	OFF	OFF
2	Y	х	0	1	1	ON	Low power
3	Y	х	0	1	0	ON	Normal
4	Y	х	1	0	х	ON	Low power
5	Y	х	1	1	х	ON	Normal
6	Ν	1	0	0	х	OFF	OFF
7	N	1	0	1	1	ON	Low power
8	Ν	1	0	1	0	ON	Normal
9	Ν	1	1	0	х	ON	Low power
10	Ν	1	1	1	х	ON	Normal
11	Ν	0	х	х	х	OFF	OFF

Table 4. 32k Resource Power Mode

#	REGISTER BIT	REGISTER BIT	REGISTER BIT		
#	PWR_MD_32K[1]	PWR_MD_32K[0]	GLBL_LPM	ON/OFF	POWER MODE

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

1	0	0	x	OFF	OFF		
2	0	1	1	ON	Low-power mode		
3	0	1	0	ON	Low-jitter mode (Normal mode)		
4	1	0	x	ON	Low-power mode		
5	1	1	х	ON	Low-jitter mode (Normal mode)		

Table 4. 32k Resource Power Mode (continued)

Detailed Description—Flexible Power Supply (FPS)

Power-Off Event Recorder

Several events within a MAX77714 based system can autonomously cause a power-off (i.e., global shutdown). The source of the power-down event is recorded in a register so that when the system's microprocessor powers on again it can determine the source of the previous power-off condition. Maxim recommends that as part of the software's initialization code, it checks the POERC register. This power-off event recorder register is non-volatile as long as the RTC's coin cell (BBATT) remains within its valid voltage range. Unlike most interrupt registers, the POERC register does not have a corresponding interrupt mask and status register. Additionally, it does not affect the nIRQ pin. No status register is provided since all POERC events result in a global shutdown which would subsequently reset any related status. Once a bit is set, the controller has to write a 1 to clear it.

Flexible Power Sequencer (FPS)

The FPS allows each regulator to power-up under hardware or software control. Additionally, each regulator can power on independently or among a group of other regulators with an adjustable power-up and power-down delays (sequencing). GPIO0, GPIO1, GPIO2, and GPIO7 can be programmed to be part of a sequence allowing external regulators to be sequenced along with internal regulators. nRST_IO can be programmed to be part of a sequence.

(Figure 10) shows LDO0, LDO1, LDO2, and LDO3 powering up under the control of flexible power sequencer 2.

The time period between each sequencer event for power-up, power-down, sleep entry, and sleep exit can be configured by setting MSTR_PU[2:0], MSTR_PD[2:0], MSTR_SLPENTY[2:0], and MSTR_SLPEXT[2:0] respectively.

The flexible sequencing structure consists of two hardware enable inputs (EN0, EN1), and three master sequencing timers. Each master-sequencing timer is programmable through its configuration register to have a hardware enabled source or a software enabled source (CNFG_GLBLx). When enabled/disabled the master-sequencing timer generates eight sequencing events. The time period between each event is programmable within the configuration register.

Each regulator, GPIO0, GPIO1, GPIO2, GPIO7 and nRST_IO has a flexible-power-sequence slave register (FPS_x) which allows its enable source to be specified as a flexible-power-sequence timer or a software bit. When a FPSSRCx specifies the enable source to be a flexible power sequencer, the power-up and power-down delays are configured by MSTR_PU[2:0] and MSTR_PD[2:0] and can be specified in that regulator's flexible-power-sequencer configuration register.

If any of the FPS hardware inputs (EN0, EN1) are not needed, connect them to ground. Grounding these inputs when they are not needed ensures that they do not accidentally turn on any voltage regulators—furthermore it improves the thermal impedance of the MAX77714 package.

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

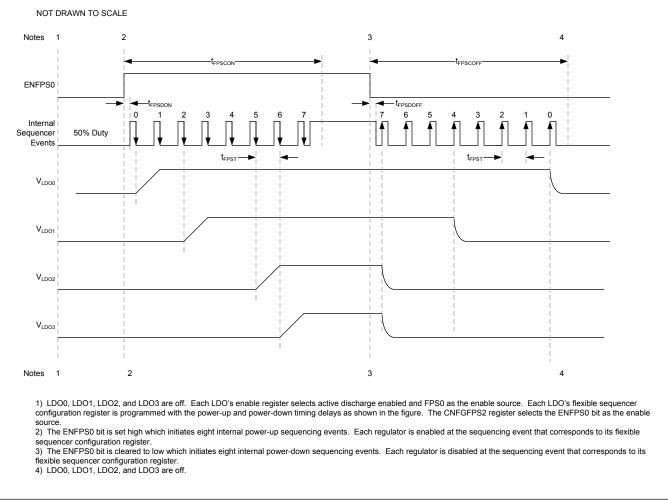


Figure 10. Flexible Power Sequencer

Features

- Two Sequencers
- Power-Up/Down Sequencing Control
- Eight Power-Up Sequence Time Slots
- Eight Power-Down Sequence Time Slots
- Adjustable Time Period Between Time Slots from 31µs to 3,904µs in Eight Binary Weighted Steps
- Sequence Enable/Disable can be Controlled by Hardware and Software
- Capable of Controlling:
 - All Regulators
 - GPIO0, GPIO1, GPIO2, and GPIO7
 - nRST_IO

FPS0

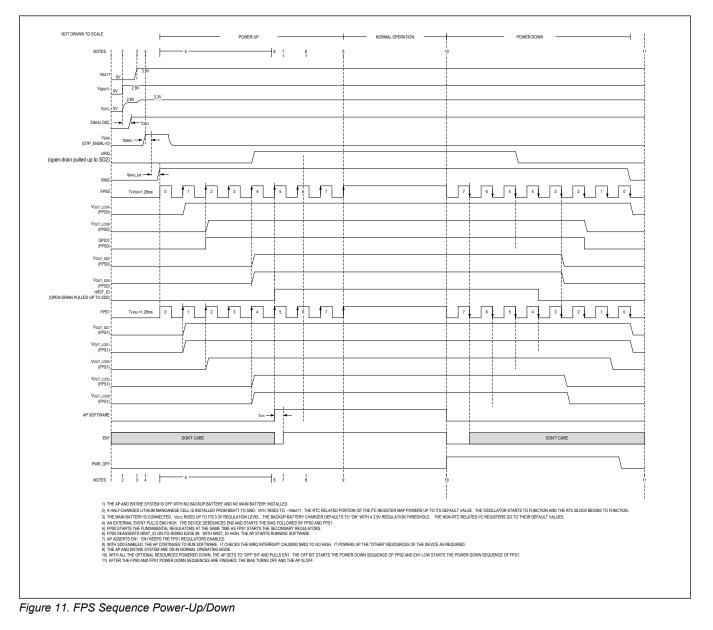
Flexible Power Sequencer 0 is the enable signal for the resources that need to be enabled when the AP is in its normal operating mode and its sleep mode. When the AP is in normal operating mode, both FPS0 and FPS1 are enabled.

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

FPS1

Flexible Power Sequencer 1 is the enable signal for the resources that need to be enabled when the AP is in its normal operating mode **and disabled when the AP is in sleep mode**. When the AP is in normal operating mode, both FPS0 and FPS1 are enabled.

FPS Sequence Power-Up/Down



Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

FPS Sequence Sleep Entry/Exit

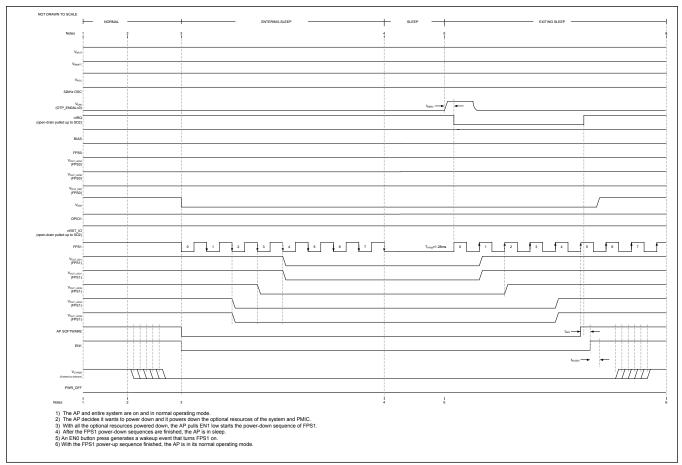


Figure 12. FPS Sleep Entry/Exit

Detailed Description—Step-Down Regulators (SD0–4A Output)

SD0 is a step-down converter with the following features:

- Programmable output voltage from 0.26V to 1.52V in 10mV steps.
- ±2% Initial output accuracy.
- Capable of 4A continuous output current.
- Capable of powering up into a prebiased output.
- Automatic transition from pulse-skipping mode to fixed-frequency mode to provide high efficiency across load range.
- Programmable low-power-mode (LPM) to enable efficient low-power PMIC states.
- Programmable soft-start to minimize inrush current.
- Inductor current limits to limit power output to a short circuit or overload.
- Capable of active discharge.
- Programmable brownout and over-voltage comparators.

Active Discharge

 When the active discharge feature is enabled (SD0ADDIS = 0) and the step-down is disabled (either through I²C or by the sequencer), there is a 100Ω active discharge resistance that is enabled from the output to ground.

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Output Monitoring

SD0 has multiple ways of ensuring the health of its output.

- There is a programmable brownout monitor that sets an interrupt flag (SD0_UV_I) when the output voltage falls below the programmed brownout threshold.
 - If the SD0_UV_M mask bit is unmasked, this allows the brownout on the output of the step-down to initiate a powerdown sequence.
 - When the step-down is first enabled, either through I²C or by the sequencer, the brownout condition is not be asserted until the soft-start is complete. However, if the output capacitance is large enough, the soft-start process completes before the output reaches the rising UV threshold and thereby the UV interrupt would get set, although the output would eventually rise above the UV threshold.
 - However, when the output voltage target is increased through I²C (write to SD0VOUT[6:0]) and the step-down
 converter is in the process of performing the controlled ramp to the new target, a brownout condition is not triggered
 until the controlled ramp is complete.
- There is a programmable overvoltage monitor that sets an interrupt flag (SD0_OV_I) when the output voltage rises above the programmed overvoltage threshold.
 - If the SD0_OV_M mask bit is unmasked, this allows the overvoltage on the output of the step-down to initiate a power-down sequence and assert the nIRQ output.
 - However, when the output voltage target is decreased through I²C (write to SD0VOUT[6:0]) and the step-down converter is in the process of performing the controlled ramp to the new target (if SD0FSREN = 1), an overvoltage condition is not triggered until the controlled ramp is complete. Note that if the controlled ramp for decreasing output voltage target is disabled (SD0FSREN = 0), then the over-voltage condition triggers and causes a power down sequence if unmasked (SD0_OV_M = 0). If this situation is expected, it is recommended to mask it by setting SD0_OV_M to 1.
 - When the step-down is first enabled, either through I²C or by the sequencer, it is possible that the combination of the programmed soft-start ramp rate (SD0SSRAMP) and the output capacitance is such that it can cause the inductor current to reach the PMOS peak current limit.
 - Similarly, when the output voltage target is increased (by a write to SD0VOUT[6:0]) and the slew rate for dynamic voltage scaling is high enough (SD0SSRAMP), it can cause the inductor current to reach the PMOS peak current limit.
- All of the above conditions have associated status bits that provide a real-time status of the condition.

Enable and Power Mode Control

- SD0 can be enabled and disabled either by the flexible power sequencer or by I²C.
- The SD0FPS register configures if it is part of the sequence, and the master and slots numbers that it is assigned to.
- The bits PWR_MD_SD0[1:0] control whether the step-down is in normal-power mode or low-power mode.
- The step-down can be configured to dynamically transition to low-power mode when the PMIC transitions to the DevSlp state.
- The step-down can also be forced to transition to low-power mode through an I²C command. See (<u>Table 3</u>) in the Resource Power Mode section for additional information.

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

PCB Layout Guidelines

Careful circuit board layout is critical to achieve low-switching power losses and clean, stable operation.

When designing the PCB, follow these guidelines:

- 1. Place the inductor and output capacitor close to the device and keep the loop area of switching current small.
- 2. When wiring the high current paths, short and wide traces should be used. For example, the trace between LX and the inductor. The voltage on this node is switching very quickly and additional area creates more radiated emissions.
- 3. The ground loop for the input and output capacitor should be as small as possible.
- 4. AGND should be connected to PGND through a via. Connect DGND and AGND together at the return terminal of the output capacitor. Do not connect them anywhere else.
- 5. Keep the power traces and load connections short and wide. This practice is essential for high-efficiency.
- 6. The feedback pin should be routed away from the switching node to increase noise immunity. This pin is a highimpedance input which is highly noise sensitive.
- 7. When possible, ground planes and traces should be used to help shield the feedback signal and minimize noise and magnetic interference.

Detailed Description—Step-Down Regulators (SD1–3A Output)

SD1 is a step-down converter with the following features:

- Programmable output voltage from 0.26V to 1.52V in 10mV steps.
- ±2% Initial output accuracy.
- Capable of 3A continuous output current.
- Capable of powering up into a prebiased output.
- Automatic transition from pulse-skipping mode to fixed-frequency mode to provide high-efficiency across load range.
- Programmable low-power mode (LPM) to enable efficient low-power PMIC states.
- Programmable soft-start to minimize inrush current.
- Inductor current limits to limit power output to a short circuit or overload.
- Capable of active discharge.
- Programmable brownout and over-voltage comparators.

Active Discharge

• When the active discharge feature is enabled (SD1ADDIS = 0) and the step-down is disabled (either through I²C or by the sequencer), there is a 100 Ω active discharge resistance that is enabled from the output to ground.

Output Monitoring

SD1 has multiple ways of ensuring the health of its output.

- There is a programmable brownout monitor that sets an interrupt flag (SD1_UV_I) when the output voltage falls below the programmed brownout threshold.
 - If the SD1_UV_M mask bit is unmasked, this allows the brownout on the output of the step-down to initiate a powerdown sequence.
 - When the step-down is first enabled, either through I²C or by the sequencer, the brownout condition is not asserted until the soft-start is complete. However, if the output capacitance is large enough, the soft-start process completes before the output reaches the rising UV threshold and thereby the UV interrupt would get set, although the output would eventually rise above the UV threshold.
 - However, when the output voltage target is increased through I²C (write to SD1VOUT[6:0]) and the step-down
 converter is in the process of performing the controlled ramp to the new target, a brownout condition is not triggered
 until the controlled ramp is complete.
- There is a programmable overvoltage monitor that sets an interrupt flag (SD_OV_I) when the output voltage rises above the programmed overvoltage threshold.
 - If the SD1_OV_M mask bit is unmasked, this allows the overvoltage on the output of the step-down to initiate a
 power-down sequence and assert the nIRQ output.
 - However, when the output voltage target is decreased through I²C (write to SDVOUT[6:0]) and the step-down

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

converter is in the process of performing the controlled ramp to the new target (if SD1FSREN = 1), an overvoltage condition is not triggered until the controlled ramp is complete. Note that if the controlled ramp for decreasing output voltage target is disabled (SD1FSREN = 0), then the over-voltage condition triggers and could cause a power-down sequence if unmasked (SD1_OV_M = 0). If this situation is expected, it is recommended to mask it by setting SD1_OV_M to 1.

- When the step-down is first enabled, either through I²C or by the sequencer, it is possible that the combination of the programmed soft-start ramp rate (SD1SSRAMP) and the output capacitance is such that it can cause the inductor current to reach the PMOS peak current limit.
- Similarly, when the output voltage target is increased (by a write to SD1VOUT[6:0]) and the slew rate for dynamic voltage scaling is high enough (SD1SSRAMP), it can cause the inductor current to reach the PMOS peak current limit.
- All of the above conditions have associated status bits that provide a real-time status of the condition.

Enable and Power Mode Control

- SD1 can be enabled and disabled either by the flexible power sequencer or by I²C.
- The SD1FPS register configures if it is part of the sequence, and the master and slots numbers that it is assigned to.
- The bits PWR MD SD1[1:0] control whether the step-down is in normal-power mode or low-power mode.
- The step-down can be configured to dynamically transition to low-power mode when the PMIC transitions to the DevSlp state.
- The step-down can also be forced to transition to low-power mode through an I²C command. See (<u>Table 3</u>) in the Resource Power Mode section for additional information.

Detailed Description—Step-Down Regulators (SD2/3–2A Output)

SD2 and SD3 are step-down converters with the following features:

- Programmable output voltage from 0.600V to 2.194V in 6.25mV steps for SD2.
- Programmable output voltage from 0.600V to 3.78V in 12.5mV steps for SD3.
- ±2% Initial output accuracy.
- Capable of 2A continuous output current.
- Capable of powering up into a prebiased output.
- Automatic transition from pulse-skipping mode to fixed-frequency mode to provide high-efficiency across load range.
- Programmable low-power mode (LPM) to enable efficient low-power PMIC states.
- Soft-start to minimize inrush current.
- Inductor current limits to limit power output to a short circuit or overload.
- Programmable brownout and over-voltage comparators.

Output Monitoring

SD2 and SD3 have multiple ways of ensuring the health of their output.

- There is a programmable brownout monitor that sets an interrupt flag (SD2_UV_I/SD3_UV_I) when the output voltage falls below the programmed brownout threshold.
 - If the SD2_UV_M/SD_UV_M mask bit is unmasked, this allows the brownout on the output of the stepdown to initiate a power-down sequence.
 - When the step-down is first enabled, either through I²C or by the sequencer, the step-down's control circuit attempts to ramp the output voltage as fast as possible to the target output (programmed by SDVOUT[7:0]/SD3VOUT[7:0]) limited only by the PMOS peak current limit. During this process of output voltage ramp, the brownout output is prevented from being triggered until the end of the soft-start period (determined by the specified ramp-up slew rate). However, if the output capacitance is large enough, the soft-start process completes before the output reaches the rising UV threshold and thereby the UV interrupt would get set, although the output would eventually rise above the UV threshold.
 - When the output voltage for SD2 or SD3 is increased through I²C (programmed by SD2VOUT[7:0]/SD3VOUT[7:0]) after they have been enabled, the step-down control circuit changes the

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

output voltage target directly to the final value. In such a case, the brownout comparator provides an undervoltage assertion. If the undervoltage assertion is not masked by SD2_UV_M/SD3_UV_M, a powerdown sequence occurs. If such a use case is foreseen, it is recommended to set the mask bits first and then change the output voltage. Alternatively, the change in output voltage should be done in small steps. Note that even if the mask bit is set, the corresponding interrupt bit is still set.

- Note that a load transient on the output of the step-down at a fast slew rate and a large magnitude has the capability to cause an output voltage droop that can cause the UV comparator to trip and flag an under-voltage event, if the brownout threshold is set high (such as 90%).
- There is a programmable overvoltage monitor that sets an interrupt flag (SD2_OV_I/SD3_OV_I) when the output voltage rises above the programmed overvoltage threshold.
 - If the SD2_OV_M/SD3_OV_M mask bit is unmasked, this allows the overvoltage on the output of the stepdown to initiate a power-down sequence.
 - When the step-down is first enabled, either through I²C or by the sequencer, the step-down control circuit attempts to ramp the output voltage as fast as possible to the target output (programmed by SD2VOUT[7:0]/SD3VOUT[7:0]) limited only by the PMOS peak current limit. During this process of output voltage ramp, the over-voltage output is prevented from being triggered until the end of the soft-start period (determined by the specified ramp-up slew rate).
 - When the output voltage for SD2 or SD3 is increased through I²C (programmed by SD2VOUT[7:0]/SD3VOUT[7:0]) after they have been enabled, the step-down's control circuit changes the output voltage target directly to the final value. The step-down output voltage increases as a function of the output capacitance and load. In such a case, the over-voltage comparator provides an over-voltage assertion. If the overvoltage assertion is not masked by SD1_OV_M/SD1_OV_M, a power-down sequence occurs. If such a use case is foreseen, it is recommended to set the mask bits first and then change the output voltage. Alternatively, the change in output voltage should be done in small steps. Note that even if the mask bit is set, the corresponding interrupt bit is still set.
 - Note that a sudden load release with a high slew rate and magnitude has the potential to cause a momentary over-shoot on the output of the step-down that can trip the OV comparator output. If such use cases are expected, the OV threshold should be set as high as allowed.
- All of the above conditions have associated status bits that provide a real-time status of the condition.

Enable and Power Mode Control

- SD2/3 can be enabled and disabled either by the flexible power sequencer or by I²C.
- The SD2FPS/SD3FPS registers configure if it they are part of the sequence, and the master and slots numbers that they are assigned to.
- The bits PWR_MD_SD2[1:0]/PWR_MD_SD3[1:0] control whether the step-down is in normal-power mode or lowpower mode.
 - The step-down can be configured to dynamically transition to low-power mode when the PMIC transitions to the DevSlp state.
 - The step-down can also be forced to transition to low-power mode through an I²C command. See (<u>Table</u>
 <u>3</u>) in the *Resource Power Mode* section for additional information.

Active Discharge Resistor

SD2/3 have an active-discharge resistance that can be enabled and disabled with SDxADDIS. Enabling the active discharge feature helps ensure a complete and timely power-down of all system peripherals. The default condition of the active-discharge resistor feature is enabled, such that when the step-down converter is disabled, an internal 100Ω discharge resistor is connected to the output to discharge the energy stored in the output capacitor. When the step-down converter is enabled, the discharge resistor is disconnected from the output.

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Soft-Start

The SD2/3 regulators have a soft-start feature to limit the inrush current during startup. The soft-start feature is achieved by limiting the slew rate of the output voltage during startup (dV_{OUT} SDx/dt).

During soft-start the output voltage for the regulator ramps at a fixed rate of $17mV/\mu s$ to its final value. The soft-start time(μs) is calculated by $V_{OUT SDx}/17mV$.

If $V_{OUT SDx}$ = 1.8V, the startup time is 105µs.

Register and Reset Conditions

See the *PMIC Register* section for additional information.

Detailed Description—150mA PMOS LDO (LDO2, LDO4, LDO5, LDO6)

The MAX77714 has nine linear regulators (LDOs).

The four NMOS regulators are capless designs that are stable with or without an output decoupling capacitor. Additionally, the PMOS regulators have adjustable compensation that allows for the use of remote output capacitors.

All regulators can be operated in low-power mode, where the no-load quiescent current drops to 1.5mA. In low-power mode, each output supports a maximum load of 5mA.

All regulators have an output voltage power-OK interrupt signal that is integrated into the MAX77714 interrupt architecture.

Features and Benefits

- Nine Linear Regulators
 - General Performance
 - ±3% Output Accuracy LDOx and ±4.5% for LDO4 (0.4V) Over Load/Line/Temperature
 - 50mV Dropout at Full Load
 - 63dB PSRR at 10kHz
 - 1.5mA Low-Power Mode
 - · Short-Circuit and Thermal-Overload Protection
 - · Dynamically Programmable Output Voltage
 - Power-OK Interrupt
 - Programmable Soft-Start Rate: 100mV/µs or 5mV/µs
 - · Soft-Start into Prebiased Output
 - Four N-Channel Regulators (LDO0/1/7/8)
 - 0.8V to 5.5V Input Range
 - 29mA Quiescent Supply Current
 - No Output Capacitor Required in Normal Operating Mode (cap required for low-power mode)
 - Five Standard P-Channel Regulators (LDO2/3/4/5/6)
 - 1.7V to 5.5V Input Range
 - 20mA Quiescent Supply Current
 - Remote Capacitor Design with Register Adjustable Compensation to Optimize Transient Performance

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Simplified Block Diagram

The nine LDOs of the MAX77714 are derived of five basic topologies as shown in (Table 5).

The PMOS regulators (PDRVx) operate and draw power from their power inputs (IN_LDOxx), which have a minimum operating supply voltage of 1.7V (V_{IN_LDOx}). The control registers and some input circuitry operate from the main system supply (MBATT) and hold their contents when the regulator input voltage (V_{IN_LDOx}) drops to 0V.

The NMOS regulators (NDRVx) gate drive operates from the main system supply (MBATT), while the load current is provided by the regulator input (IN_LDOxx). The input voltage (V_{IN_LDOx}) for the NMOS regulators extends down to 0.8V. To provide adequate gate drive for the NMOS output device, the NMOS output voltage should be more than 1.5V lower than the main system supply voltage (V_{MBATT}). The control registers are also powered from MBATT.

NMOS regulators works into dropout with the V_{IN_LDOx} to V_{OUT_LDOx} voltage determined by $I_{LOAD} \times R_{DO}$ where R_{DO} is the dropout resistance (typically 200mW). As dropout voltage decreases (by reducing load) below 0.3V, the PSRR and load regulation degrades.

All PMOS regulators are compensated at their output and require a remote output capacitance large enough to prevent oscillation. The NMOS regulators are internally compensated, but an additional output capacitor can be added to improve immunity to high-frequency noise and allow stable low-power mode operation. See the <u>Output Capacitor Selection</u> section for additional information.

NAME	DESCRIPTION	LDO
PDRV1	Power Device: PMOS Output Current: 150mA	LDO2, LDO4, LDO5, LDO6
PDRV2	Power Device: PMOS Output Current: 300mA	LDO3
NDRV1	Power Device: NMOS Output Current: 150mA	LDO0, LDO1
NDRV2	Power Device: NMOS Output Current: 300mA	LDO8
NDRV3	Power Device: NMOS Output Current: 450mA	LD07

Table 5. Basic LDO Topologies

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

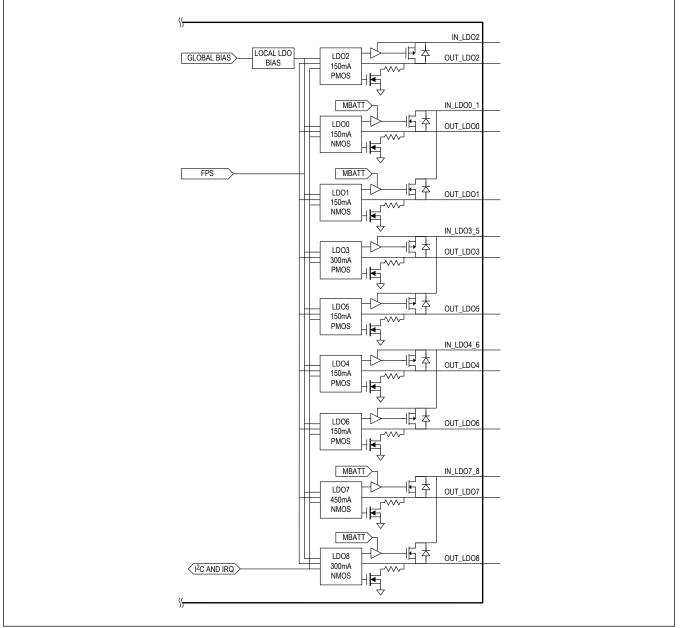


Figure 13. Linear Regulator Functional Diagram

Active-Discharge Resistor

Each linear regulator has an active-discharge resistor feature that can be enabled/disabled with ADE_Lx_. Enabling the active discharge feature helps ensure a complete and timely power-down of all system peripherals. The default condition of the active-discharge resistor feature is enabled so that whenever V_{MBATT} is below $V_{MBATTUVLO}$ all regulators are disabled with their active-discharge resistors turned on. When V_{MBATT} is less than 1.0V, the NMOS transistors that control the active-discharge resistors lose their gate drive and become open.

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Input Capacitor Selection

Sufficient input bypass capacitance is required for stable operation of the LDO. Choose an effective input bypass capacitance (C_{IN_LDO}) of at least 1µF after derating. A 2.2µF ceramic capacitor is sufficient for most use cases. Larger values of C_{IN_LDO} improve the decoupling for the LDO regulator.

 C_{IN_LDO} reduces the current peaks drawn from the battery or input power source during LDO regulator operation. The impedance of the input capacitor should be very low (i.e., $\leq 5m\Omega + \leq 500$ pH) for frequencies up to 2MHz. Ceramic capacitors with X5R or X7R dielectric are highly recommended due to their small size, low ESR, and small temperature coefficients.

As the case sizes of ceramic surface-mount capacitors decrease, their capacitance verses DC bias voltage characteristic becomes poor. Due to this characteristic, it is possible for 0603 case size capacitors to perform well while 0402 case size capacitors of the same value perform poorly. Consider the input capacitance value after initial tolerance, bias voltage, aging, and temperature derating. Maxim recommends a nominal capacitance value of 1μ F which, in 0402 case size, can derate to 0.4μ F.

Output Capacitor Selection

Choose the output bypass capacitance (C_{OUT_LDO}) to be 2.2µF. Larger values of C_{OUT_LDO} improve PSRR and load transient performance but increases the input surge currents during soft-start and output voltage changes.

 $C_{OUT\ LDO}$ is required to keep the LDO stable. The impedance of the output capacitor should be very low (i.e., $\leq 5m\Omega + \leq 500$ pH) for frequencies up to 2MHz. Ceramic capacitors with X5R or X7R dielectric are highly recommended due to their small size, low ESR, and small temperature coefficients.

As the case sizes of ceramic surface-mount capacitors decrease, their capacitance verses DC bias voltage characteristic becomes poor. Due to this characteristic, it is possible for 0603 case size capacitors to perform well while 0402 case size capacitors of the same value perform poorly. Consider the output capacitance value after initial tolerance, bias voltage, aging, and temperature derating. Maxim recommends a nominal capacitance value of 2.2μ F which, in 0402 case size, can derate to 1.1μ F.

P-Channel Linear Regulator Output Capacitor

P-channel LDOs require an output capacitor to maintain stable output voltage regulation. Adjustable compensation allows for flexibility when designing the PCB and placing the output capacitor. The default compensation is factory programmable; additionally, the compensation is register adjustable when the LDO is off.

In many LDO designs, there is little-to-no flexibility in the physical placement of the output capacitor on the PCB. However, the LDO implementation within the device provides adjustable compensation for the p-channel LDOs. This adjustable compensation allows flexibility in the placement of the output capacitor on the PCB. However, as the output capacitor is placed farther from the device, slower compensation values are required to maintain stability; these slower compensation values decrease performance.

For optimum p-channel LDO performance, place the output capacitor as close to the LDO output as possible and program COMP_Lx = 0b00. In situations were the full LDO performance is not required, the output capacitor can be place farther away from the LDO output with slower compensation values. This option becomes especially useful when the LDO output capacitor can be eliminated and the load's local input capacitor becomes the only capacitance on the LDO output node.

Warning: The COMP_Lx bits should only be changed when the LDO is disabled. If the compensation bits are changed when the LDO is enabled, the output voltage glitches as the compensation changes.

N-Channel Linear Regulator Output Capacitor

N-channel LDOs technically do not require and output capacitor to maintain stable output voltage regulation if they are in normal mode (i.e., they can be capless). However, a n-channel LDO does require an output capacitor to maintain stable output voltage regulation in low-power mode. In either mode (normal or low-power), the LDO performs best with an output capacitor (C_{OUTx}) as recommended in the <u>Output Capacitor Selection</u> section of the datasheet.

Note that the COMP_Lx[1:0] bits for n-channel LDOs must be set to 0b00.

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Bias

A small section of bias circuitry is required to be on when any of the LDOs are enabled. LDO enable signal from the FPS OR the L_B_EN from I²C enables the LDO bias circuits. In addition, whenever the LDO bias is enabled, the global bias for the MAX77714 is also enabled. The LDO bias circuitry takes t_{LBIAS} to turn on. If the LDO bias circuit is off and an LDO is enabled, the total time before the output starts slewing up is $t_{LBIAS} + t_{LON}$. If the LDO bias is on and an LDO is enabled, the total time before the output starts slewing is t_{LON} .

If the sequencing of a group of regulators is particularly important, it may be desirable to force the LDO bias to be on with the L_B_EN bit to ensure that the LDOs enables in a consistent manner with the shortest latency. Note that whenever L_B_EN is set, the global bias circuits and LDO bias circuits are enabled. The combined bias circuitry current is I_{QBIAS} . To ensure that the system always operates with the lowest quiescent current possible, it is a good idea to clear L_B_EN when it is not needed.

LDO Power Modes

Linear regulators and step-down regulators have very similar power mode controls. Each linear regulator is independently controlled with PWR_MD_Lx[1:0] and each step-down regulator is independently controlled with PWR_MD_SDx[1:0]. In addition to enable and disable control, each linear regulator has a special low-power mode that reduced the quiescent current to 1.5μ A. In low-power mode, each regulator supports a load of up to 5mA (I_MAXxx). The load regulation performance degrades proportionally with the reduced load current.

Several usage options are available for low-power mode. To force individual regulators to low-power mode, set PWR_MD_Lx to 0b10. To force a group of regulators to enter and exit low-power mode in unison, set their individual PWR_MD_Lx_bits to 0b10. When set for this "group and/or dynamic" low-power mode, the low-power mode is enabled when the global low-power mode signal is high. The global low-power mode signal is driven by the GLBL_LPM bit or though a GPIO0.

When a linear regulator is configured to be part of a flexible power sequence (FPSSRC_Lx), the power mode bits (PWR_MD_Lx) are still used to configure low-power mode and normal-power mode, but the flexible power sequencer itself controls weather the regulator is enabled or disabled.

Soft-Start and Dynamic Voltage Scaling (DVS)

The linear regulators have a programmable soft-start rate. When a linear regulator is enabled, the output voltage ramps to its final voltage at a slew rate of either 5mV/ms or 100mV/ms, depending on the state of the SS_Lx bit. The 5mV/ms ramp rate limits the input inrush current to around 10mA on a 300mA regulator with a 2.2µF output capacitor and no load. The 100mV/ms ramp rate results in a 200mA inrush current on a 300mA regulator with a 2.2µF output capacitor and no load, but achieves regulation within 50ms. The soft-start ramp rate is also the rate of change at the output when changing dynamically between two output voltages while enabled (DVS). This includes both positive and negative output voltage transitions.

The LDO soft-start circuitry supports starting into a prebiased output. For example, if the output capacitor has an initial voltage of 0.4V when the regulator is enabled, the regulator gracefully increases the capacitor voltage to the required target voltage such as 1.2V. This is unlike other regulators without the start into prebias feature where they can force the output capacitor voltage to 0V before the soft-start ramp begins.

During a soft-start event or a DVS transition, the regulators output current increases by $C_{OUT} \times dV/dt$. In the event that the load current plus the additional current imposed by the soft-start or DVS transition, reach the regulator's current limit, the current limit is enforced. When the current limit is enforced, the advertised transition rate (dV/dt) does not occur.

Power-OK (POK) Comparators for Linear Regulators

Each linear regulator includes a POK comparator. The POK comparator signals (POK_Lx) indicate when each output has lost regulation (i.e., the output voltage is below V_{POKTHL}). The POK signal has a 25µs noise immunity filter (t_{POKNFLDO}).

When any of the POK signals (POK_Lx) go low, a maskable interrupt is generated. POK is the only interrupt available for the device's LDOs. The block level LDO interrupt register is IRQ_LVL2_Lx and the top level LDO interrupt is IRQ_LDO.

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Overvoltage Clamp

Each LDO has an overvoltage clamp that allows it to sink current when the output voltage is above its target voltage. This overvoltage clamp for a given LDO is disabled when that LDO is in low-power mode. If an LDO is in normal-power mode, then the overvoltage clamp is enabled/disabled with OVCLMP_EN_Lx (default enabled). The following bulleted list briefly describes three typical application scenarios that pertain to the overvoltage clamp.

Warning: If an LDO's overvoltage clamp is disabled (OVCLMP_EN_Lx = 0), the output loading is very low (<10 μ A), and the junction temperature of the device is hot (>70°C) the output voltage may rise above its regulation point.

Typical application scenarios for the overvoltage clamp:

- LDOs Load Leaking Current into the LDOs Output. Some LDO loads leak current into an LDO output during certain operating modes. This is typically seen with microprocessor loads. For example, a microprocessor with 3.3V, 2.5V, 1.8V, and 1.0V supply rails is running in standby mode. In this mode the higher voltage rails can leak currents of several milliamps into the lower voltage rails. If the 1.0V rail is supplied by an LDO, the LDO output voltage rises based on the amount of leakage current. With the LDO overvoltage clamp enabled, when the output voltage rises above its target regulation voltage, the overvoltage clamp sinks current from the output capacitor, which brings the output voltage back within regulation.
- Negative Load Transient to 0A: When the LDO load current quickly ramps to 0A (i.e., 300mA to 0A load transient with 1µs transition time), the output voltage can overshoot (i.e., sore). Since the LDO cannot turn off its pass device with an intently fast load transition, the LDO output voltage overshoots. In this instance, when the output voltage sores above target regulation voltage, the overvoltage clamp sinks current from the output capacitor, which brings the output voltage back within regulation.
- Negative Dynamic Voltage Transition: When the LDO output target voltage is decreased (i.e., 1.2V to 0.8V) when the system loading is light, the energy in the output capacitor tends to hold the output voltage up. When the output voltage is above its target regulation voltage, the overvoltage clamp sinks current from the output capacitor, which brings the output voltage back within regulation.

Nontypical Applications:

There are some nontypical applications for this overvoltage clamp that are not discussed.

- Two LDO outputs can be connected together to give one output with more current capability. In this case, you typically
 want one LDOs output voltage to be set 1LSB higher than the other LDO. The LDO with the lower output voltage
 should deactivate its overvoltage clamp.
- Similar to the above, a step-down and LDO output can be connected together to give more current. In this case, the
 LDO output should be set lower than the step-down so that the step-down delivers the bulk of the load current (i.e.,
 step-down is more efficient). The LDO would only become active during transient conditions or high load condiditons.
 In this case, the LDO overvoltage clamp should be disabled.

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Detailed Description—GPIO

GPIO

The MAX77714 has eight GPIO channels. It can be configure as GPO, GPI, and also has an ALT mode.

When configured as a general purpose output (GPO), the GPO is programmable to be push-pull or open-drain. When a GPIO is configured as a general purpose output, do not enable the internal pull-up or internal pull-down resistors which corresponds with that GPO.

When configured as a general pupose input (GPI), the GPI is programmable to have either a high-impedance, $100k\Omega$ pulldown, or $100k\Omega$ pullup. Additionally, interrupt inputs with programmable debounce timers are available.

The GPI edge(s) that triggers interrupts are selectable with REFE_IRQx. When a GPI interrupt is enabled and the selected edge(s) are detected, EDGEx is set in the INT_LVL2_GPIO register and IRQ_GPIO is set in the top-level interrupt register. If the top-level interrupt mask is cleared (IRQ_GPIOM), the external interrupt signal nIRQ is asserted.

Alternate Mode

In addition to the GPO and GPI configurations, each GPIO has an alternate mode.

When a GPIO is in an alternate mode device may internally force the direction (i.e., output or input) and/or logic level of the GPIO. However, other options such as debounce times and rising/falling edge triggered interrupt settings are still valid in alternate mode.

Table 6. GPIO Alternate Modes

GPIOx	ALTERNATE MODES
GPIO0	Active-High, Open-Drain, Flexible Power Sequencer Output
GPIO1	Active-High, Open-Drain, Flexible Power Sequencer Output
GPIO2	Active-High, Open-Drain, Flexible Power Sequencer Output
GPIO3	ACOK input
GPIO4	32kHz Output (32K_OUT0)
GPIO5	32kHz Output (32K_OUT1)
GPIO6	32kHz Output (32K_OUT2)
GPIO7	Active-High, Open-Drain, Flexible Power Sequencer Output

Features and Benefits

- Eight GPIO
- MBATT and GPIO_INB Input Power Sources
- Four GPIOs per input
- Input Voltage Range from 1.7V to 5.5V
- GPI
 - · GPI to ACOK
 - GPI
 - Flexible Edge Trigger Support
 - Selectable Debounce Time
 - Optional pullup/pulldown
- GPO
 - Push-Pull
 - Open-Drain
 - Four GPO programmable to Flexible Power Sequencer
 - Three GPO to 32kHz Output Option
 - 12mA Sink Current Allows for LED Drive

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

GPIO Programming Matrix

Table 7. GPIO Programming Matrix

GPIOx GPI									
Comment	DBNCx[1:0]	REFE_IRQx[1:0]	DOx	DIx	DIRx	PPDRVx	PUEx	PDEx	AMEx
GPI	Debounce Times	Interrupt Options	0	Input Logic Level	1 = GPI	0	0	0	0
GPI with Internal Pullup	Debounce Times	Interrupt Options	0	Input Logic Level	1 = GPI	0	1	0	0
GPI with Internal Pulldown	Debounce Times	Interrupt Options	1	Input Logic Level	1 = GPI	0	0	1	0
GPIOx GPO									
GPO Push-Pull	0	0	Output Logic Level	0	0 = GPO	1 = push- pull	0	0	0
GPO Open-Drain	0	0	Output Logic Level	0	0 = GPO	0 = open- drain	0	0	0
GPIO0/1/2/7 Alternative Mode	Active-High I	Flexible Power Sec	quencer Out	put					
Comment	DBNCx[1:0]	REFE_IRQx[1:0]	DOx	DIx	DIRx	PPDRVx	PUEx	PDEx	AMEx
GPO Flexible Power Sequencer Output, Push-Pull	0	0	set by FPS	0	0	1 = push- pull	0	0	1
GPO Flexible Power Sequencer Output, Open- Drain	0	0	set by FPS	0	0	0 = open- drain	0	0	1
GPIO4/5/6 Alternative Mode 3	2kHz Output (32K_OUT1)							
Comment	DBNCx[1:0]	REFE_IRQx[1:0]	DOx	DIx	DIRx	PPDRVx	PUEx	PDEx	AMEx
GPO 32kHz Output, Push-Pull	0	0	set by XIN	0	0	1 = push- pull	0	0	1
GPO 32kHz Output, Open- Drain	0	0	set by XIN	0	0	0 = open- drain	0	0	1
GPIO3 Alternative Mode ACO	K (Level Trigg	gered)							
Comment	DBNC3[1:0]	REFE_IRQx[1:0]	DO3	DI3	DIR3	PPDRV3	PUE3	PDE3	AME3
GPI	Debounce Times	Interrupt Options	0	Input Logic Level	1 = GPI	0	0	0	1
GPI with Internal Pullup	Debounce Times	Interrupt Options	0	Input Logic Level	1 = GPI	0	1	0	1
GPI with Internal Pulldown	Debounce Times	Interrupt Options	1	Input Logic Level	1 = GPI	0	0	1	1

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Detailed Description—32kHz Oscillator

The MAX77714 provides a 32kHz clock signal for the real-time clock and the central state machine. The 32kHz clock signal is derived from either an external 32kHz crystal or an external 32kHz clock source.

Features: 32kHz Oscillator

- Low-jitter mode reduces cycle-to-cycle jitter to 15ns
- · Low-power mode lowers power consumption
- Dedicated clock output, additional outputs selectable as GPIO alternate modes
- · Allows use of board-mounted crystal ballast capacitors or on-chip crystal ballast capacitors
- Internal ballast capacitor options support 6.5pF, 7.5pF, and 12.5pF crystals
- · Bypass mode supports external clock input
- · Backup silicon oscillator allows continued functionality if crystal fails

Operation Modes

The MAX77714 32kHz oscillator supports two hardware configurations, selectable by an OTP option. In normal mode, the oscillator drives an external crystal to derive a 32kHz clock signal. In bypass mode, the oscillator accepts a 32kHz square wave from an external clock source. CRYSTAL_CONFIG indicates the active operation mode.

In bypass mode, the oscillator buffers and passes through the input clock. The frequency detector detects abnormally low or high frequencies (below fDET_MIN and above fDET_MAX), but does not consider duty cycle or jitter.

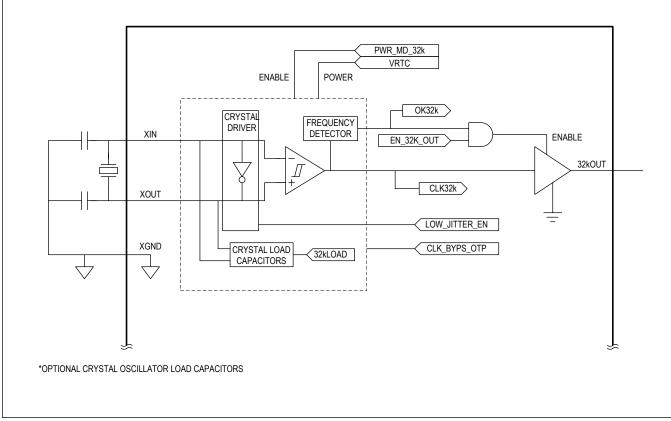


Figure 14. Block Diagram—32kHz Normal-Mode Operation

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Low-Jitter Mode and Low-Power Mode

The crystal driver features two modes of operation: low-power mode and low-jitter mode. In low-jitter mode, the crystal driver current consumption is 24μ A which allows for 15ns cycle-to-cycle jitter (tJIT_LPM) and duty cycle to between 45% and 55%. In low-power mode, the crystal driver current consumption is low (IOSC_LPM, 1.5 μ A) which corresponds to an increased cycle-to-cycle jitter and wider duty cycle (40% to 60%).

Power mode control is independently managed by the ON/OFF Controller based on the system state (ACTIVE, HIBERNATE, and STANDBY). When a system state transition occurs, the crystal driver automatically changes power mode as configured with 32K_LJ_x.

Internal Ballast Capacitors

The crystal driver has four options for internal ballast capacitance, selectable with an OTP option (32KLOAD_OTP). (<u>Table 8</u>) shows the total crystal load capacitance (internal and external) for common configurations. XIN and XOUT typically have 3pf of parasitic capacitance each (C_{PAR}) which factors in the total load capacitance calculation. For any internal and external load capacitance configuration, C_{LOAD} can be calculated using the formula $C_{LOAD} = (C_{INT} + C_{EXT} + C_{PAR}) / 2$.

For prototyping purposes, the internal load capacitance can be changed using test register access. Changing the internal load capacitance while the system is in operation is not recommended.

32KLOAD	PARASITIC CAPACITANCE FROM XIN TO GND and XOUT TO GND (C _{PAR})	INTERNAL LOAD CAPACITANCE FROM XIN TO GND AND XOUT TO GND (C _{INT})	EXTERNAL LOAD CAPACITANCE FROM XIN TO GND AND XOUT TO GND (C _{EXT})	TOTAL LOAD CAPACITANCE ON THE CRYSTAL (C _{LOAD})
0b00	3pF	None	10pF	6.5pF
0b00	3pF	None	12pF	7.5pF
0b00	3pF	None	22pF	12.5pF
0b01	3pF	10pF	None	6.5pF
0b10	3pF	12pF	None	7.5pF
0b11	3pF	22pF	None	12.5pF

Table 8. 32kHz Crystal Oscillator Load Capacitance

Buffered Output

The oscillator clocks a dedicated 32kHz buffered output (32KOUT) which provides a low-jitter 32kHz clock source to the system. The buffer is configurable to be either a push-pull, or open-drain output stage. The supply for the push-pull output stage is configurable to be one of three voltage rails: LDO12, BUCK3 or LSW1 (V32KOUT). For the buffered output to meet the low-jitter spec (t-JIT_LPM), the following conditions must be satisfied:

- The primary oscillator must generate the 32kHz clock (32KSOURCE = 0).
- If a crystal is used (normal mode), the oscillator must be configured for low-jitter operation.
- If an external clock is used (bypass mode), the external clock must meet the low-jitter spec.
- The buffer must be configured for the push-pull output stage.

Additional 32kHz outputs are available from GPIO alternative modes; see the GPIO section for more information.

The FBB3 and LSW1 supply inputs to the buffer can be unpowered when their respective inputs are disabled. In such cases, the unpowered inputs are not backpowered from the powered inputs. Before enabling the buffer (EN32KOUT = 1), the selected supply must have reached its programmed output voltage; otherwise, runt pulses may appear at 32KOUT.

Silicon Oscillator

The MAX77714 includes a silicon oscillator which permits continued system operation in the event that the crystal oscillator fails. The silicon oscillator has reduced accuracy and higher jitter than a crystal oscillator and is not suitable for timekeeping or applications requiring low jitter; however, it offers greater reliability than the crystal oscillator and is sufficiently accurate for continued operation of device's core functionality.

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

During normal operation, the device derives its 32kHz clock from the crystal oscillator or internal silicon oscillator depending on the oscillator OTP selection. There are two conditions that cause it to use the silicon oscillator instead: if the crystal oscillator fails to start up in a timely manner, or if it fails during operation. The latter case results in an asynchronous reset of all registers in the device. In both cases, the device generates an interrupt (XTAL_FAIL_I) to notify the AP that a crystal fault caused the device to start up and operate using the silicon oscillator.

Once the system is operating with the silicon oscillator, software can periodically check XOSCOK to see if the crystal has restabilized. If software determines that the crystal is stable enough to use, it can set XOSC_RETRY to initiate a glitchless transition back to the crystal oscillator. If the crystal oscillator is not OK (XOSCOK = 0), the transition does not occur.

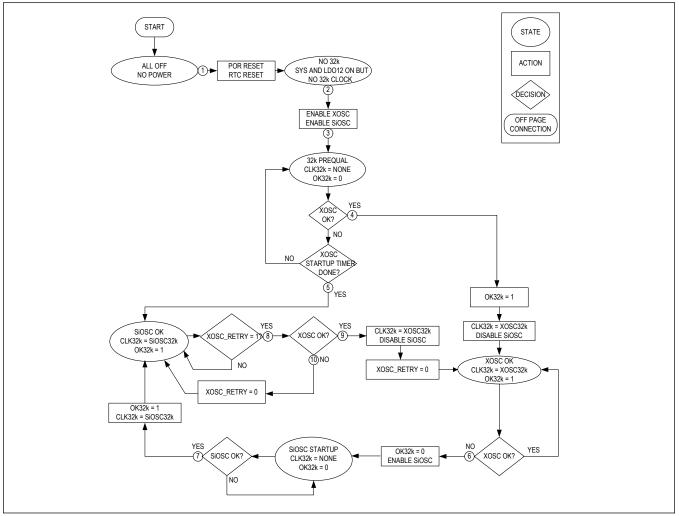


Figure 15. Flow Chart-Silicon Oscillator

Detailed Description—Backup Battery Charger

The backup battery charger is a constant voltage (CV) and constant current (CC) style charger with a series output resistance. The backup battery charger is enabled and disabled with BBCEN. The charge current, charger voltage, output current, and output resistance are adjustable with the CNFG_BBC register. The backup battery charger is suitable for the following types of backup cells:

• Super capacitor (a.k.a., gold cap, double-layer electrolytic)

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

- Standard capacitors (tantalum, electrolytic, ceramic)
- Rechargeable lithium manganese cells

Features

- 800µA maximum CC-CV backup battery charger.
- 2.5V to 3.5V adjustable backup battery setting with ± 3% tolerance.
- Seamless transition of RTC supply from V_{MBATT} to V_{BBATT} when V_{MBATT} drops below V_{MBATT} UVLO threshold.

Detailed Description—Real-Time Clock (RTC)

The real-time clock (RTC) is responsible for keeping track of the time. It records seconds, minutes, hours, days, months, and years with a calendar structure that accounts for leap years. The RTC is further equipped with two alarms and has a host of maskable capabilities.

Through a set of configuration registers, various modes of operation are possible. RTC supports both "Binary", and "Binary Coded Decimal", and supports features such as AM/PM, and 24/12 modes of operation. Additional sudden momentary power loss (SMPL) is available.

Features

- Gregorian Calendar with Leap Year Correction
- Two Alarms
- Maskable Interrupts
 - 1s and 60s
 - Alarm 1 & 2
 - SMPL
- Binary and BCD Modes
- 12/24 Hour Modes
- Sudden Momentary Power Loss (SMPL)
- Double Buffered Read/Write Registers Allows Asynchronous Register Access
- Operates down to 1.71V

Writing to RTC

In order to safely write to various registers on-board the RTC, all RTC registers (except RTCINT register, bit 0 of UPDATE0 register, and bit 4 of UPDATE0 register) have a corresponding "Write Buffer". When the user writes to the RTC, the user is actually performing a write to these "Write Buffers". Therefore, in writing to RTC there are two steps needed to update a particular register or set of registers:

- 1. User writes desired value(s) to the register(s) located between 0x01 and 0x24. Behind the scene, only the "Write Buffers" are updated with these new values.
- 2. The user then writes a 1 to UDR bit 0 of the "UPDATE0 Register" at address 0x04 to transfer the modified "Write Buffers" to the corresponding time registers.

The logic subsequently would perform a transfer of data from Write Buffers to the actual registers and then clears the "UDR" bit automatically as well as clearing the Write Buffers (marking them as not modified).

Under the hood, the logic first does a double synchronization of the UDR bit to the 32.768kHz clock before using it as an enable bit to transfer from Write buffers to the actual registers thus allowing a safe update of these two unsynchronized clock events.

Example 1. Pseudo code for setting clock to Saturday, Jan 01, 2011, 1:00:00 PM

Set RTCCNTL to 0x01 //12hr mode, BCD mode

Set RTCUPDATE0 to 0x01 //transfer RTCCNTL modification to RTC

Set RTCSEC to 0x00 //0 second

Set RTCMIN to 0x00 //0 minute

Set RTCHOUR to 0x41 //1 PM

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Set RTCDOW to 0x40	//Saturday
Set RTCMONTH to 0x01	//January
Set RTCYEAR to 0x11	//11
Set RTCDOM to 0x01	//First
Set RTCUPDATE0 to 0x01	//transfer write buffers to counters
Wait 16 ms for write to com	plete
Set RTCSEC to 0x	//new write
Example 2. Pseudo code	for setting ALARM1 to every Wednesday at 7:30:00 AM:
Set RTCCNTL to 0x01	//12hr mode, BCD mode
Set RTCUPDATE0 to 0x01	//transfer RTCCNTL modification to RTC
Set RTCSECA1 to 0x80	//0 sec, enabled
Set RTCMINA1 to 0xB0	//30 minute, enabled
Set RTCHOURA1 to 0x87	//7 AM, enabled
Set RTCDOWA1 to 0x08	//Wednesday, enabled
Set RTCMONTHA1 to 0x00) //Disabled
Set RTCYEARA1 to 0x00	//Disabled
Set RTCDOMA1 to 0x00	//Disabled
Set RTCUPDATE0 to 0x01	//transfer write buffers to counters
Wait 16ms for write to com	plete
Set RTCSEC to 0x	//new write

Reading from RTC

Corresponding to most timing registers are a series of Read Buffers.

In order to safely read from various registers on-board the RTC, all RTC registers (except RTCINT register and bit 0 and 4 of UPDATE0 Register) have a corresponding Read Buffer. When the user reads from the RTC, the user is actually performing a read from the Read Buffers. Therefore, there are two steps needed to read a particular register or set of registers:

- 1. The user writes a 1 to RBUDR bit 4 of the UPDATE0 Register at address 0x04 to transfer most timing registers to the Read Buffers. Behind the scene, the Read Buffers are updated.
- 2. The user then reads from the desired register location.

After step 1, the logic subsequently performs a transfer of data from the actual registers to the Read Buffers and then clears the RBUDR bit.

The logic first does a double synchronization of the RBUDR bit to the 32.768 kHz clock before using it as a clock (RBUDR_sync) to transfer from the actual registers to the Read Buffers, thus allowing a safe update of these 2 unsynchronized clock events.

Example 3. Pseudo code for reading the time:

Set RTCUPDATE0 to 0x10 //transfer timekeeper counters to read buffers

Wait 16ms for read to complete

Read RTCSEC	//second
Read RTCMIN	//minute
Read RTCHOUR	//hour
Read RTCDOW	//Day of Week
Read RTCMONTH	//Month

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Read RTCYEAR //Year Read RTCDOM //Day of Month Example 4. Pseudo code for reading ALARM1 setting: Set RTCUPDATE0 to 0x10 // transfer timekeeper counters to read buffers Wait 16ms for read to complete Read RTCSECA1 //sec Read RTCMINA1 //minute Read RTCHOURA1 //hour Read RTCDOWA1 //Day of Week Read RTCMONTHA1 //Month Read RTCYEARA1 //Year Read RTCDOMA1 //Day of Month

Sudden Momentary Power Loss (SMPL)

The SMPL function allows the system to recover if power is briefly lost due to a poor battery connection. If V_{MBATT} falls below and returns above the UVLO threshold within the SMPL timer threshold (SMPLT[1:0]) and SMPL is enabled (SMPL_EN = 1), SMPL initiates a power-up sequence and the SMPL interrupt bit is set. If the SMPL timer expires before V_{MBATT} returns, the SMPL enable bit is automatically cleared in order to prevent power-up on subsequent SMPL events.

To ensure proper operation of the SMPL state machine, initialization software should clear and set SMPL_EN after each power on event.

Detailed Description—I²C Interface

I²C Slave Address

The device implements 7-bit slave addressing. An I²C bus master initiates communication with a slave device by issuing a START condition followed by the slave address. The device responds to its two slave addresses; all other slave addresses are not acknowledged by the device, (optional) with the exception of the General Call address (Software Reset option).

RTC SLAVE RTC SLAVE PMIC/GPIO SLAVE PMIC/GPIO SLAVE OTP I2CADDR[1:0] ADDRESS WRITE ADDRESS READ ADDRESS READ ADDRESS WRITE 0x90, 0b1001_0000 0b00 0x91, 0b1001 0001 0x38, 0b0011 1000 0x39, 0b0011 1001 0b01 0x94, 0b1001 0100 0x95, 0b1001 0101 0x3C, 0b0011 1100 0x3D, 0b0011 1101 0b10 0x0D, 0b1101 0000 0xD1, 0b1101 0001 0x78, 0b0111 1000 0x79, 0b0111 1001 0b11 0xD4, 0b1101_0100 0xD5, 0b1101_0101 0x7C, 0b0111_1100 0x7D, 0b0111_1101

Table 9. MAX77714 Slave Addresses

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Register Map

RTC

ADDRESS	NAME	MSB							LSB
RTC_FUNC							1	1	
0x00	RTCINT[7:0]	RSVD	RSVD	RSVD	RTC1S	SMPL	RTCA2	RTCA1	RTC60S
0x01	RTCINTM[7:0]	RSVD	RSVD	RSVD	RTC1SM	SMPLM	RTCA2M	RTCA1M	RTC60S M
0x02	RTCCNTLM[7:0]	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	HRMOD EM	BCDM
0x03	RTCCNTL[7:0]	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	HRMOD E	BCD
0x04	RTCUPDATE0[7:0]	RSVD	RSVD	RSVD	RBUDR	RSVD	FREEZE _SEC	FCUR	UDR
0x05	RTCUPDATE1[7:0]	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	RBUDF	UDF
0x06	RTCSMPL[7:0]	SMPL_E N	RSVD	RSVD	RSVD	SMPL	_T[1:0]	RSVD	RSVD
0x07	RTCSEC[7:0]	RSVD				SEC[6:0]			
0x08	RTCMIN[7:0]	RSVD				MIN[6:0]			
0x09	RTCHOUR[7:0]	RSVD	AMPM			HOU	R[5:0]		
0x0A	RTCDOW[7:0]	RSVD	SAT	FRI	THU	WED	TUE	MON	SUN
0x0B	RTCMONTH[7:0]	RSVD	RSVD	RSVD			MONTH[4:0]	
0x0C	RTCYEAR[7:0]			I	YEAF	R[7:0]			
0x0D	RTCDOM[7:0]	RSVD	RSVD				<i>[</i> 5:0]		
0x0E	RTCSECA1[7:0]	AESECA 1		I		SECA1[6:0]			
0x0F	RTCMINA1[7:0]	AEMINA 1				MINA1[6:0]			
0x10	RTCHOURA1[7:0]	AEHOU RA1	AMPMA 1			HOUR	A1[5:0]		
0x11	RTCDOWA1[7:0]	AEDOW A1	SATA1	FRIA1	THUA1	WEDA1	TUEA1	MONA1	SUNA1
0x12	RTCMONTHA1[7:0]	AEMON A1	RSVD	RSVD		N	IONTHA1[4:	0]	
0x13	RTCYEARA1[7:0]	AEYEAR A1			١	/EARA1[6:0)]		
0x14	RTCDOMA1[7:0]	AEDOM A1	RSVD DAYA1[5:0]						
0x15	RTCSECA2[7:0]	AESECA 2	SECA2[6:0]						
0x16	RTCMINA2[7:0]	AEMINA 2	MINA2[6:0]						
0x17	RTCHOURA2[7:0]	AEHOU RA2	AMPMA 2 HOURA2[5:0]						
0x18	RTCDOWA2[7:0]	AEDOW A2	SATA2	FRIA2	THUA2	WEDA2	TUEA2	MONA2	SUNA2

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

ADDRESS	NAME	MSB							LSB
0x19	RTCMONTHA2[7:0]	AEMON A2	RSVD	RSVD	RSVD MONTHA2[4:0]				
0x1A	RTCYEARA2[7:0]	AEYEAR A2	YEARA2[6:0]						
0x1B	RTCDOMA2[7:0]	AEDOM A2	RSVD DAYA2[5:0]						
0x25	RTC_TIME_OK[7:0]	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	RTC_TI ME_OK

Register Details

RTCINT (0x00)

BIT	7	6	5	4		3	2	1	0	
Field	RSVD	RSVD	RSVD	RTC1S	5	SMPL	RTCA2	RTCA1	RTC60S	
Reset	0b0	0b0	0b0	0b0		0b0	0b0	0b0	0x0	
Access Type	Read Only	Read Only	Read Only	Read Only	Re	ad Only	Read Only	Read Only	Read Only	
BITFIELD	BITS		DESCRIPT	ION			D	ECODE		
RSVD	7		physical bit at t are don't care.	his location. W	rite					
RSVD	6		ohysical bit at t are don't care.	his location. W	rite					
RSVD	5		There is no physical bit at this location. Write to 0. Reads are don't care.							
RTC1S	4	Interrupt 0b0 = 1s Tin	RTC Periodic 1 Second Timer Expired Interrupt 0b0 = 1s Timer did not expire 0b1 = 1s Time expired							
SMPL	3	SMPL Event	Interrupt			0: No In 1: Interr	Interrupt errupt			
RTCA2	2	0b0 = No int	RTC Alarm 2 Interrupt 0b0 = No interrupt 0b1 = Interrupt							
RTCA1	1	0b0 = No int	RTC Alarm 1 Interrupt 0b0 = No interrupt 0b1 = Interrupt							
RTC60S	0		ond Timer Exp mer did not ex mer expired							

RTCINTM (0x01)

BIT	7	6	5	4	3	2	1	0
Field	RSVD	RSVD	RSVD	RTC1SM	SMPLM	RTCA2M	RTCA1M	RTC60SM
Reset	0b0	0b0	0x0	0b1	0b1	0b1	0b1	0b1
Access Type	Write, Read							

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
RSVD	7	There is no physical bit at this location. Write to 0. Reads are don't care.
RSVD	6	There is no physical bit at this location. Write to 0. Reads are don't care.
RSVD	5	There is no physical bit at this location. Write to 0. Reads are don't care.
RTC1SM	4	RTC Periodic 1 Second Timer Expired Interrupt MASK 0b0 = Not Masked 0b1 = Masked
SMPLM	3	SMPL Event Interrupt 0b0 = Not Masked 0b1 = Masked
RTCA2M	2	RTC Alarm 2 Interrupt 0b0 = Not Masked 0b1 = Masked
RTCA1M	1	RTC Alarm 1 Interrupt 0b0 = Not Masked 0b1 = Masked
RTC60SM	0	RTC 60 Second Timer Expired Interrupt 0b0 = Not Masked 0b1 = Masked

RTCCNTLM (0x02)

BIT	7	6	5	4		3	2	1	0	
Field	RSVD	RSVD	RSVD	RSVD	F	RSVD	RSVD	HRMODEM	BCDM	
Reset	0b0	0b0	0x0	0b0		0b0	0b0	0b1	0b1	
Access Type	Write, Read	Write, Read	Write, Read	Write, Read	Writ	e, Read	Write, Read	Write, Read	Write, Read	
BITFIELD	BITS		DESCRIPT	ION			D	ECODE		
RSVD	7		physical bit at t are don't care.	his location. W	rite					
RSVD	6		There is no physical bit at this location. Write to 0. Reads are don't care.							
RSVD	5		There is no physical bit at this location. Write to 0. Reads are don't care.							
RSVD	4		physical bit at t are don't care.	his location. W	rite					
RSVD	3		physical bit at t are don't care.	his location. W	rite					
RSVD	2		physical bit at t are don't care.	his location. W	rite					
HRMODEM	1	RTCCNTL 0b0 = Writes address 0x0 0b1 = Writes	Access Control of HRMODE Bit in Register RTCCNTL 0b0 = Writes to Bit 1 (HRMODE) of register address 0x03 (RTCCNTL) is not allowed. 0b1 = Writes to Bit 1 (HRMODE) of register address 0x03 (RTCCNTL) is allowed.				s to Bit 0 (HRM TCCNTL) is all	IODE) of registr owed.	er address	

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION	DECODE
BCDM	0	Access Control of BCD Bit in Register RTCCNTL 0b0 = Writes to Bit 0 (BCD) of register address 0x03 (RTCCNTL) is not allowed. 0b1 = Writes to Bit 0 (BCD) of register address 0x03 (RTCCNTL) is allowed.	0: Writes to Bit 0 (BCD) of register address 0x03 (RTCCNTL) is not allowed. 1: Writes to Bit 0 (BCD) of register address 0x03 (RTCCNTL) is allowed.

RTCCNTL (0x03)

BIT	7	6	5	4	3		2	1	0
Field	RSVD	RSVD	RSVD	RSVD	RSVD		RSVD	HRMODE	BCD
Reset	0b0	0b0	0b0	0b0	0b0		0b0	0b0	0b0
Access Type	Write, Read	Write, Read	Write, Read	Write, Read	Write, Re	ead	Write, Read	Write, Read	Write, Read
BITFIELD	BITS		DESCRIPT	ION			D	ECODE	
RSVD	7		physical bit at t are don't care.	his location. W	rite				
RSVD	6		physical bit at t are don't care.	his location. W	rite				
RSVD	5		physical bit at t are don't care.	his location. W	rite				
RSVD	4		physical bit at t are don't care.	his location. W	rite				
RSVD	3		There is no physical bit at this location. Write to 0. Reads are don't care.						
RSVD	2		physical bit at t are don't care.	his location. W	rite				
HRMODE	1	HOURA reg 12-hour mod has AM/PM 0b0 = 12-Ho 0b1 = 24-Ho If HRMODE allowed. When switch 24-hour mod	MPM bit defined ister only make de as the 24-ho implied. bur mode bur mode M = 0, writes to hing between 1 de, the register y update. User		dy not				

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION	DECODE
BCD	0	Data Mode for Time and Calendar Updates 0b0 = Binary 0b1 = Binary Coded Decimal (BCD) If BCDM = 0 writes to BCD are not allowed. When switching between binary and BCD, the time contents are no longer valid and must be reinitialized.	0: Binary 1: Binary Coded Decimal (BCD)

RTCUPDATE0 (0x04)

BIT	7	6	5		4	3	2	1	0		
Field	RSVD	RSVD	RS	/D	RBUDR	RSVD	FREEZE_S EC	FCUR	UDR		
Reset	0b0	0b0	0b	0	0b0	0b1	0b0	0b1	0b0		
Access Type	Write, Rea	d Write, Read	Write,	Read	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read		
BITFIE	LD	BITS		DESCRIPTION							
RSVD		7		There is no physical bit at this location. Write to 0. Reads are don't care.							
RSVD	SVD 6				e is no physical	bit at this locat	tion. Write to 0.	Reads are do	n't care.		
RSVD	D 5				e is no physical	bit at this locat	tion. Write to 0.	Reads are do	n't care.		
RBUDR		4		 Access control to update RTC registers by transferring data from the acregisters to the Read Buffers. 0b0 = No action 0b1 = Update Read Buffers Typical transfer time from timekeeper counters to read is 15ms after RI is set. RBUDR is internally cleared after the registers data has been transferred 							
RSVD		3		There	e is no physical	bit at this locat	tion. Write to 0.	Reads are do	n't care.		
FREEZE_SEC	;	2		0b0 = 0b1 =	bit freezes the s SEC counter i SEC counter s timer string (M	ncrements nor stops incremen	mally ting, which sto	ps all subseque			
FCUR		1		Flags Cleared Upon Read Control Bit 0b0 = User must write 0 to clear UDF and RBUDF 0b1 = UDF and RBUDF cleared upon read							
UDR 0				Access control to update RTC registers by transferring data from the Write Buffers to the actual registers. 0b0 = No action 0b1 = Update register Typical transfer time from Write Buffers to the timekeeper counters is 15ms after UDR is set. UDR is internally cleared after the registers data has been transferred.							

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

RTCUPDATE1 (0x05)

BIT	7	6	5	;	4	3	2	1	0		
Field	RSVD	RSVD	RS	VD	RSVD	RSVD	RSVD	RBUDF	UDF		
Reset	0b0	0b0	0b	0	0b0	0b0	0b0	0b1	0b0		
Access Type	Read Only	Read Only	Read	Only	Read Only	Read Only	Read Only	Read Only	Read Only		
BITFIE	LD	BITS		DESCRIPTION							
RSVD 7				There	e is no physical	bit at this locat	tion. Write to 0.	Reads are do	n't care.		
RSVD	SVD 6				e is no physical	bit at this locat	tion. Write to 0.	Reads are do	n't care.		
RSVD		5		There	e is no physical	bit at this locat	tion. Write to 0.	Reads are do	n't care.		
RSVD		4		There	e is no physical	bit at this locat	tion. Write to 0.	Reads are do	n't care.		
RSVD		3		There	e is no physical	bit at this locat	tion. Write to 0.	Reads are do	n't care.		
RSVD		2 There is no physical bit at this location. Write to 0. Reads are							lon't care.		
RBUDF 1				This bit is an Update Flag that indicates when an actual transfer of data from the actual registers to Read Buffers occurs. When this bit is 1, then the user can initiate a new read operation, otherwise it is not safe to do so. 0b0 = Update not done 0b1 = Update done Typical update time is 15ms after the RBUDR bit is set. If FCUR bit (RTCUPDATE0 register) is 1, this bit is automatically cleared after a read operation. If FCUR is 0, the user must write a 0 to clear it.							
UDF 0				 This bit is an Update Flag that indicates when an actual transfer of data from the Write Buffers to the corresponding register occurs. When this bit is 1, then the user can initiate a new write operation, otherwise it is not safe to do so. 0b0 = Update not done 0b1 = Update done Typical update time is 15ms after the UDR bit is set. If FCUR bit (RTCUPDATE0 register) is 1, this bit is automatically cleared after a read operation. If FCUR is 0, the user must write a 0 to clear it. 							

RTCSMPL (0x06)

BIT	7		6	5	5 4		3	2	1	0
Field	SMPL_E	N	RSVD	RS\	/D	RSVD	SMPL	.T[1:0]	RSVD	RSVD
Reset	0b0		0b0	0b	0	0b0	Ob	00	0b0	0b0
Access Type	Write, Re	ad W	Vrite, Read	Write,	Read	Read Write, Read Write, Read		Write, Read	Write, Read	
BITFIEI	D		BITS				DE	SCRIPTION		
SMPL_EN			7		0b0 =	- Feature Enab SMPL Disable SMPL Enable	d			
RSVD			6		There is no physical bit at this location. Write to 0. Reads are don't care.					
RSVD			5		There is no physical bit at this location. Write to 0. Reads are don't care.					
RSVD			4		There is no physical bit at this location. Write to 0. Reads are don't care.					

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
SMPLT	3:2	Sets the SMPL Timer Threshold 0b00 = 0.5s 0b01 = 1.0s 0b10 = 1.5s 0b11 = 2.0s
RSVD	1	There is no physical bit at this location. Write to 0. Reads are don't care.
RSVD	0	There is no physical bit at this location. Write to 0. Reads are don't care.

RTCSEC (0x07)

BIT	7	6	6 5 4 3 2 1							
Field	RSVD		SEC[6:0]							
Reset	0b0		0b0000000							
Access Type	Write, Rea	ad	Write, Read							
BITFI	ELD	BITS			DE	SCRIPTION				
RSVD		7	There	e is no physica	l bit at this locat	ion. Write to (). Reads are do	n't care.		
SEC		6:0	In Bir In BC	RTC Seconds Counter Register In Binary format (BCD = 0), valid values for B6 through B0 are 0 through In BCD format, valid data for B6 through B4 are 0 through 5, and valid data for B3 through B0 are 0 through 9.						

RTCMIN (0x08)

BIT	7	6	6 5 4 3 2 1 0							
Field	RSVD		MIN[6:0]							
Reset	0b0		0b000000							
Access Type	Write, Re	ad	Write, Read							
BITFIE	ELD	BITS			DE	SCRIPTION				
RSVD		7	There	e is no physical	bit at this locat	tion. Write to (). Reads are do	on't care.		
MIN		6:0	In Bir In BC	RTC Minutes Counter Register In Binary format (BCD = 0), valid values for B6 through B0 are 0 throug In BCD format, valid data for B6 through B4 are 0 through 5, and valid of for B3 through B0 are 0 through 9.						

RTCHOUR (0x09)

BIT	7	6	5	5 4 3 2 1							
Field	RSVD	AMPM		HOUR[5:0]							
Reset	0b0	0b0		0b00000							
Access Type	Write, Read	Write, Read		Write, Read							
BITFIE	LD	BITS	DESCRIPTION								
RSVD		7	There is no physical bit at this location. Write to 0. Reads are don't care.								

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
АМРМ	6	AM/PM Selection. AMPM is only valid when the clock is set for 12-hour mode (HRMODE = 0). When the clock is set for 24-hour mode, this bit is a don't care. 0b0 = AM 0b1 = PM
HOUR	5:0	 RTC Hours Counter Register Note that there are two possibilities for values chosen for B5 through B0 depending on current status of HRMODE Bit: If HRMODE = 1 (24-Hour Mode) Binary mode (BCD = 0): B5 is zero, and B4 through B0 valid values are 0 through 23. BCD mode (BCD = 1): Valid values for B5 through B4 are 0 through 2, and valid values for B3 through B0 are 0 through 9 (the full number does not exceed 23). If HRMODE = 0 (12-Hour Mode) Binary mode (BCD = 0): B5 and B4 are 0, and valid values for B3 through B0 are 1 through 12. BCD mode (BCD = 1): Valid values for B5 through B4 are 0 through 1, and valid values for B3 through B0 are 0 through 9 (the full number does not exceed 12).

RTCDOW (0x0A)

BIT	7	6	5		4	3	2	1	0		
Field	RSVD	SAT	FRI		THU	WED	TUE	MON	SUN		
Reset	0b0	0b0	0b0		0b0	0b0	0b0	0b0	0b1		
Access Type	Write, Read	Write, Read	Write, R	ead	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read		
BITFIE	LD	BITS				DE	SCRIPTION				
RSVD		7	٦	There is no physical bit at this location. Write to 0. Reads are don't care.							
SAT		6			Bits B6 through B0 each represent one day of the week. As such, only one bit is set at a time. B[6:0] = 100_0000 represents Saturday						
FRI		5	E	B[6:0] = 010_0000 represents Friday							
THU		4	E	B[6:0] = 001_0000 represents Thursday							
WED		3	E	B[6:0] = 000_1000 represents Wednesday							
TUE		2	E	B[6:0] = 000_0100 represents Tuesday							
MON		1	E	B[6:0] = 000_0010 represents Monday							
SUN		0	E	B[6:0]	= 000_0001 re	epresents Sun	day				

RTCMONTH (0x0B)

BIT	7	6	5		4	3	2	1	0		
Field	RSVD	RSVD	RSVI	D	MONTH[4:0]						
Reset	0b0	0b0	0b0	b0 0b00001							
Access Type	Write, Read	Write, Read	Write, R	Read Write, Read							
BITFIE	LD	BITS		DESCRIPTION							
RSVD		7		There is no physical bit at this location. Write to 0. Reads are don't care.							

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
RSVD	6	There is no physical bit at this location. Write to 0. Reads are don't care.
RSVD	5	There is no physical bit at this location. Write to 0. Reads are don't care.
MONTH	4:0	RTC Months Counter Register In Binary format (BCD = 0), valid values for B4 through B0 are 1 through 12. In BCD format (BCD = 1), valid data for B4 is either 0 or 1, and valid data for B3 through B0 are 0 through 9 (the full value in BCD format does not exceed 12 and must be greater than zero).

RTCYEAR (0x0C)

BIT	7	6	5	4	3	2	1	0			
Field		YEAR[7:0]									
Reset		0b0000000									
Access Type		Write, Read									
BITFIEI	LD	BITS			DE	SCRIPTION					
YEAR 7:0 RTC Years Counter Register In Binary format (BDC = 0), valid values for B7 through B0 are 0 thro In BCD format (BCD = 1), valid data for B7 through B4 are 0 through similarly valid data for B3 through B0 are 0 through 9.											

RTCDOM (0x0D)

BIT	7	6	5	4	3	2	1	0			
Field	RSVD	RSVD		DAY[5:0] 0b000001							
Reset	0b0	0b0		0b000001							
Access Type	Write, Rea	d Write, Read		Write, Read							
BITFIE	LD	BITS		DESCRIPTION							
RSVD		7	The	There is no physical bit at this location. Write to 0. Reads are don't care.							
RSVD		6	The	There is no physical bit at this location. Write to 0. Reads are don't care.							
DAY		5:0	In B In B valid thar Furt acco • Fo mus • Fo thro • Fo 1 thi not a	C Days in a Mon inary format (BC CD format (BC d data for B3 thr o but not excer- hermore, there ording to the sel r months 1, 3, 5 to be 1 through 3 r months 4, 6, 9 ugh 30. r month 2, or month rough 28 for non account for sola , 4, 8, 24, 28	CD = 0, valid w D = 1, valid da ough B0 are 0 ed 31). is a restriction ected month a C, 7, 8, 10, and C, and 11 the second onth of Feb., the mal years, or p r years. Leap y	through 9 (the on choosing nund year as sho 12 the selected elected value for must be 1 through the selected value must be 1 through the selected value for must be 1 through the selected value for the selec	gh B5 are 0 thi full value shou umber of days wn below: d value for B5 or B5 through I ue for B5 throu ugh 29 for leap	rough 3, and uld be greater in a month through B0 B0 must be 1 ugh B0 must be o years. Does			

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

RTCSECA1 (0x0E)

BIT	7	6							
Field	AESECA1				SEC	CA1[6:0]			
Reset	0b0				0b0	000000			
Access Type	Write, Read				Write	e, Read			
BITFIELD	BITS		DESCRIPT	ION			ſ	DECODE	
AESECA1	7	Alarm Enabl	e Control			0: Alarm 1: Alarm			
SECA1	6:0	In Binary for B6 through I format, valid through 5, a	RTC Seconds Counter Register In Binary format (BCD = 0), valid values for B6 through B0 are 0 through 59. In BCD format, valid data for B6 through B4 are 0 through 5, and valid data for B3 through B0 are 0 through 9.						

RTCMINA1 (0x0F)

BIT	7	6	5	4		3	2	1	0			
Field	AEMINA1		MINA1[6:0]									
Reset	0b0				0x0	000001						
Access Type	Write, Read		Write, Read									
BITFIELD	BITS		DESCRIPT	ION				DECODE				
AEMINA1	7	Alarm Enabl	e Control			0: Alarm 1: Alarm						
MINA1	6:0	If the value of MIN and AE interrupt is g RTC Minute In Binary for B6 through f format, valid	MINA1 is 1, ar enerated. s Counter Reg mat (BCD = 0) 30 are 0 throug data for B6 th nd valid data for	ual to the value RTCA1 alarm ister , valid values f	or							

RTCHOURA1 (0x10)

BIT	7	6	5	4	3	2	1	0		
Field	AEHOURA	1 AMPMA1		HOURA1[5:0]						
Reset	0b0	0b0		0b00001						
Access Type	Write, Rea	d Write, Read		Write, Read						
BITFIE	LD	BITS			DE	SCRIPTION				
AEHOURA1		7	Alarm Enable Control 0b0 = Alarm disabled 0b1 = Alarm enabled							

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
AMPMA1	6	AM/PM Selection AMPM is only valid when the clock is set for 12-hour mode (HRMODE = 0). When the clock is set for 24-hour mode, this bit is a don't care. 0b0 = AM 0b1 = PM
		RTC Hours Alarm Register If the value of HOURA1 is equal to the value of HOUR and AEHOURA1 is 1, an RTCA1 alarm interrupt is generated.
HOURA1	5:0	 RTC Hours Counter Register Note that there are two possibilities for values chosen for B5 through B0 depending on current status of HRMODE Bit: If HRMODE = 1 (24-Hour Mode) Binary mode (BCD = 0): B5 is zero, and B4 through B0 valid values are 0 through 23. BCD mode (BCD = 1): Valid values for B5 through B4 are 0 through 2, and valid values for B3 through B0 are 0 through 9 (the full number does not exceed 23). If HRMODE = 0 (12-Hour Mode) Binary mode (BCD = 0): B5 and B4 are 0, and valid values for B3 through B0 are 1 through 12. BCD mode (BCD = 1): Valid values for B5 through B4 are 0 through 1, and valid values for B3 through B0 are 0 through 9 (the full number does not exceed 12).

RTCDOWA1 (0x11)

BIT	7		6	5		4	3	2	1	0		
Field	AEDOW	A1	SATA1	FRI	A1	THUA1	WEDA1	TUEA1	MONA1	SUNA1		
Reset	0b0		0b0	0b	0	0b0	0b0	0b0	0b0	0b1		
Access Type	Write, Re	rite, Read Write, Read Write			Read	Read Write, Read Write, Read Write, Read Write, Read Write, Read						
BITFIE	LD	D BITS					DE	SCRIPTION				
AEDOWA1	7				0b0 =	Alarm Enable Control 0b0 = Alarm disabled 0b1 = Alarm enabled						
SATA1	RTC Day Of Week Alarm Register If the value of RTCDOWA1 is equal to the value of DOW ar an RTCA1 alarm interrupt is generated. Bits B6 through B0 each represent one day of the week. As is set at a time. B[6:0] = 100 0000 represents Saturday											
FRIA1			5		B[6:0] = 010_0000 r	epresents Frida	ау				
THUA1			4		B[6:0] = 001_0000 r	epresents Thur	sday				
WEDA1] = 000_1000 r	epresents Wed	Inesday				
TUEA1	2			B[6:0] = 000_0100 represents Tuesday								
MONA1	MONA1 1 B[6:0] = 000_0010 represents Monday											
SUNA1			0		B[6:0] = 000_0001 r	epresents Sun	day				

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

RTCMONTHA1 (0x12)

BIT	7	6	5		4	3	2	1	0						
Field	AEMONA1	RSVD	RS\	/D	MONTHA1[4:0]										
Reset	0b0	0b0	0b	0			0b00000								
Access Type	Write, Read	Write, Read	Write,	Read	Write, Read										
BITFIEI	LD	BITS	BITS			DE	SCRIPTION								
AEMONA1		7		0b0 =	rm Enable Control) = Alarm disabled = Alarm enabled										
RSVD		6		There	e is no physical	bit at this loca	ation. Write to 0.	Reads are do	n't care.						
RSVD		5	5		ere is no physical bit at this location. Write to 0. Reads are don't care.						ere is no physical bit at this location. Write to 0. Reads are don't care.				
MONTHA1		4:0		If the	C Month Alarm Register ne value of MONTHA1 is equal to the value of MONTH and AEMONTHA I, an RTCA1 alarm interrupt is generated.										

RTCYEARA1 (0x13)

BIT	7	6	5	4	3	2	1	0		
Field	AEYEARA	1	YEARA1[6:0]							
Reset	0b0				0b0000000					
Access Type	Write, Rea	d			Write, Read					
BITFIE	LD	BITS			DE	SCRIPTION				
AEYEARA1		7	0b0 =	n Enable Cont = Alarm disabl = Alarm enable	ed					
YEARA1		6:0	If the RTC/ RTC In Bir In BC	A1 alarm intern Years Counte nary format (B CD format (BC	RA1 is equal to rupt is generate	d. alues for B7 th a for B7 throug	rough B0 are 0 gh B4 are 0 thre	through 99.		

RTCDOMA1 (0x14)

BIT	7	6	5	5 4 3 2 1									
Field	AEDOMA1	RSVD		DAYA1[5:0]									
Reset	0b0	0b0		0b00000									
Access Type	Write, Read	Write, Read		Write, Read							Write, Read		
BITFIE	LD	BITS			DE	SCRIPTION							
AEDOMA1		7	0b0 :	Alarm Enable Control 0b0 = Alarm disabled 0b1 = Alarm enabled									
RSVD		6	There is no physical bit at this location. Write to 0. Reads are don't care.										

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
DAYA1	5:0	RTC Day Of Month Alarm 1 Register If the value of DAYA1 is equal to the value of DAY and AEDAYA1 is 1, an RTCA1 alarm interrupt is generated.

RTCSECA2 (0x15)

BIT	7	6	5	4	3	2	1	0		
Field	AESECA	12	SECA2[6:0]							
Reset	0b0		0b000000							
Access Type	Write, Re	ad	Write, Read							
BITFIE	LD	BITS			DES	CRIPTION				
AESECA2	AESECA2 7		7 Alarm Enable Control 7 0b0 = Alarm disabled 0b1 = Alarm enabled							
SECA2		6:0	In Bi In BC	RTC Seconds Counter Register In Binary format (BCD = 0), valid values for B6 through B0 are 0 through 59 In BCD format, valid data for B6 through B4 are 0 through 5, and valid data for B3 through B0 are 0 through 9.						

RTCMINA2 (0x16)

BIT	7	6	5	4	3	2	1	0		
Field	AEMINA2	2	MINA2[6:0]							
Reset	0b0		0b000001							
Access Type	Write, Rea	ıd	Write, Read							
BITF	IELD	BITS			DE	SCRIPTION				
AEMINA2		7	0b0 =	Enable Cont Alarm disabl Alarm enable	ed					
MINA2		6:0	If the RTCA RTC In Bir In BC	RTC Minutes Alarm Register If the value of MINA2 is equal to the value of MIN and AEMINA2 is 1, an RTCA2 alarm interrupt is generated. RTC Minutes Counter Register In Binary format (BCD = 0), valid values for B6 through B0 are 0 through In BCD format, valid data for B6 through B4 are 0 through 5, and valid of for B3 through B0 are 0 through 9.						

RTCHOURA2 (0x17)

BIT	7	6	5	4	3	2	1	0		
Field	AEHOURA2	AMPMA2		HOURA2[5:0]						
Reset	0b0	0b0			0b00	0000				
Access Type	Write, Read	Write, Read			Write,	Read				

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
AEHOURA2	7	Alarm Enable Control 0b0 = Alarm disabled 0b1 = Alarm enabled
AMPMA2	6	AM/PM Selection. AMPM is only valid when the clock is set for 12-hour mode (HRMODE = 0). When the clock is set for 24-hour mode, this bit is a don't care. 0b0 = AM 0b1 = PM
HOURA2	5:0	 RTC Hours Alarm Register If the value of HOURA2 is equal to the value of HOUR and AEHOURA2 is 1, an RTCA2 alarm interrupt is generated. RTC Hours Counter Register Note that there are two possibilities for values chosen for B5 through B0 depending on current status of HRMODE Bit: If HRMODE = 1 (24-Hour Mode) Binary mode (BCD = 0): B5 is zero, and B4 through B0 valid values are 0 through 23. BCD mode (BCD = 1): Valid values for B5 through B4 are 0 through 2, and valid values for B3 through B0 are 0 through 9 (the full number does not exceed 23). If HRMODE = 0 (12-Hour Mode) Binary mode (BCD = 0): B5 and B4 are 0, and valid values for B3 through B0 are 1 through 12. BCD mode (BCD = 1): Valid values for B5 through B4 are 0 through 1, and valid values for B3 through B0 are 0 through 9 (the full number does not exceed 12).

RTCDOWA2 (0x18)

BIT	7	6	5		4	3	2	1	0		
Field	AEDOWA	2 SATA2	FRI	A2	THUA2	WEDA2	TUEA2	MONA2	SUNA2		
Reset	0b0	0b0	0b	0	0b0	0b0	0b0	0b0	0b1		
Access Type	Write, Rea	ad Write, Read	Read	Read Write, Read Write, Read Write, Read Write, Read Write, Read							
BITFIEI	LD	BITS		DESCRIPTION							
AEDOWA2		7 Alarm Enable Control 0b0 = Alarm disabled 0b1 = Alarm enabled									
SATA2		6		RTC Day Of Week Alarm Register If the value of RTCDOWA2 is equal to the value of DOW and AEDC an RTCA2 alarm interrupt is generated. Bits B6 through B0 each represent one day of the week. As such, o is set at a time. B[6:0] = 100 0000 represents Saturday							
FRIA2		5		B[6:0] = 010_0000 r	epresents Frida	ау				
THUA2		4		B[6:0] = 001_0000 r	epresents Thur	sday				
WEDA2		3		B[6:0] = 000_1000 represents Wednesday							
TUEA2		2		B[6:0] = 000_0100 represents Tuesday							
MONA2		1		B[6:0] = 000_0010 represents Monday							
SUNA2		0		B[6:0] = 000_0001 r	epresents Sun	day				

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

RTCMONTHA2 (0x19)

BIT	7	6	5	4	3	2	1	0		
Field	AEMONA2	RSVD	RSVD			MONTHA2[4:0]				
Reset	0b0	0b0	0b0			0b00000				
Access Type	Write, Read	Write, Read	Write, Read			Write, Read				
BITFIELD	BITS		DESCRIPT	ION		D	ECODE			
AEMONA2	7	Alarm Enabl 0b0 = Alarm 0b1 = Alarm	disabled			n disable n enable				
RSVD	6		physical bit at t are don't care.	his location. Write	2					
RSVD	5		physical bit at t are don't care.	his location. Write	•					
MONTHA2	4:0	If the value of MO	Alarm Register of MONTHA2 is NTH and AEM m interrupt is g	s equal to the ONTHA2 is 1, an						

RTCYEARA2 (0x1A)

BIT	7	6	5	4	3	2	1	0			
Field	AEYEARA	2	YEARA2[6:0]								
Reset	0b0				0b000000						
Access Type	Write, Rea	d			Write, Read						
BITFIE	LD	BITS			DE	SCRIPTION					
AEYEARA2		7	0b0 =	Alarm Enable Control 0b0 = Alarm disabled 0b1 = Alarm enabled							
YEARA2		6:0	If the RTC/ RTC In Bir In BC	RTC Year Alarm Register If the value of YEARA2 is equal to the value of YEAR and AEYEARA2 is 1 RTCA2 alarm interrupt is generated. RTC Years Counter Register In Binary format (BDC = 0), valid values for B7 through B0 are 0 through 9 In BCD format (BCD = 1), valid data for B7 through B4 are 0 through 9, an similarly valid data for B3 through B0 are 0 through 9.							

RTCDOMA2 (0x1B)

BIT	7	6	5	4	3	2	1	0
Field	AEDOMA2	RSVD			DAYA	2[5:0]		
Reset	0b0	0b0			0b00	0000		
Access Type	Write, Read	Write, Read			Write,	Read		

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
AEDOMA2	7	Alarm Enable Control 0b0 = Alarm disabled 0b1 = Alarm enabled
RSVD	6	There is no physical bit at this location. Write to 0. Reads are don't care.
DAYA2	5:0	RTC Day Of Month Alarm 2 Register If the value of DAYA2 is equal to the value of DAY and AEDAYA2 is 1, an RTCA2 alarm interrupt is generated.

RTC_TIME_OK (0x25)

BIT	7	6	5		4	3	2	1	0	
Field	RSVD	RSVD	RS	/D	RSVD	RSVD	RSVD	RSVD	RTC_TIME _OK	
Reset	0b0	0b0	0b	0	0b0	0b0	0b0	0b0	0b0	
Access Type	Write, Rea	ad Write, Read	Write,	Read	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read	
BITFIE	LD	BITS				DE	SCRIPTION			
RSVD		7		There	e is no physical	bit at this locat	tion. Write to 0.	Reads are do	n't care.	
RSVD		6	6 There is no physical bit at this location. W					Reads are do	n't care.	
RSVD		5 There is no physical bit at this location. Write to 0. F					. Reads are don't care.			
RSVD		4		There	e is no physical	bit at this locat	tion. Write to 0.	Reads are do	n't care.	
RSVD		3		There is no physical bit at this location. Write to 0. Reads are don't care.						
RSVD		2		There is no physical bit at this location. Write to 0. Reads are don't care.						
RSVD		1		There	e is no physical	bit at this locat	tion. Write to 0.	Reads are do	n't care.	
RTC_TIME_O	к	0 RTC_TIME_OK bit can be used by the customer to use as a RTC da bit. This bit is by default 0, communicating that the RTC time keeping re data is either holding RESET default or holding a value which is not In the application, when the customer updates the time keeping regishould write 1 to this bit and every time this bit is read and holds "1" that the RTC data is current/valid. If the VRTC < VRTCUVLO, then t reset to 0.						g register not current. register, they "1" implies		

PMIC-GPIO

	•								
ADDRESS	NAME	MSB							LSB
CLOGIC									
0x00	INT_TOP[7:0]	IRQ_GL BL	IRQ_SD	IRQ_LD O	IRQ_GPI O	IRQ_RT C	RSVD	IRQ_ON OFF	IRQ
0x01	INT_MBATTRST_TEM P[7:0]	RSVD	RSVD	RSVD	RSVD	RSVD	MBATTR ESET_R	TJALRM 1_R	TJALRM 2_R
0x02	INT_LVL2_ONOFF[7:0]	RSVD	RSVD	ACOK_R	ACOK_F	EN0_R	EN0_F	EN0_1S EC	MRWRN
0x03	INT_LVL2_SD0_3[7:0]	SD0_OV _I	SD0_UV _I	SD1_OV _I	SD1_UV _I	SD2_OV _I	SD2_UV _I	SD3_OV _I	SD3_UV _I
0x04	INT_LVL2_L0_7[7:0]	IRQ_LVL 2_7	IRQ_LVL 2_6	IRQ_LVL 2_5	IRQ_LVL 2_4	IRQ_LVL 2_3	IRQ_LVL 2_2	IRQ_LVL 2_1	IRQ_LVL 2_0

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

ADDRESS	NAME	MSB							LSB
0x05	INT_LVL2_L8[7:0]	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	IRQ_LVL 2_8
0x06	INT_LVL2_GPIO[7:0]	EDGE7	EDGE6	EDGE5	EDGE4	EDGE3	EDGE2	EDGE1	EDGE0
0x07	INT_TOPM[7:0]	IRQ_GL BLM	IRQ_SD M	IRQ_LD OM	IRQ_GPI OM	IRQ_RT CM	RSVD	IRQ_ON OFFM	GLBLM
0x08	INTM_MBATTRST_TE MP[7:0]	RSVD	RSVD	RSVD	RSVD	RSVD	MBATTR ESETM	TJALRM 1M	TJALRM 2M
0x09	INTM_ONOFF[7:0]	RSVD	RSVD	ACOK_H IGHM	ACOK_L OWM	EN0_RM	EN0_FM	EN0_1S ECM	MRWRN M
0x0A	INTM_SD0_3[7:0]	SD0_OV _M	SD0_UV _M	SD1_OV _M	SD1_UV _M	SD2_OV _M	SD2_UV _M	SD3_OV _M	SD3_UV _M
0x0B	INT_MSK_L0_7[7:0]	IRQ_MS K_L7	IRQ_MS K_L6	IRQ_MS K_L5	IRQ_MS K_L4	IRQ_MS K_L3	IRQ_MS K_L2	IRQ_MS K_L1	IRQ_MS K_L0
0x0C	INT_MSK_L8[7:0]	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	IRQ_MS K_L8
0x0D	STAT_MBATTRST_TE MP[7:0]	RSVD	RSVD	RSVD	RSVD	RSVD	MBATTR ESET_S	TJALRM 1	TJALRM 2
0x0E	STAT_ONOFF[7:0]	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	EN0	ACOK
0x10	POERC0[7:0]	RSTIN	MBU	МВО	MBLSD	TOVLD	HDRST	WTCHD G	SHDN
0x11	POERC1[7:0]	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	32K_OK	BRDY_O K
0x20	STAT_SD0_3[7:0]	SD0_OV _S	SD0_UV _S	SD1_OV _S	SD1_UV _S	SD2_OV _S	SD2_UV _S	SD3_OV _S	SD3_UV _S
0x30	<u>32K_STATUS[7:0]</u>	RSVD	RSVD	SIOSCO K	XOSCO K	32KSOU RCE	32KLO	AD[1:0]	CRYSTA L_CONF IG
0x31	32K_CONFIG[7:0]	RSVD	RSVD	RSVD	XOSC_R ETRY	RSVD	PWR_MD	0_32k[1:0]	32KSOU RCE_OT P
0x90	CNFG_GLBL1[7:0]	RSVD	MBLPD		ESET_HY	MBA	TT_RESET	[2:0]	MBATT_ RSTEN
0x91	CNFG_GLBL2[7:0]	RSVD	RSVD	RSVD	GLBL_L PM	WDTSLP C	WDTEN	TWE)[1:0]
0x92	CNFG_GLBL3[7:0]	RSVD	RSVD	RSVD	SRCFPS 0	ENFPS0	SRCFPS 1	ENFPS1	WDTC
0x93	CNFG1_ONOFF[7:0]	RSVD	SFT_RS T		MRT[2:0]		SLPEN	PWR_O FF	EN0DLY
0x94	CNFG2_ONOFF[7:0]	MR_RST _WK	SFT_RS T_WK	WD_RS T_WK	WK_AC OK	WK_MB ATT	WK_ALA RM1R	WK_ALA RM2R	WK_EN0
0x95	MSTR_PU_PD[7:0]	RSVD	M	STR_PU[2:	0]	RSVD	M	ISTR_PD[2:	0]
0x96	MSTR_SLPENTRY_EXI T[7:0]	RSVD	MSTI	STR_SLPENTY[2:0]		RSVD	MST	R_SLPEXT	[2:0]
0x97	BUCK_PWR_MD[7:0]	PWR_MD	_SD3[1:0]	SD3[1:0] PWR_MD_SD2[1:0]		PWR_MD	_SD1[1:0]	PWR_MD	_SD0[1:0]
0x98	LDO_PWR_MD0_3[7:0]	PWR_M	D_L0[1:0]			PWR_MI	D_L2[1:0]	PWR_MI	D_L3[1:0]
0x99	LDO_PWR_MD4_7[7:0]	PWR_M	D_L4[1:0]	PWR_M	D_L5[1:0]	PWR_MI	D_L6[1:0]	PWR_MI	D_L7[1:0]
0x9A	LDO_PWR_MD8[7:0]	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	PWR_M	D_L8[1:0]
0x9B	LDO0FPS[7:0]	FPSSRC	C_L0[1:0]	LD	O0UPSLT[2	2:0]	LD	O0DNSLT[2	2:0]

Analog Devices | 95

LSB

LDO1DNSLT[2:0]

LDO2DNSLT[2:0]

LDO3DNSLT[2:0]

MAX77714

ADDRESS

0x9C

0x9D

0x9E

NAME

LDO1FPS[7:0]

LDO2FPS[7:0]

LDO3FPS[7:0]

MSB

FPSSRC_L1[1:0]

FPSSRC_L2[1:0]

FPSSRC_L3[1:0]

ONOL		1100100								
0x9F	LDO4FPS[7:0]	FPSSRC	C_L4[1:0]	LD	O4UPSLT[2	2:0]	LD	O4DNSLT[2	2:0]	
0xA0	LDO5FPS[7:0]	FPSSRC	C_L5[1:0]	LD	O5UPSLT[2	2:0]	LD	O5DNSLT[2	2:0]	
0xA1	LDO6FPS[7:0]	FPSSRC	C_L6[1:0]	LD	O6UPSLT[2	2:0]	LD	O6DNSLT[2	2:0]	
0xA2	LD07FPS[7:0]	FPSSRC	C_L7[1:0]	LD	07UPSLT[2	2:0]	LD	O7DNSLT[2	2:0]	
0xA3	LDO8FPS[7:0]	FPSSRC	C_L8[1:0]	LD	O8UPSLT[2	2:0]	LD	O8DNSLT[2	2:0]	
0xA4	SD0FPS[7:0]	FPSSRC	_SD0[1:0]	SD0UPSLT[2:0]			SI	SD0DNSLT[2:0]		
0xA5	SD1FPS[7:0]	FPSSRC	_SD1[1:0]	SI	D1UPSLT[2	:0]	SI	:0]		
0xA6	SD2FPS[7:0]	FPSSRC	_SD2[1:0]	SI	D2UPSLT[2	:0]	SI	D2DNSLT[2	:0]	
0xA7	SD3FPS[7:0]	FPSSRC	_SD3[1:0]	SI	D3UPSLT[2	:0]	SI	D3DNSLT[2	:0]	
0xA8	GPI00FPS[7:0]	FPSSRC_	GPIO0[1:0]	GP	IO0UPSLT[2:0]	GP	IO0DNSLT[2:0]	
0xA9	GPIO1FPS[7:0]	FPSSRC_	GPIO1[1:0]	GP	IO1UPSLT[2:0]	GP	IO1DNSLT[2:0]	
0xAA	<u>GPIO2FPS[7:0]</u>	FPSSRC_	GPIO2[1:0]	GP	IO2UPSLT[2:0]	GP	IO2DNSLT[2:0]	
0xAB	<u>GPI07FPS[7:0]</u>	FPSSRC_	GPIO7[1:0]	GP	IO7UPSLT[2:0]	GP	IO7DNSLT[2:0]	
0xAC	RSTIOFPS[7:0]	FPSSRC_	RSTIO[1:0]	RS	ST7UPSLT[2	2:0]	RS	T7DNSLT[2	2:0]	
			0	VERLAP						
BUCK										
0x40	SD0_CNFG1[7:0]	RSVD			S	D0VOUT[6:	0]			
0x41	SD1_CNFG1[7:0]	RSVD			S	D1VOUT[6:	0]			
0x42	SD2_CNFG1[7:0]				SD2VC					
0x43	SD3_CNFG1[7:0]				SD3VC	UT[7:0]				
0x44	SD0_CNFG2[7:0]	RSVD	RSVD	SD0_SS RAMP	RSVD	RSVD	SD0FSR EN	SD0ADD IS	SD0FPW MEN	
0x45	SD0_CNFG3[7:0]	SD0_BO	_THR[1:0]	SD0_BO	_HYS[1:0]	RSVD	SD0_BO	_PR[1:0]	SD0_OV _THR	
0x46	SD1_CNFG2[7:0]	RSVD	RSVD	SD1_SS RAMP	RSVD	RSVD	SD0FSR EN	SD0ADD IS	SD0FPW MEN	
0x47	SD1_CNFG3[7:0]	SD1_BO	_THR[1:0]	SD1_BO	_HYS[1:0]	RSVD	SD1_BO	_PR[1:0]	SD1_OV _THR	
0x48	SD2_CNFG2[7:0]	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	SD2ADD IS	SD2FPW MEN	
0x49	SD2_CNFG3[7:0]	SD2_BO	_THR[1:0]	SD2_BO_	_HYS[1:0]	RSVD	SD2_BO	_PR[1:0]	SD2_OV _THR	
0x4A	SD3_CNFG2[7:0]	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	SD3ADD IS	SD3FPW MEN	
0x4B	SD3_CNFG3[7:0]	SD3_BO	SD3_BO_THR[1:0] SD3_BO_HYS[1:0] RSVD SD3_						SD3_OV _THR	
			0	VERLAP						

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

LDO1UPSLT[2:0]

LDO2UPSLT[2:0]

LDO3UPSLT[2:0]

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

ADDRESS	NAME	MSB							LSB	
LDO										
0x50	LDO_CNFG1_L0[7:0]	RSVD	RSVD			VOUT_LD	O_L0[5:0]			
0x51	LDO_CNFG2_L0[7:0]	OVCLM P_EN_L 0	ALPM_E N_L0	RSVD	RSVD	POK_L0	RSVD	ADE_L0	SS_L0	
0x52	LDO_CNFG1_L1[7:0]	RSVD	RSVD			VOUT_LD	O_L1[5:0]			
0x53	LDO_CNFG2_L1[7:0]	OVCLM P_EN_L 1	ALPM_E N_L1	RSVD	RSVD	POK_L1	RSVD	ADE_L1	SS_L1	
0x54	LDO_CNFG1_L2[7:0]	RSVD	RSVD			VOUT_LD	O_L2[5:0]			
0x55	LDO_CNFG2_L2[7:0]	OVCLM P_EN_L 2	ALPM_E N_L2	COMP_	_L2[1:0]	POK_L2	RSVD	ADE_L2	SS_L2	
0x56	LDO_CNFG1_L3[7:0]	RSVD	RSVD			VOUT_LD	O_L3[5:0]			
0x57	LDO_CNFG2_L3[7:0]	OVCLM P_EN_L 3	ALPM_E N_L3	COMP_	_L3[1:0]	POK_L3	RSVD	ADE_L3	SS_L3	
0x58	LDO_CNFG1_L4[7:0]	RSVD	RSVD			VOUT_LD	O_L4[5:0]		·	
0x59	LDO_CNFG2_L4[7:0]	OVCLM P_EN_L 4	ALPM_E N_L4	COMP_	_L4[1:0]	POK_L4	RSVD	ADE_L4	SS_L4	
0x5A	LDO_CNFG1_L5[7:0]	RSVD	RSVD			VOUT_LD	·			
0x5B	LDO_CNFG2_L5[7:0]	OVCLM P_EN_L 5	ALPM_E N_L5	COMP_	_L5[1:0]	POK_L5	RSVD	ADE_L5	SS_L5	
0x5C	LDO_CNFG1_L6[7:0]	RSVD	RSVD			VOUT_LD	VOUT_LDO_L6[5:0]			
0x5D	LDO_CNFG2_L6[7:0]	OVCLM P_EN_L 6	ALPM_E N_L6	COMP_	_L6[1:0]	POK_L6	RSVD	ADE_L6	SS_L6	
0x5E	LDO_CNFG1_L7[7:0]	RSVD	RSVD			VOUT_LD	O_L7[5:0]			
0x5F	LDO_CNFG2_L7[7:0]	OVCLM P_EN_L 7	ALPM_E N_L7	COMP_	_L7[1:0]	POK_L7	RSVD	ADE_L7	SS_L7	
0x60	LDO_CNFG1_L8[7:0]	RSVD	RSVD			VOUT_LD	O_L8[5:0]			
0x61	LDO_CNFG2_L8[7:0]	OVCLM P_EN_L 8	ALPM_E N_L8	RSVI	D[1:0]	POK_L8	RSVD	ADE_L8	SS_L8	
0x62	LDO_CNFG3[7:0]				RSVD[6:0]				L_B_EN	
			0	VERLAP						
GPIO						1				
0x70	CNFG_GPIO0[7:0]	-	20[1:0]	REFE_IRQ[1:0]		DO0	DI0	DIR0	PPDRV0	
0x71	CNFG_GPIO1[7:0]		C1[1:0]	REFE_IRQ[1:0]		DO1	DI1	DIR1	PPDRV1	
0x72	CNFG_GPIO2[7:0]	-	2[1:0]	REFE_IRQ[1:0]		DO2	DI2	DIR2	PPDRV2	
0x73	CNFG_GPIO3[7:0]		23[1:0]	REFE_IRQ[1:0]		DO3	DI3	DIR3	PPDRV3	
0x74	CNFG_GPIO4[7:0]		24[1:0]	REFE_IRQ[1:0]		DO4	DI4	DIR4	PPDRV4	
0x75	CNFG_GPIO5[7:0]		25[1:0]	REFE_IRQ[1:0]		DO5	DI5	DIR5	PPDRV5	
0x76	CNFG_GPIO6[7:0]	-	26[1:0]		RQ[1:0]	DO6	DI6	DIR6	PPDRV6	
0x77	CNFG_GPI07[7:0]	DBNC	27[1:0]	REFE_I	RQ[1:0]	DO7	DI7	DIR7	PPDRV7	

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

ADDRESS	NAME	MSB							LSB		
0x78	PUE_GPIO[7:0]	PUE7	PUE6	PUE5	PUE4	PUE3	PUE2	PUE1	PUE0		
0x79	PDE_GPI0[7:0]	PDE7	PDE6	PDE5	PDE4	PDE3	PDE2	PDE1	PDE0		
0x7A	AME_GPIO[7:0]	AME7	AME6	AME5	AME4	AME3	AME2	AME1	AME0		
			0	VERLAP							
SBIAS											
0xB0	<u>CID0[7:0]</u>				SR	7:0]					
0xB1	<u>CID1[7:0]</u>				SR[[*]	15:8]					
0xB2	<u>CID2[7:0]</u>				SR[2	3:16]					
0xB3	<u>CID3[7:0]</u>		DIDN	/[3:0]			DIDO	D[3:0]			
0xB4	<u>CID4[7:0]</u>				DRV	'[7:0]					
BBC											
0x80	CNFG_BBC[7:0]	BBCR	S[1:0]	BBCLO WIEN	BBCV	′S[1:0]	BBCC	S[1:0]	BBCEN		
I2C											
0xC0	12C_CTRL1[7:0]	RSVD	RSVD	RSVD	PAIR	RSVD	RSVD	WD_EN	HS_EXT		
0xC1	12C_CTRL2[7:0]	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	I2CWP		

Register Details

INT_TOP (0x00)

BIT	7	6	5		4	3	2	1	0
Field	IRQ_GLE	IRQ_SD	IRQ_	LDO	IRQ_GPIO	IRQ_RTC	RSVD	IRQ_ONOF F	IRQ
Reset	0b0	0b0	0b	0	0b0	0b0	0b0	0b0	0b0
Access Type	Read On	ly Read Only	Read	Only	Read Only	Read Only	Read Only	Read Only	Read Only
BITFIEI	LD	BITS				DE	SCRIPTION		
IRQ_GLBL		7		0 = No unmasked interrupts pending in the INT_MBATTRST_TEMP register. 1 = There are unmasked interrupts pending in the INT_MBATTRST_TEMP register.					0
IRQ_SD		6		0 = No unmasked interrupts pending in the INT_LVL2_SD0_3 register. 1 = There are unmasked interrupts pending in the INT_LVL2_SD0_3 register.					
IRQ_LDO		5		INT_I 1 = T	LVL2_L8 regist here are unmas	er. sked interrupts			_7 and
IRQ_GPIO		4							
IRQ_RTC		3							er.
RSVD		2		Rese	rved. Unutilized	bit. Write to 0	. Reads are do	n't care.	
IRQ_ONOFF		1		DESCRIPTION 0 = No unmasked interrupts pending in the INT_MBATTRST_TEMP reg 1 = There are unmasked interrupts pending in the INT_MBATTRST_TE register. 0 = No unmasked interrupts pending in the INT_LVL2_SD0_3 register.					
IRQ		0			nmasked gate nmasked gate				

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

INT_MBATTRST_TEMP (0x01)

BIT	7	6	5		4	3	2	1	0
Field	RSVD	RSVD	RSV	D	RSVD	RSVD	MBATTRES ET_R	TJALRM1_ R	TJALRM2_ R
Reset	0b0	0b0	0b0)	0b0	0b0	0b0	0b0	0b0
Access Type	Read Onl	y Read Only	Read C	Dnly	Read Only	Read Only	Read Only	Read Only	Read Only
BITFIE	LD	BITS				DE	SCRIPTION		
RSVD		7		Rese	rved. Unutilized	d bit. Write to 0	. Reads are do	n't care.	
RSVD		6		Rese	rved. Unutilized	d bit. Write to 0	. Reads are do	n't care.	
RSVD		5		Rese	rved. Unutilized	d bit. Write to 0	. Reads are do	n't care.	
RSVD		4		Rese	rved. Unutilized	d bit. Write to 0	. Reads are do	n't care.	
RSVD		3		Rese	rved. Unutilized	d bit. Write to 0	. Reads are do	n't care.	
MBATTRESE	ſ_R	2		time t 1 = M	his bit was read IBATT has falle	d.	-		
TJALRM1_R		1							
TJALRM2_R		0		DESCRIPTION Reserved. Unutilized bit. Write to 0. Reads are don't care. Reserved. Unutilized bit. Write to 0. Reads are don't care. Reserved. Unutilized bit. Write to 0. Reads are don't care. Reserved. Unutilized bit. Write to 0. Reads are don't care. Reserved. Unutilized bit. Write to 0. Reads are don't care. Reserved. Unutilized bit. Write to 0. Reads are don't care. 0 = MBATT has not fallen below programmed MBATTRESET since the last time this bit was read. 1 = MBATT has fallen below programmed MBATTRESET since the last time this bit was read. 0 = T _J has not risen above TJALRM1 since the last time this bit was read. 0 = T _J has not risen above TJALRM21 since the last time this bit was read. 1 = T _J has risen above TJALRM21 since the last time this bit was read.					

INT_LVL2_ONOFF (0x02)

BIT	7	6	5		4	3	2	1	0
Field	RSVD	RSVD	ACO	K_R	ACOK_F	EN0_R	EN0_F	EN0_1SEC	MRWRN
Reset	0b0	0b0	0b	0	0b0	0b0	0b0	0b0	0b0
Access Type	Read Clears All	Read Clears All			Read Clears All				
BITFIEI	D	BITS				DE	SCRIPTION		
RSVD		7		Rese	rved. Unutilized	bit. Write to 0	. Reads are do	n't care.	
RSVD		6		Reserved. Unutilized bit. Write to 0. Reads are don't care.					
ACOK_R		5							
ACOK_F		4		Read Clears All DESCRIPTION Reserved. Unutilized bit. Write to 0. Reads are don't care.					
EN0_R		3							
EN0_F		2							
EN0_1SEC		1							

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
MRWRN	0	The time for the hard power off warning is one setting shorter than what is programmed by MRT[2:0]. When MRT[2:0] = 0b000, MRWRN is essentially a don't care. 0 = EN0 has not been active for MRT[2:0]-1 since the last time this bit was read. 1 = EN0 has been active for MRT[2:0]-1 since the last time this bit was read.

INT_LVL2_SD0_3 (0x03)

BIT	7	6	5		4	3	2	1	0
Field	SD0_OV_	I SD0_UV_I	SD1_	OV_I	SD1_UV_I	SD2_OV_I	SD2_UV_I	SD3_OV_I	SD3_UV_I
Reset	0b0	0b0	0b	0	0b0	0b0	0b0	0b0	0b0
Access Type	Read Clears All	Read Clears All	Rea Clear		Read Clears All	Read Clears All	Read Clears All	Read Clears All	Read Clears All
BITFIE	LD	BITS				DE	SCRIPTION		
SD0_OV_I		7		time t 1 = S	this bit was rea	d.	-		
SD0_UV_I		6		thres 1 = S	hold since the I D0 was enable	ast time this bit d and SD0 out	t was read, OR put HAS fallen	, SD1 was disa	abled.
SD1_OV_I		5		time t 1 = S	this bit was rea	d.	-		
SD1_UV_I		4		thres 1 = S	hold since the I D1 was enable	ast time this bit d and SD1 out	t was read, OR put HAS fallen	, SD1 was disa	abled.
SD2_OV_I		3		time t 1 = S	this bit was rea	d.	-		
SD2_UV_I		2		thres 1 = S	hold since the I D2 was enable	ast time this bi d and SD2 out	t was read, OR put HAS fallen	, SD2 was disa	abled.
SD3_OV_I		1		time t 1 = S	this bit was rea	d.	-		
SD3_UV_I		0		thres 1 = S	hold since the I D3 was enable	Ob0 Ob0			

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

INT_LVL2_L0_7 (0x04)

BIT	7	6	5		4	3	2	1	0	
Field	IRQ_LVL2 7	2_ IRQ_LVL2_ 6	IRQ_L 5	_	IRQ_LVL2_ 4	IRQ_LVL2_ 3	IRQ_LVL2_ 2	IRQ_LVL2_ 1	IRQ_LVL2_ 0	
Reset	0b0	0b0	0b	0	0b0	0b0	0b0	0b0	0b0	
Access Type	Read Onl	y Read Only	Read	Only	Read Only	Read Only	Read Only	Read Only	Read Only	
BITFIEI	LD	BITS				DE	SCRIPTION			
IRQ_LVL2_7		7			•			is register was	read.	
IRQ_LVL2_6		6		 1: An interrupt has occurred since the last time this register was read. 0: No interrupt has occurred since the last time this register was read. 						
IRQ_LVL2_5		5		0: No interrupt has occurred since the last time this register was read.1: An interrupt has occurred. Cleared when read.						
IRQ_LVL2_4		4		Read Only Read Only <t< td=""><td>read.</td></t<>					read.	
IRQ_LVL2_3		3			•			is register was	read.	
IRQ_LVL2_2		2			•			is register was	read.	
IRQ_LVL2_1		1			•			is register was	read.	
IRQ_LVL2_0		0		 An interrupt has occurred. Cleared when read. No interrupt has occurred since the last time this register was read. An interrupt has occurred. Cleared when read. No interrupt has occurred since the last time this register was read. An interrupt has occurred. Cleared when read. No interrupt has occurred. Cleared when read. No interrupt has occurred since the last time this register was read. An interrupt has occurred. Cleared when read. No interrupt has occurred. Cleared when read. An interrupt has occurred. Cleared when read. An interrupt has occurred since the last time this register was read. An interrupt has occurred. Cleared when read. No interrupt has occurred. Cleared when read. An interrupt has occurred. Cleared when read. An interrupt has occurred. Cleared when read. No interrupt has occurred. Cleared when read. No interrupt has occurred. Cleared when read. No interrupt has occurred. Cleared when read. An interrupt has occurred. Cleared when read. 						

INT_LVL2_L8 (0x05)

BIT	7	6	5		4	3	2	1	0
Field	RSVD	RSVD	RSV	/D	RSVD	RSVD	RSVD	RSVD	IRQ_LVL2_ 8
Reset	0b0	0b0	0b	0	0b0	0b0	0b0	0b0	0b0
Access Type	Read Onl	y Read Only	Read	Only	Read Only	Read Only	Read Only	Read Only	Read Only
BITFIEI	D	BITS				DE	SCRIPTION		
RSVD		7 Reserved. Unutilized bit. Write to 0. Reads are don't care.							
RSVD		6		Rese	rved. Unutilized	d bit. Write to 0	. Reads are do	n't care.	
RSVD		5		Rese	rved. Unutilized	d bit. Write to 0	. Reads are do	n't care.	
RSVD		4		Rese	rved. Unutilized	d bit. Write to 0	. Reads are do	n't care.	
RSVD		3		Rese	rved. Unutilized	d bit. Write to 0	. Reads are do	n't care.	
RSVD		2		Rese	rved. Unutilized	d bit. Write to 0	. Reads are do	n't care.	
RSVD		1		Reserved. Unutilized bit. Write to 0. Reads are don't care.					
IRQ_LVL2_8		0			n interrupt has o o interrupt has o			is register was	read.

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

INT_LVL2_GPIO (0x06)

BIT	7	6	5		4	3	2	1	0
Field	EDGE7	EDGE6	EDG	E5	EDGE4	EDGE3	EDGE2	EDGE1	EDGE0
Reset	0b0	0b0	0b	0	0b0	0b0	0b0	0b0	0b0
Access Type	Write, Read	Write, Read	Write,	Read	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read
BITFIE	LD	BITS				DE	SCRIPTION		
EDGE7		7		0 = N read. 1 = A since	x Edge Detecti o edges have b n edge corresp the last time th upt mask which	onding to REF	E_IRQx has be . Note that REI	en detected or	n GPIOx
EDGE6		6		0 = N read. 1 = A since	x Edge Detecti o edges have b n edge corresp the last time th upt mask which	onding to REF	E_IRQx has be . Note that REI	en detected or	n GPIOx
EDGE5		5		0 = N read. 1 = A since	x Edge Detecti o edges have b n edge corresp the last time th upt mask which	oeen detected onding to REF is bit was read	E_IRQx has be . Note that REI	een detected or	n GPIOx
EDGE4		4		0 = N read. 1 = A since	x Edge Detecti o edges have t n edge corresp the last time th upt mask which	oeen detected onding to REF is bit was read	E_IRQx has be . Note that REI	een detected or	n GPIOx
EDGE3		3		0 = N read. 1 = A since	x Edge Detecti o edges have t n edge corresp the last time th upt mask which	oeen detected onding to REF is bit was read	E_IRQx has be . Note that REI	een detected or	n GPIOx
EDGE2		2		0 = N read. 1 = A since	x Edge Detecti o edges have t n edge corresp the last time th upt mask which	oeen detected onding to REF is bit was read	E_IRQx has be . Note that REI	en detected or	n GPIOx
EDGE1		1		0 = N read. 1 = A since	x Edge Detecti o edges have t n edge corresp the last time th upt mask which	onding to REF	E_IRQx has be . Note that REI	en detected or	n GPIOx

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
EDGE0	0	 GPIOx Edge Detection Interrupt 0 = No edges have been detected on GPIOx since the last time this bit was read. 1 = An edge corresponding to REFE_IRQx has been detected on GPIOx since the last time this bit was read. Note that REFE_IRQx = 0b00 sets an interrupt mask which forces EDGEx to 0.

INT_TOPM (0x07)

BIT	7	6	5		4	3	2	1	0		
Field	IRQ_GLB M	L IRQ_SDM	IRQ_L	DOM	IRQ_GPIO M	IRQ_RTCM	RSVD	IRQ_ONOF FM	GLBLM		
Reset	0b1	0b1	0b	1	0b1	0b1	0b0	0b1	0b1		
Access Type	Read Onl	y Read Only	Read	Only	Read Only	Read Only	Read Only	Read Only	Read Only		
BITFIE	LD	BITS				DES	ESCRIPTION				
IRQ_GLBLM		7		IRQ_GLBLM blocks the interrupts from the global resources (INTLBT regist from affecting the nIRQ pin. Be careful not to confuse IRQ_GLBLM with GLBLM. GLBLM blocks all interrupts from affecting the nIRQ pin. 0 = Unmasked 1 = Masked					.M with		
IRQ_SDM		6		0 = Unmasked 1 = Masked							
IRQ_LDOM		5		1 = Masked 0 = Unmasked 1 = Masked							
IRQ_GPIOM		4			nmasked lasked						
IRQ_RTCM		3			nmasked lasked						
RSVD		2		Rese	rved. Unutilized	d bit. Write to 0	. Reads are do	n't care.			
IRQ_ONOFFM	1	1			nmasked lasked						
GLBLM		0		(INT_ to con affect 0 = U		EMP register)	from affecting f	resources the nIRQ pin. B cks all interrupt			

INTM_MBATTRST_TEMP (0x08)

BIT	7	6	5		4	3	2	1	0
Field	RSVD	RSVD	RSVD)	RSVD	RSVD	MBATTRES ETM	TJALRM1M	TJALRM2M
Reset	0b0	0b0	0b0		0b0	0b0	0b1	0b1	0b1
Access Type	Read Only	Read Only	Read Or	nly	Read Only	Read Only	Read Only	Read Only	Read Only
BITFIEI	LD	BITS				DES	SCRIPTION		
RSVD		7	F	Reserved. Unutilized bit. Write to 0. Reads are don't care.					
RSVD		6	F	Rese	ved. Unutilized	d bit. Write to 0	. Reads are do	n't care.	

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
RSVD	5	Reserved. Unutilized bit. Write to 0. Reads are don't care.
RSVD	4	Reserved. Unutilized bit. Write to 0. Reads are don't care.
RSVD	3	Reserved. Unutilized bit. Write to 0. Reads are don't care.
MBATTRESETM	2	0 = Unmasked 1 = Masked
TJALRM1M	1	0 = Unmasked 1 = Masked
TJALRM2M	0	0 = Unmasked 1 = Masked

INTM_ONOFF (0x09)

BIT	7	6	5		4	3	2	1	0			
Field	RSVD	RSVD	ACOK HI		ACOK_LO WM	EN0_RM	EN0_FM	EN0_1SEC M	MRWRNM			
Reset	0b0	0b0	0b	1	0b1	0b1	0b1	0b1	0b1			
Access Type	Read Only	Read Only	Read	Only	Read Only	Read Only	Read Only	Read Only	Read Only			
BITFIEI	D	BITS			DESCRIPTION							
RSVD		7		Rese	rved. Unutilized	d bit. Write to 0	. Reads are do	n't care.				
RSVD		6			Reserved. Unutilized bit. Write to 0. Reads are don't care.							
ACOK_HIGHM	I	5		0 = Unmasked 1 = Masked								
ACOK_LOWM		4		0 = Unmasked 1 = Masked								
EN0_RM		3		0 = Unmasked 1 = Masked								
EN0_FM		2		0 = Unmasked 1 = Masked								
EN0_1SECM		1		0 = Unmasked 1 = Masked								
MRWRNM		0		0 = Unmasked 1 = Masked								

INTM_SD0_3 (0x0A)

BIT	7	6	5		4	3	2	1	0
Field	SD0_OV_N	I SD0_UV_M	SD1_C	DV_M	SD1_UV_M	SD2_OV_M	SD2_UV_M	SD3_OV_M	SD3_UV_M
Reset	0b1	0b1	0b	1	0b1	0b1	0b1	0b1	0b1
Access Type	Write, Read	d Write, Read	Write, I	Read	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read
BITFIE	LD	BITS		DESCRIPTION					
SD0_OV_M		7		0 = During an output over-voltage event, SD0_OV_I is set to 1. nIRQ is driven low due to an output over-voltage event. 1 = During an output over-voltage event, SD0_OV_I is set to 1. nIRQ is not driven low due to an output over-voltage event.					

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
SD0_UV_M	6	 0 = During an output under-voltage event, SD0_UV_I is set to 1. nIRQ is driven low due to an output under-voltage event. 1 = During an output under-voltage event, SD0_UV_I is set to 1. nIRQ is not driven low due to an output under-voltage event.
SD1_OV_M	5	 0 = During an output over-voltage event, SD1_OV_I is set to 1. nIRQ is driven low due to an output over-voltage event. 1 = During an output over-voltage event, SD1_OV_I is set to 1. nIRQ is not driven low due to an output over-voltage event.
SD1_UV_M	4	 0 = During an output under-voltage event, SD1_UV_I is set to 1. nIRQ is driven low due to an output under-voltage event. 1 = During an output under-voltage event, SD1_UV_I is set to 1. nIRQ is not driven low due to an output under-voltage event.
SD2_OV_M	3	 0 = During an output over-voltage event, SD2_OV_I is set to 1. nIRQ is driven low due to an output over-voltage event. 1 = During an output over-voltage event, SD2_OV_I is set to 1. nIRQ is not driven low due to an output over-voltage event.
SD2_UV_M	2	0 = During an output under-voltage event, SD2_UV_I is set to 1. nIRQ is driven low due to an output under-voltage event. 1 = During an output under-voltage event, SD2_UV_I is set to 1. nIRQ is not driven low due to an output under-voltage event.
SD3_OV_M	1	0 = During an output over-voltage event, SD3_OV_I is set to 1. nIRQ is driven low due to an output over-voltage event. 1 = During an output over-voltage event, SD3_OV_I is set to 1. nIRQ is not driven low due to an output over-voltage event.
SD3_UV_M	0	0 = During an output under-voltage event, SD3_UV_I is set to 1. nIRQ is driven low due to an output under-voltage event. 1 = During an output under-voltage event, SD3_UV_I is set to 1. nIRQ is not driven low due to an output under-voltage event.

INT_MSK_L0_7 (0x0B)

BIT	7	6 5			4	3	2	1	0		
Field	IRQ_MSK_ L7	IRQ_MSK_ L6			IRQ_MSK_ L4	IRQ_MSK_ L3	IRQ_MSK_ L2	IRQ_MSK_ L1	IRQ_MSK_ L0		
Reset	0b1	0b1	0b	1	0b1	0b1	0b1	0b1	0b1		
Access Type	Write, Read	Write, Read	Write,	Read	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read		
BITFIEI	D	BITS				DE	SCRIPTION				
IRQ_MSK_L7		7			1: Interrupt is masked and nIRQ is not driven low due to an LDO event.						
				0: Interrupt is unmasked.							
IRQ MSK L6		6		1: Interrupt is masked and nIRQ is not driven low due to an LDO event.							
		-		0: Interrupt is unmasked.							
IRQ MSK L5		5		1: Interrupt is masked and nIRQ is not driven low due to an LDO event.							
		5		0: Interrupt is unmasked.							
IRQ MSK L4				1: Interrupt is masked and nIRQ is not driven low due to an LDO event.							
		4		0: Interrupt is unmasked.							
IRQ MSK L3		3		1: Interrupt is masked and nIRQ is not driven low due to an LDO event.							
		5		0: Interrupt is unmasked.							

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
	2	1: Interrupt is masked and nIRQ is not driven low due to an LDO event.
IRQ_MSK_L2	2	0: Interrupt is unmasked.
	1	1: Interrupt is masked and nIRQ is not driven low due to an LDO event.
IRQ_MSK_L1		0: Interrupt is unmasked.
	٥	1: Interrupt is masked and nIRQ is not driven low due to an LDO event.
IRQ_MSK_L0	0	0: Interrupt is unmasked.

INT_MSK_L8 (0x0C)

BIT	7	6	5		4	3	2	1	0		
Field	RSVD	RSVD	RSV	/D	RSVD	RSVD	RSVD	RSVD	IRQ_MSK_ L8		
Reset	0b0	0b0	0b(0	0b0	0b0	0b0	0b0	0b1		
Access Type	Write, Rea	d Write, Read	Write, I	Read	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read		
BITFIE	LD	BITS		DESCRIPTION							
RSVD		7		Reserved. Unutilized bit. Write to 0. Reads are don't care.							
RSVD		6		Reserved. Unutilized bit. Write to 0. Reads are don't care.							
RSVD		5		Reserved. Unutilized bit. Write to 0. Reads are don't care.							
RSVD		4		Reserved. Unutilized bit. Write to 0. Reads are don't care.							
RSVD		3		Reserved. Unutilized bit. Write to 0. Reads are don't care.							
RSVD		2		Reserved. Unutilized bit. Write to 0. Reads are don't care.							
RSVD		1		Reserved. Unutilized bit. Write to 0. Reads are don't care.							
IRQ_MSK_L8		0		 1: Interrupt is masked and nIRQ is not driven low due to an LDO event. 0: Interrupt is unmasked. 							

STAT_MBATTRST_TEMP (0x0D)

BIT	7	6	5		4	3	2	1	0			
Field	RSVD	RSVD	RS۱	/D	RSVD	RSVD	MBATTRES ET_S	TJALRM1	TJALRM2			
Reset	0b0	0b0	0b	0	0b0	0b0	0b0	0b0	0b0			
Access Type	Read On	y Read Only	Read	Only	Read Only	Read Only	Read Only	Read Only	Read Only			
BITFIEI	LD	BITS		DESCRIPTION								
RSVD		7		Rese	Reserved. Unutilized bit. Write to 0. Reads are don't care.							
RSVD		6		Reserved. Unutilized bit. Write to 0. Reads are don't care.								
RSVD		5		Reserved. Unutilized bit. Write to 0. Reads are don't care.								
RSVD		4		Reserved. Unutilized bit. Write to 0. Reads are don't care.								
RSVD		3		Reserved. Unutilized bit. Write to 0. Reads are don't care.								
MBATTRESET	_s	2		0 = V _{MBATT} > V _{MBATTRESET} 1 = V _{MBATT} < V _{MBATTRESET}								
TJALRM1		1		$0 = T_J < TJ120$ $1 = T_J > TJ120$								

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
TJALRM2	0	$0 = T_J < TJ140$ 1 = T_J > TJ140

STAT_ONOFF (0x0E)

BIT	7	6	5	;	4	3	2	1	0		
Field	RSVD	RSVD	RS	VD	RSVD	RSVD	RSVD	EN0	ACOK		
Reset	0b0	0b0	0b	0	0b0	0b0	0b0	0b0	0b0		
Access Type	Read Only	Read Only	Read	Only	Read Only	Read Only	Read Only	Read Only	Read Only		
BITFIE	LD	BITS				DE	SCRIPTION				
RSVD		7		Rese	rved. Unutilized	d bit. Write to 0	. Reads are do	n't care.			
RSVD		6		Rese	rved. Unutilized	d bit. Write to 0	. Reads are do	n't care.			
RSVD		5		Rese	rved. Unutilized	d bit. Write to 0	. Reads are do	n't care.			
RSVD		4		Reserved. Unutilized bit. Write to 0. Reads are don't care.							
RSVD		3		Reserved. Unutilized bit. Write to 0. Reads are don't care.							
RSVD		2		Rese	rved. Unutilized	d bit. Write to 0	. Reads are do	n't care.			
ENO		1			DTP_ENOAL = (N0 is not active N0 is active (lo DTP_ENOAL = 7 N0 is not active N0 is active (lo	e (logic low). gic high). 1 e (logic high).					
ACOK		0			For OTP_ACOKAL = 0 0 = ACOK is not active (logic low). 1 = ACOK is active (logic high). For OTP_ACOKAL = 1 0 = ACOK is not active (logic high). 1 = ACOK is active (logic low).						

POERC0 (0x10)

BIT	7		6	5		4	3	2	1	0		
Field	RSTIN		MBU	MB	0	MBLSD	TOVLD	HDRST	WTCHDG	SHDN		
Reset	0b0		0b0	0b	0	0b0	0b0	0b0	0b0	0b0		
Access Type	Read On	ıly	Read Only	Read	Only	Read Only	Read Only	Read Only	Read Only	Read Only		
BITFIE	LD	BITS				DESCRIPTION						
RSTIN			7		0 = The reset input signal (RSI) did not cause a global shutdown. 1 = The reset input signal (RSI) caused a global shutdown.							
MBU		6			0 = Main battery undervoltage event did not cause a global shutdown. 1 = The main battery caused a global shutdown by falling below its UVLO threshold ($V_{MBATT} < V_{MBATTUVLO}$). If the sudden momentary power loss (SMPL) function is enabled, the PMIC can automatically recover from a momentary power loss.							

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
МВО	5	0 = Main battery overvoltage event did not cause a global shutdown. 1 = The main battery caused a global shutdown by rising above its OVLO threshold ($V_{MBATT} < V_{MBATTOVLO}$).
MBLSD	4	0 = Main battery low did not cause a global shutdown. 1 = Main battery low caused a global shutdown because MBLPD is set and V _{MBATT} < V _{MBATTRESET} .
TOVLD	3	0 = The junction temperature did not cause a global shutdown. 1 = The junction temperature caused a global shutdown by rising above T_JSHDN .
HDRST	2	0 = The hard-reset function did not cause a global shutdown.1 = The hard-reset function caused a global shutdown.
WTCHDG	1	0 = The system watchdog timer did not cause a global shutdown.1 = The system watchdog timer caused a global shutdown.
SHDN	0	0 = The shutdown pin did not cause a global shutdown.1 = The shutdown pin caused a global shutdown.

POERC1 (0x11)

BIT	7	6	5		4	3	2	1	0			
Field	RSVD	RSVD	RSVD RSV		RSVD	RSVD	RSVD	32K_OK	BRDY_OK			
Reset	0b0	0b0		0	0b0	0b0	0b0	0b0	0b0			
Access Type	Write Clea All, Read		Write C All, R		Write Clears All, Read	Write Clears All, Read	Write Clears All, Read	Write Clears All, Read	Write Clears All, Read			
BITFIELD BITS			DESCRIPTION									
RSVD		7			Reserved. Unutilized bit. Write to 0. Reads are don't care.							
RSVD		6			Reserved. Unutilized bit. Write to 0. Reads are don't care.							
RSVD		5	Reserved. Unutilized bit. Write to 0. Reads are don't care.									
RSVD		4	Reserved. Unutilized bit. Write to 0. Reads are don't care.									
RSVD		3			Reserved. Unutilized bit. Write to 0. Reads are don't care.							
RSVD		2			Reserved. Unutilized bit. Write to 0. Reads are don't care.							
32К_ОК		1			Write 1 to clear 0 = The 32kHz oscillator did not cause a global shutdown. 1 = The 32kHz oscillator caused a global shutdown.							
BRDY_OK	ру_ок 0			Write 1 to clear 0 = The BRDY did not cause a global shutdown. 1 = The BRDY caused a global shutdown.								

<u>STAT_SD0_3 (0x20)</u>

BIT	7	6	5		4	3	2	1	0
Field	SD0_OV_S	SD0_UV_S	SD1_OV_S		SD1_UV_S	SD2_OV_S	SD2_UV_S	SD3_OV_S	SD3_UV_S
Reset	0b0	0b0	0b0		0b0	0b0	0b0	0b0	0b0
Access Type	Read Only	Read Only	Read Only		Read Only				
BITFIELD		BITS		DESCRIPTION					
SD0_OV_S		7		0 = SD0 output HAS NOT risen above the rising OV threshold. 1 = SD0 output HAS risen above the rising OV threshold.					

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
SD0_UV_S	6	 0 = SD0 is enabled and SD1 output HAS NOT fallen below the falling UV threshold OR, SD0 is disabled. 1 = SD0 is enabled and SD1 output HAS fallen below the falling UV threshold.
SD1_OV_S	5	0 = SD1 output HAS NOT risen above the rising OV threshold.1 = SD1 output HAS risen above the rising OV threshold.
SD1_UV_S	4	 0 = SD1 is enabled and SD1 output HAS NOT fallen below the falling UV threshold OR, SD1 is disabled. 1 = SD1 is enabled and SD1 output HAS fallen below the falling UV threshold.
SD2_OV_S	3	0 = SD2 output HAS NOT risen above the rising OV threshold.1 = SD2 output HAS risen above the rising OV threshold.
SD2_UV_S	2	 0 = SD2 is enabled and SD2 output HAS NOT fallen below the falling UV threshold OR, SD2 is disabled. 1 = SD2 is enabled and SD2 output HAS fallen below the falling UV threshold.
SD3_OV_S	1	0 = SD3 output HAS NOT risen above the rising OV threshold.1 = SD3 output HAS risen above the rising OV threshold.
SD3_UV_S	0	 0 = SD3 is enabled and SD3 output HAS NOT fallen below the falling UV threshold OR, SD3 is disabled. 1 = SD3 is enabled and SD3 output HAS fallen below the falling UV threshold.

32K_STATUS (0x30)

BIT	7	6	5		4	3	2	1	0		
Field	RSVD	RSVD	SIOS	сок	хоѕсок	32KSOURC E	32KLOAD[1:0]		CRYSTAL_ CONFIG		
Reset	0b0	0b0	0b0		0b0	0b0	0b10		0b0		
Access Type	Read On	ly Read Only	Read	Only	Read Only	Read Only	Read Only		Read Only		
BITFIELD		BITS				DESCRIPTION					
RSVD		7		Reserved. Unutilized bit. Write to 0. Reads are don't care.							
RSVD		6		Reserved. Unutilized bit. Write to 0. Reads are don't care.							
SIOSCOK 5				Silicon Oscillator OK Indicator 0 = The silicon oscillator is disabled or the clock is not yet stable. 1 = The silicon oscillator is enabled and is generating a clock. During normal operation this bit is interchangeable with 32KSOURCE. The values may differ when transitioning between silicon and crystal oscillators.							
XOSCOK 4				Crystal Oscillator OK Indicator 0 = The crystal oscillator is not generating a valid clock. 1 = The crystal oscillator is generating a valid clock.							
32KSOURCE		3		Primary Source of Internal Oscillator 0 = XOSC is the primary source for 32kHz oscillator (silicon oscillator is used initially to get the PMIC up and running while the XOSC is settling). 1 = Silicon oscillator is used as the primary source for 32K oscillator.					ig).		
32KLOAD 2:1			Internal Crystal Load Capacitance 0b00 = None 0b01 = 10pF 0b10 = 12pF 0b11 = 22pF								

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
CRYSTAL_CONFIG		Primary Oscillator Clock Source Indicator 0 = Normal mode. Oscillator is generating the clock from a crystal on XIN and XOUT or silicon oscillator. 1 = Bypass mode. Oscillator is deriving the clock from an external clock driving XIN.

32K_CONFIG (0x31)

BIT	7	6	5		4	3	2	1	0
Field	RSVD	RSVD	RSV	'D	XOSC_RET RY	RSVD	PWR_MD_32k[1:0]		32KSOURC E_OTP
Reset	0b0	0b0	0bC)	0b1	0b0	0	TP	OTP
Access Type	Write, Read	Write, Read	Write, Read		Write, Read	Write, Read	Write,	Read	Write, Read
BITFIE	LD	BITS		DESCRIPTION					
RSVD		7		Reserved. Unutilized bit. Write to 0. Reads are don't care.					
RSVD		6	Reserved. Unutilized bit. Write to 0. Reads are don't care.						
RSVD		5 Reserved. Unutilized bit. Write to 0. Reads are don't care.							
XOSC_RETRY 4				Crystal Oscillator Retry When the system is operating with the backup silicon oscillator and the crystal oscillator is stable (XOSCOK = 1), setting this bit causes the system to switch back to the crystal oscillator. If the crystal oscillator is not stable (XOSCOK = 0) or the system is already using the crystal oscillator, setting this bit has no effect. This bit clears after the operation is complete.					
RSVD		3		Reserved. Unutilized bit. Write to 0. Reads are don't care.					
PWR_MD_32k 2:1 32kHz Oscillator Mode of Operation 0b00 = Low-power mode 0b01 = Global low-power mode. The oscillator operates in low-ji when the global low-power mode signal is low. When the global mode signal is high, the oscillator operates in low-power mode. 0b10 = Same as 0b00 0b11 = Low-jitter mode									
32KSOURCE_OTP 0				Primary Source of Internal Oscillator 0 = XOSC is the primary source for 32kHz oscillator (silicon oscillator is used initially to get the PMIC up and running while the XOSC is settling) 1 = Silicon oscillator is used as the primary source for 32kHz oscillator					

CNFG_GLBL1 (0x90)

BIT	7	6	5	4	3	2	1	0
Field	RSVD	MBLPD	MBATT_RES	SET_HYS[1:0]	ME	MBATT_RS TEN		
Reset	0b0	OTP	0	TP		OTP		
Access Type	Write, Read	Write, Read	Write,	Read			Write, Read	
BITFIEI	LD	BITS			DESCRIPTION			
RSVD		7	Rese	rved. Unutilized	d bit. Write to 0	. Reads are do	n't care.	

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
MBLPD	6	0 = MBATT < MBATT_RESET falling (MBATTLOWB) does not cause a global shutdown. 1 = MBATT < MBATT_RESET falling (MBATTLOWB) forces a global shutdown.
MBATT_RESET_HYS	5:4	0x00 = 100mV 0x02 = 300mV 0x01 = 200mV 0x03 = 400mV
MBATT_RESET	3:1	0b000 = 2.7V 0b100 = 3.1V 0b001 = 2.8V 0b101 = 3.2V 0b010 = 2.9V 0b110 = 3.3V 0b011 = 3.0V 0b111 = 3.4V
MBATT_RSTEN	0	0 = The low-battery monitor only generates the MBATT < MBATT_RESET status bit and the MBATTRESET_R interrupt bit. 1 = In addition to the bits mentioned above, the low-battery monitor also pulls nRST_IO low.

CNFG_GLBL2 (0x91)

BIT	7	6	5	;	4	3	2	1	0
Field	RSVD	RSVD	RS	٧D	GLBL_LPM	WDTSLPC	WDTEN	TWD	[1:0]
Reset	0b0	0b0	0b	0	0b0	0b0	0b0	0b	11
Access Type	Write, Re	ad Write, Read	d Write, Read Write, Read Write, Read Write, Read Write, Read		Write,	Read			
BITFIE	LD	BITS		DESCRIPTION					
RSVD		7		Rese	rved. Unutilized	d bit. Write to 0	. Reads are do	n't care.	
RSVD		6		Rese	rved. Unutilized	d bit. Write to 0	. Reads are do	n't care.	
RSVD		5	5			d bit. Write to 0	. Reads are do	n't care.	
GLBL_LPM		4	 0 = The global low-power mode signal is logic low. Devices that have been programmed to follow the global low-power mode signal operates in their normal power modes. 1 = The global low-power mode signal is logic high. Devices that have been programmed to follow the global low-power mode signal operates in their low-power modes. 					s in their have been	
WDTSLPC		3	state.		-		-	-	
WDTEN		2		1 = The system watchdog timer automatically clears in the sleep state. 0 = System watchdog timer disabled 1 = System watchdog timer enabled If OTP_WDTEN = 0, then WDTEN can be changed at any time. If OTP_WDTEN = 1, then once WDTEN is set, the watchdog timer cannot disabled by clearing WDTEN. Once enabled, the system watchdog timer re until a global shutdown occurs.					

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
TWD	1:0	0b00 = 2s 0b01 = 16s 0b10 = 64s 0b11 = 128s If OTP_WDTT = 0, then TWD can be changed at any time. If the value of TWD needs to be changed, clear the system watchdog timer first (WDTC[1:0] = 0b01), then change the value of TWD.
		If OTP_WDTT = 1, then TWD can only be changed when WDTEN = 0.

CNFG_GLBL3 (0x92)

BIT	7	6	5	;	4	3	2	1	0			
Field	RSVD	RSVD	RS	٧D	SRCFPS0	ENFPS0	SRCFPS1	ENFPS1	WDTC			
Reset	0b0	0b0	0b	0	0b0	0b0	0b0	0b0	0b0			
Access Type	Write, Re	ad Write, Read	Write,	Read	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read			
BITFIE	FIELD BITS					DE	SCRIPTION					
RSVD		7			rved. Unutilized	bit. Write to 0	. Reads are do	n't care.				
RSVD		6		Rese	rved. Unutilized	bit. Write to 0	. Reads are do	n't care.				
RSVD		5		Reserved. Unutilized bit. Write to 0. Reads are don't care.								
SRCFPS0		4	0b0 = EN0 hardware input 0b1 = ENFPS0 software bit									
ENFPS0		3		0 = Disable FPS0 1 = Enable FPS0 ENFPS0 is a don't care if SRCFPS0 = 0								
SRCFPS1		2		0b0 = EN1 hardware input 0b1 = ENFPS1 software bit								
ENFPS1		1		0 = Disable FPS1 1 = Enable FPS1 ENFPS1 is a don't care if SRCFPS1 = 0					1 = Enable FPS1			
WDTC		0		Writing 0b1 to these bits clears the watchdog timer. These bits automatically reset to 0b0 after they are written to 0b1. 0b0 = The system watchdog timer is not cleared. 0b1 = The system watchdog timer is cleared.								

CNFG1_ONOFF (0x93)

BIT	7	6	5 4 3			2	1	0	
Field	RSVD	SFT_RST	MRT[2:0]			SLPEN	PWR_OFF	EN0DLY	
Reset	0b0	0x0	OTP			0b0	0b0	OTP	
Access Type	Write, Read	Write, Read	Write, Read			Write, Read	Write, Read	Write, Read	
BITFIEI	LD	BITS		DESCRIPTION					
RSVD		7	Re	Reserved. Unutilized bit. Write to 0. Reads are don't care.					

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
SFT_RST	6	0 = No action 1 = Generates a global shutdown event that initiates the FPS0 and FPS1 power-down event and generates a reset. If both SFT_RST and PWR_OFF are set, the resulting action is SFT_RST. This bit self clears at the end of the global shutdown event.
MRT	5:3	3b000 = 2s 3b001 = 3s 3b010 = 4s 3b011 = 5s 3b100 = 6s 3b101 = 8s 3b110 = 10s 3b111 = 12s
SLPEN	2	0 = Pulling EN1 low does not place the AP into sleep mode. 1 = Pulling EN1 low places the AP into sleep mode.
PWR_OFF	1	0 = No action 1 = Generates a global shutdown event that initiates the FPS0 and FPS1 power-down event but does not generate a reset. Note that PWR_OFF is cleared at the end of any global shutdown event that it generates.
EN0DLY	0	0 = The only delay for EN0 is the debounce circuit. 1 = In addition to the debounce circuit, there is an addition 1 second delay for EN0.

CNFG2_ONOFF (0x94)

BIT	7	6	5		4	3	2	1	0	
Field	MR_RST WK	SFT_RST WK	WD_F W	_	WK_ACOK	WK_MBAT T	WK_ALAR M1R	WK_ALAR M2R	WK_EN0	
Reset	OTP	0b1	0b	0	0b0	OTP	0b1	0b1	0b1	
Access Type	Write, Re	ad Write, Read	Write,	Read	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read	
BITFIEI	LD	BITS			DE	SCRIPTION				
MR_RST_WK		7	stand 1 = A	0 = An MR_RST event does not generate a wakeup signal (device resides in standby state). 1 = An MR_RST event generates a wakeup signal (device moves to ON state)".						
SFT_RST_WK		6		0 = An SFT_RST event does not generate a wakeup signal (device resides in standby state). 1 = An SFT_RST event generates a wakeup signal (device moves to ON state).						
WD_RST_WK		5		stand	n WD_RST eve lby state). n WD_RST eve).	-				
WK_ACOK		4	4		n ACOK event n ACOK event			signal.		
WK_MBATT		3	0 = A valid MBATT event does 1 = A valid MBATT event gener							
WK_ALARM1F	2	2			0 = An ALARM1_R event does not generate a wakeup signal. 1 = An ALARM1_R event generates a wakeup signal.					
WK_ALARM2F	2	1			0 = An ALARM2_R event does not generate a wakeup signal. 1 = An ALARM2_R event generates a wakeup signal.					

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
WK_EN0	0	0 = An EN0 event does not generate a wakeup signal. 1 = An EN0 event generates a wakeup signal.

<u>MSTR_PU_PD (0x95)</u>

BIT	7	6	5	4	3	2	1	0
Field	RSVD		MSTR_PU[2:0	J[2:0] RSVD MSTR_PD[2:0]				
Reset	0b0		OTP		0b0		OTP	
Access Type	Write, Re	ad	Write, Read		Write, Read	Write, Read		
BITFIE	LD	BITS	BITS DESCRIPTION					
RSVD		7	7 Reserved. Unutilized bit. Write to 0. Reads are don't care.					
MSTR_PU		6:4	3'b00 3'b01 3'b01 3'b10 3'b10 3'b10 3'b11	00 = 31µs 01 = 63µs 0 = 127µs 1 = 253µs 00 = 508µs 01 = 984µs 0 = 1936µs 1 = 3904µs				
RSVD		3	Rese	rved. Unutilize	d bit. Write to 0.	Reads are do	on't care.	
MSTR_PD		2:0	3'b00 3'b01 3'b01 3'b10 3'b10 3'b10 3'b11	3'b000 = 31µs 3'b001 = 63µs 3'b010 = 127µs 3'b011 = 253µs 3'b100 = 508µs 3'b101 = 984µs 3'b101 = 1936µs 3'b111 = 3904µs				

MSTR_SLPENTRY_EXIT (0x96)

BIT	7	6	5	4	3	2	1	0
Field	RSVD	MS	FR_SLPENTY	[2:0]	RSVD	MSTR_SLPEXT[2:0]		
Reset	0b0		OTP		0b0		OTP	
Access Type	Write, Rea	ad	Write, Read				Write, Read	
BITFIE	LD	BITS			DES	SCRIPTION		
RSVD		7	Rese	rved. Unutilized	d bit. Write to 0	. Reads are do	n't care.	
MSTR_SLPEN	ITY	6:4	3'b00 3'b01 3'b01 3'b10 3'b10 3'b10 3'b11	3'b000 = 31µs 3'b001 = 63µs 3'b010 = 127µs 3'b011 = 253µs 3'b100 = 508µs 3'b101 = 984µs 3'b110 = 1936µs 3'b111 = 3904µs				
RSVD		3	Rese	Reserved. Unutilized bit. Write to 0. Reads are don't care.				

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
MSTR_SLPEXT	2:0	3'b000 = 31µs 3'b001 = 63µs 3'b010 = 127µs 3'b011 = 253µs 3'b100 = 508µs 3'b101 = 984µs 3'b110 = 1936µs 3'b111 = 3904µs

BUCK_PWR_MD (0x97)

BIT	7	6	5	4	3	2	1	0
Field	PWR_M	D_SD3[1:0]	PWR_MI	D_SD2[1:0]	PWR_MD_SD1[1:0]		PWR_MD_SD0[1:0]	
Reset	(DTP	C	TP	0.	TP	0	ГР
Access Type	Write	e, Read	Write	, Read	Write,	Read	Write,	Read
BITFIEI	LD	BITS			DE	SCRIPTION		
PWR_MD_SD	3	7:6	0b01 0b10	0b00 = Output disabled 0b01 = Global low-power mode 0b10 = Forced low-power mode 0b11 = Forced normal-mode				
PWR_MD_SD2	2	5:4	0b01 0b10) = Output disab = Global low-p) = Forced low-p = Forced norm	ower mode oower mode			
PWR_MD_SD	PWR_MD_SD1 3:2		0b01 0b10	0b00 = Output disabled 0b01 = Global low-power mode 0b10 = Forced low-power mode 0b11 = Forced normal-mode				
PWR_MD_SD0 1:0 0b01 = 0b10 =) = Output disab = Global low-p) = Forced low-r = Forced norm	ower mode oower mode				

LDO_PWR_MD0_3 (0x98)

BIT	7	6	5	4	3	2	1	0
Field	PWR_MI	D_L0[1:0]	PWR_MD_L1[1:0]		PWR_MD_L2[1:0]		PWR_MD_L3[1:0]	
Reset	0	TP	0	TP	OTP		OTP	
Access Type	Write,	Read	Write,	Read	Write,	Read	Write, Read	

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
		 When FPSSRC_Lx[1:0] = 0b11 0b00 = Output disabled. LDOx is off. 0b01 = Group low-power mode. LDOx operates in normal mode when the global low-power mode signal is low. When the global low-power mode signal is high, LDOx operates in low-power mode. 0b10 = Low-power mode. LDOx is forced into low-power mode. The maximum load current is 5mA and the quiescent supply current is 1.5mA. 0b11 = Normal Mode. LDOx is forced into its normal operating mode.
PWR_MD_L0	7:6	When FPSSRC_Lx[1:0] ≠ 0b11 0b00 = Output disabled. LDOx is off. 0b01 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled when the flexible power sequencer is enabled. When LDOx is enabled, it operates in normal mode when the global low-power mode signal is low, and it operates in low-power mode when the global low-power mode signal is logic high. 0b10 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in low-power mode when the flexible power sequencer is enabled. 0b11 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in normal-power mode when the flexible power sequencer is enabled.
		When FPSSRC_Lx[1:0] = 0b11 0b00 = Output disabled. LDOx is off. 0b01 = Group low-power mode. LDOx operates in normal mode when the global low-power mode signal is low. When the global low-power mode signal is high, LDOx operates in low-power mode. 0b10 = Low-Power Mode. LDOx is forced into low-power mode. The maximum load current is 5mA and the quiescent supply current is 1.5mA. 0b11 = Normal mode. LDOx is forced into its normal operating mode.
PWR_MD_L1	5:4	When FPSSRC_Lx[1:0] ≠ 0b11 0b00 = Output disabled. LDOx is off. 0b01 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled when the flexible power sequencer is enabled. When LDOx is enabled, it operates in normal mode when the global low-power mode signal is low, and it operates in low-power mode when the global low-power mode signal is logic high. 0b10 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in low-power mode when the flexible power sequencer is enabled. 0b11 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in normal-power mode when the flexible power sequencer is enabled.

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
		 When FPSSRC_Lx[1:0] = 0b11 0b00 = Output disabled. LDOx is off. 0b01 = Group low-power mode. LDOx operates in normal mode when the global low-power mode signal is low. When the global low-power mode signal is high, LDOx operates in low-power mode. 0b10 = Low-Power Mode. LDOx is forced into low-power mode. The maximum load current is 5mA and the quiescent supply current is 1.5mA. 0b11 = Normal mode. LDOx is forced into its normal operating mode.
PWR_MD_L2	3:2	When FPSSRC_Lx[1:0] ≠ 0b11 0b00 = Output disabled. LDOx is off. 0b01 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled when the flexible power sequencer is enabled. When LDOx is enabled, it operates in normal mode when the global low-power mode signal is low, and it operates in low-power mode when the global low-power mode signal is logic high. 0b10 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in low-power mode when the flexible power sequencer is enabled. 0b11 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in normal-power mode when the flexible power sequencer is enabled.
PWR_MD_L3	1:0	When FPSSRC_Lx[1:0] = 0b11 0b00 = Output disabled. LDOx is off. 0b01 = Group low-power mode. LDOx operates in normal mode when the global low-power mode signal is low. When the global low-power mode signal is high, LDOx operates in low-power mode. 0b10 = Low-Power Mode. LDOx is forced into low-power mode. The maximum load current is 5mA and the quiescent supply current is 1.5mA. 0b11 = Normal mode. LDOx is forced into its normal operating mode. When FPSSRC_Lx[1:0] \neq 0b11 0b00 = Output disabled. LDOx is off. 0b01 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled when the flexible power sequencer
		is enabled. When LDOx is enabled, it operates in normal mode when the global low-power mode signal is low, and it operates in low-power mode when the global low-power mode signal is logic high. 0b10 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in low-power mode when the flexible power sequencer is enabled. 0b11 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in normal-power mode when the flexible power sequencer is enabled.

LDO_PWR_MD4_7 (0x99)

BIT	7	6	5	4	3	2	1	0
Field	PWR_MI	D_L4[1:0]	PWR_MD_L5[1:0]		PWR_MD_L6[1:0]		PWR_MD_L7[1:0]	
Reset	0	TP	0	TP	OTP		OTP	
Access Type	Write,	Read	Write,	Read	Write,	Read	Write,	Read

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
		When FPSSRC_Lx[1:0] = 0b11 0b00 = Output disabled. LDOx is off. 0b01 = Group low-power mode. LDOx operates in normal mode when the global low-power mode signal is low. When the global low-power mode signal is high, LDOx operates in low-power mode. 0b10 = Low-power mode. LDOx is forced into low-power mode. The maximum load current is 5mA and the quiescent supply current is 1.5mA. 0b11 = Normal mode. LDOx is forced into its normal operating mode.
PWR_MD_L4	7:6	When FPSSRC_Lx[1:0] ≠ 0b11 0b00 = Output disabled. LDOx is off. 0b01 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled when the flexible power sequencer is enabled. When LDOx is enabled, it operates in normal mode when the global low-power mode signal is low, and it operates in low-power mode when the global low-power mode signal is logic high. 0b10 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in low-power mode when the flexible power sequencer is enabled. 0b11 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in normal-power mode when the flexible power sequencer is enabled.
		When FPSSRC_Lx[1:0] = 0b11 0b00 = Output disabled. LDOx is off. 0b01 = Group low-power mode. LDOx operates in normal mode when the global low-power mode signal is low. When the global low-power mode signal is high, LDOx operates in low-power mode. 0b10 = Low-power mode. LDOx is forced into low-power mode. The maximum load current is 5mA and the quiescent supply current is 1.5mA. 0b11 = Normal mode. LDOx is forced into its normal operating mode.
PWR_MD_L5	5:4	When FPSSRC_Lx[1:0] \neq 0b11 0b00 = Output disabled. LDOx is off. 0b01 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled when the flexible power sequencer is enabled. When LDOx is enabled, it operates in normal mode when the global low-power mode signal is low, and it operates in low-power mode when the global low-power mode signal is logic high. 0b10 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in low-power mode when the flexible power sequencer is enabled. 0b11 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in low-power mode when the flexible power sequencer is enabled.

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
		When FPSSRC_Lx[1:0] = 0b11 0b00 = Output disabled. LDOx is off. 0b01 = Group low-power mode. LDOx operates in normal mode when the global low-power mode signal is low. When the global low-power mode signal is high, LDOx operates in low-power mode. 0b10 = Low-power mode. LDOx is forced into low-power mode. The maximum load current is 5mA and the quiescent supply current is 1.5mA. 0b11 = Normal mode. LDOx is forced into its normal operating mode.
PWR_MD_L6 3:2	3:2	When FPSSRC_Lx[1:0] ≠ 0b11 0b00 = Output disabled. LDOx is off. 0b01 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled when the flexible power sequencer is enabled. When LDOx is enabled, it operates in normal mode when the global low-power mode signal is low, and it operates in low-power mode when the global low-power mode signal is logic high. 0b10 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in low-power mode when the flexible power sequencer is enabled. 0b11 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in normal-power mode when the flexible power sequencer is enabled.
PWR_MD_L7	1:0	When FPSSRC_Lx[1:0] = 0b110b00 = Output disabled. LDOx is off.0b01 = Group low-power mode. LDOx operates in normal mode when theglobal low-power mode signal is low. When the global low-power mode signalis high, LDOx operates in low-power mode.0b10 = Low-power mode. LDOx is forced into low-power mode. Themaximum load current is 5mA and the quiescent supply current is 1.5mA.0b11 = Normal mode. LDOx is forced into its normal operating mode.When FPSSRC_Lx[1:0] \neq 0b110b00 = Output disabled. LDOx is off.0b01 = LDOx is disabled when the flexible power sequencer set by
		FPSSRC_Lx is disabled. LDOx is enabled when the flexible power sequencer is enabled. When LDOx is enabled, it operates in normal mode when the global low-power mode signal is low, and it operates in low-power mode when the global low-power mode signal is logic high. 0b10 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in low-power mode when the flexible power sequencer is enabled. 0b11 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in normal-power mode when the flexible power sequencer is enabled.

LDO_PWR_MD8 (0x9A)

BIT	7	6	6 5			4	3	2	1	0
Field	RSVD	RS	/D	RS\	/D	RSVD	RSVD	RSVD	PWR_MD_L8[1:0]	
Reset	0b0	0b	0	0b	0	0b0	0b0	0b0	OT	ſP
Access Type	Write, Re	ad Write,	Read	Write,	Read	Write, Read	Write, Read	Write, Read	Write,	Read
BITFIEI	LD	E	SITS				DES	SCRIPTION		
RSVD		7 Reserved. Unutilized bit. Write to 0. Reads are don't care.								
RSVD			6 Reserved. Unutilized bit. Write to 0. Reads are don't care.							

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
RSVD	5	Reserved. Unutilized bit. Write to 0. Reads are don't care.
RSVD	4	Reserved. Unutilized bit. Write to 0. Reads are don't care.
RSVD	3	Reserved. Unutilized bit. Write to 0. Reads are don't care.
RSVD	2	Reserved. Unutilized bit. Write to 0. Reads are don't care.
PWR_MD_L8	1:0	 When FPSSRC_Lx[1:0] = 0b11 0b00 = Output disabled. LDOx is off. 0b01 = Group low-power mode. LDOx operates in normal mode when the global low-power mode signal is low. When the global low-power mode signal is high, LDOx operates in low-power mode. 0b10 = Low-power Mode. LDOx is forced into low-power mode. The maximum load current is 5mA and the quiescent supply current is 1.5mA. 0b11 = Normal mode. LDOx is forced into its normal operating mode. When FPSSRC_Lx[1:0] ≠ 0b11 0b00 = Output disabled. LDOx is off. 0b01 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled when the flexible power sequencer is enabled. When LDOx is enabled, it operates in normal mode when the global low-power mode signal is logic high. 0b10 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled when the flexible power mode when the global low-power mode signal is logic high. 0b10 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in low-power mode when the flexible power sequencer is enabled. 0b11 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in low-power mode when the flexible power sequencer is enabled.

LDO0FPS (0x9B)

BIT	7	6	5	4	3	2	1	0	
Field	FPSSR	C_L0[1:0]	L	DO0UPSLT[2:0	[]	L	DO0DNSLT[2:0)]	
Reset	C	TP		OTP			OTP		
Access Type	Write	, Read		Write, Read			Write, Read		
BITFIEI	D	BITS			DE	SCRIPTION			
FPSSRC_L0		7:6	0b01 0b10 0b11	0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence: • The LDO enables are controlled by PWR_MD_Lx.					
LDO0UPSLT		5:3	3'b00 3'b01 3'b01 3'b10 3'b10 3'b10 3'b11	• The LDO enables are controlled by PWR_MD_Lx. 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7					

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
LDO0DNSLT	2:0	3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7

LDO1FPS (0x9C)

BIT	7	6	5	4	3	2	1	0	
Field	FPSSF	RC_L1[1:0]		LDO1UPSLT[2:0] LDO1DN				0]	
Reset	(ОТР		OTP			OTP		
Access Type	Writ	e, Read		Write, Read Write, Read					
BITFIE	D	BITS		DESCRIPTION					
FPSSRC_L1		7:6	0b01 0b10 0b11	0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence: • The LDO enables are controlled by PWR_MD_Lx.					
LDO1UPSLT		5:3 $3'b000 = Slot 0$ $3'b001 = Slot 1$ $3'b010 = Slot 2$ $3'b011 = Slot 3$ $3'b100 = Slot 4$ $3'b101 = Slot 5$ $3'b110 = Slot 6$ $3'b111 = Slot 7$							
LDO1DNSLT		2:0	3'b0 3'b0 3'b0 3'b1 3'b1 3'b1 3'b1	3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 2 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7					

LDO2FPS (0x9D)

BIT	7	6	5	4	3	2	1	0
Field	FPSSR	RC_L2[1:0]		DO2UPSLT[2:0	0]	L	DO2DNSLT[2:0)]
Reset	C	TP		OTP			OTP	
Access Type	Write	, Read		Write, Read Write, Read				
BITFIEI	LD	BITS			DE	SCRIPTION		
FPSSRC_L2	7:6 0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence: • The LDO enables are controlled by PWR_MD_Lx.							

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
LDO2UPSLT	5:3	3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7
LDO2DNSLT	2:0	3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7

LDO3FPS (0x9E)

BIT	7	6	5	4	3	2	1	0	
Field	FPSS	RC_L3[1:0]	L	LDO3UPSLT[2:0] LDO3DNSLT[2				0]	
Reset		OTP		OTP			OTP		
Access Type	Wri	te, Read		Write, Read Write, Read					
BITFIE	LD	BITS			DE	SCRIPTION			
FPSSRC_L3		7:6	0b01 0b10 0b11	0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence: • The LDO enables are controlled by PWR_MD_Lx.					
LDO3UPSLT	3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3								
LDO3DNSLT	-T 2:0 3'b111 = Slot 7 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b100 = Slot 2 3'b111 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6			3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5					

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

LDO4FPS (0x9F)

BIT	7	6	5	4	3	2	1	0	
Field	FPSS	RC_L4[1:0]	L	LDO4UPSLT[2:0] LDO)]	
Reset		OTP		OTP			OTP		
Access Type	Writ	te, Read		Write, Read Write, Read					
BITFIE	ELD BITS DESCRIPTION								
FPSSRC_L4		7:6	0b01 0b10 0b11	0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence: • The LDO enables are controlled by PWR_MD_Lx.					
LDO4UPSLT 5:3 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7				1 = Slot 1 0 = Slot 2 1 = Slot 3 0 = Slot 4 1 = Slot 5 0 = Slot 6					
LDO4DNSLT	$\frac{3'b000 = Slot 0}{3'b001 = Slot 1}$ $\frac{3'b010 = Slot 1}{3'b010 = Slot 2}$ $\frac{3'b011 = Slot 3}{3'b101 = Slot 3}$ $\frac{3'b101 = Slot 4}{3'b101 = Slot 5}$ $\frac{3'b110 = Slot 6}{3'b111 = Slot 7}$								

LDO5FPS (0xA0)

BIT	7	6	5	4	3	2	1	0	
Field	FPSSRO	PSSRC_L5[1:0]		LDO5UPSLT[2:0	0]	L	LDO5DNSLT[2:0]		
Reset	0	OTP		OTP			OTP		
Access Type	Write,	Read		Write, Read			Write, Read		
BITFIE	LD	BITS			DE	SCRIPTION			
FPSSRC_L5		7:6	0b01 0b10 0b11	0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence: • The LDO enables are controlled by PWR_MD_Lx.					
LDO5UPSLT 5:3				00 = Slot 0 01 = Slot 1 10 = Slot 2 11 = Slot 3 00 = Slot 4 01 = Slot 5 10 = Slot 6 11 = Slot 7					

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
LDO5DNSLT	2:0	3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7

LDO6FPS (0xA1)

BIT	7	6	5	4	3	2	1	0	
Field	FPSSF	RC_L6[1:0]	L	DO6UPSLT[2:0)]	LDO6DNSLT[2:0]			
Reset		OTP		OTP			OTP		
Access Type	Writ	e, Read	Write, Read Write, Read						
BITFIEI	LD	BITS	BITS DESCRIPTION						
FPSSRC_L6		7:6	0b01 0b10 0b11 • The	0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence: • The LDO enables are controlled by PWR_MD_Lx.					
LDO6UPSLT		5:3 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7							
LDO6DNSLT		2:0	3'b00 3'b01 3'b01 3'b10 3'b10 3'b10 3'b11	3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 2 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7					

LDO7FPS (0xA2)

BIT	7	6	5	4	3	2	1	0
Field	FPSSR	C_L7[1:0]	L	DO7UPSLT[2:0	0]	L	DO7DNSLT[2:0	0]
Reset	0	TP		OTP			OTP	
Access Type	Write	, Read		Write, Read Write, Read				
BITFIEI	D	BITS			DE	SCRIPTION		
FPSSRC_L7	L7 7:6 0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence: • The LDO enables are controlled by PWR_MD_Lx.							

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
LDO7UPSLT	5:3	3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7
LDO7DNSLT	2:0	3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7

LDO8FPS (0xA3)

BIT	7	6	5	4	3	2	1	0	
Field	FPSS	RC_L8[1:0]	L	LDO8UPSLT[2:0] LDO8DNSLT[2				0]	
Reset		OTP		OTP			OTP		
Access Type	Wri	ite, Read		Write, Read Write, Read					
BITFIE	LD	BITS			DI	SCRIPTION			
FPSSRC_L8		7:6	0b01 0b10 0b11	0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence: • The LDO enables are controlled by PWR_MD_Lx.					
LDO8UPSLT	3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3								
LDO8DNSLT		2:0	3'b00 3'b01 3'b01 3'b10 3'b10 3'b10 3'b11	3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 2 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7					

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

SD0FPS (0xA4)

BIT	7	6	5	4	3	2	1	0
Field	FPSSF	RC_SD0[1:0]		SD0UPSLT[2:0	5	SD0DNSLT[2:0]		
Reset		OTP		OTP			OTP	
Access Type	Wri	ite, Read		Write, Read Write, Read				
BITFIE	LD	BITS			DE	SCRIPTION		
FPSSRC_SD0 7:6			0b01 0b10	0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence.				
SDOUPSLT	3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3							
SD0DNSLT 2:0			3'b00 3'b01 3'b01 3'b10 3'b10 3'b10 3'b11	00 = Slot 0 01 = Slot 1 10 = Slot 2 11 = Slot 3 00 = Slot 4 01 = Slot 5 10 = Slot 6 11 = Slot 7				

SD1FPS (0xA5)

BIT	7	6	5	5 4 3 2 1				0	
Field	FPSSRC	SSRC_SD1[1:0]		SD1UPSLT[2:0]		SD1DNSLT[2:0]		
Reset	0	OTP		OTP			OTP		
Access Type	Write, Read			Write, Read			Write, Read		
BITFIEI	D	BITS		DESCRIPTION					
FPSSRC_SD1		7:6		0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence.					
SD1UPSLT 5:3 3 3 3 3 3 3 3 3 3 3			3'b00 3'b01 3'b01 3'b10 3'b10 3'b10 3'b11	00 = Slot 0 01 = Slot 1 0 = Slot 2 1 = Slot 3 00 = Slot 4 01 = Slot 5 0 = Slot 6 1 = Slot 7					

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
SD1DNSLT	2:0	3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7

SD2FPS (0xA6)

BIT	7	6	5	4	3	2	1	0		
Field	FPSSF	RC_SD2[1:0]		SD2UPSLT[2:0]			SD2DNSLT[2:0]			
Reset		OTP		OTP			OTP			
Access Type	Wri	ite, Read		Write, Read Write, Read						
BITFIE	LD	BITS			DI	SCRIPTION				
FPSSRC_SD2		7:6	0b01 0b10	0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence.						
SD2UPSLT		5:3	3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7							
SD2DNSLT		2:0	3'b0 3'b0 3'b0 3'b1 3'b1 3'b1 3'b1	00 = Slot 0 01 = Slot 1 10 = Slot 2 11 = Slot 3 00 = Slot 4 01 = Slot 5 10 = Slot 6 11 = Slot 7						

SD3FPS (0xA7)

BIT	7	6	5	4	3	2	1	0		
Field	FPSSRO	SSRC_SD3[1:0]		SD3UPSLT[2:0)]		SD3DNSLT[2:0]			
Reset	()ТР		OTP			OTP			
Access Type	Write	e, Read		Write, Read	Write, Read					
BITFIEI	LD	BITS			DE	SCRIPTION				
FPSSRC_SD3 7:6			Ob Ob	0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence.						

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
SD3UPSLT	5:3	3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7
SD3DNSLT	2:0	3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7

GPIO0FPS (0xA8)

BIT	7	6	5	4	3	2	1	0	
Field	FPSSR	C_GPIO0[1:0]	Ģ	SPIO0UPSLT[2:	0]	G	GPIO0DNSLT[2:0]		
Reset		OTP		OTP			OTP		
Access Type	Wr	ite, Read		Write, Read Write, Read					
BITFIE	LD	BITS			DI	ESCRIPTION			
FPSSRC_GPIO0 7:6			0b01 0b10	0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence.					
GPIO0UPSLT	3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3								
GPIO0DNSLT		2:0	3'b0(3'b0' 3'b1(3'b1(3'b1(3'b1)	00 = Slot 0 01 = Slot 1 10 = Slot 2 11 = Slot 3 00 = Slot 4 01 = Slot 5 10 = Slot 6 11 = Slot 7					

GPIO1FPS (0xA9)

BIT	7	6	5	4	3	2	1	0
Field	FPSSRC_	GPIO1[1:0]	GPIO1UPSLT[2:0]			GPIO1DNSLT[2:0]		
Reset	OTP			OTP		OTP		
Access Type	Write,	Read		Write, Read		Write, Read		

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
FPSSRC_GPI01	7:6	0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence.
GPIO1UPSLT	5:3	3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7
GPIO1DNSLT	2:0	3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7

GPIO2FPS (0xAA)

BIT	7	6	5	4	3	2	1	0		
Field	FPSSRC	_GPIO2[1:0]	G	PIO2UPSLT[2:	0]	G	GPIO2DNSLT[2:0]			
Reset	(OTP		OTP			OTP			
Access Type	Write	e, Read		Write, Read Write, Read						
BITFIE	LD	BITS			DE	SCRIPTION				
FPSSRC_GPIO2 7:6			0b01 0b10	0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence.						
GPIO2UPSLT	3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3									
GPIO2DNSLT 2:0			3'b00 3'b01 3'b01 3'b10 3'b10 3'b10 3'b11	0 = Slot 0 1 = Slot 1 0 = Slot 2 1 = Slot 3 0 = Slot 4 1 = Slot 5 0 = Slot 6 1 = Slot 7						

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

GPIO7FPS (0xAB)

BIT	7	6	5	4	3	2	1	0	
Field	FPSSRC	C_GPIO7[1:0]	G	PIO7UPSLT[2:	0]	GPIO7DNSLT[2:0]			
Reset		OTP		OTP			OTP		
Access Type	Writ	te, Read		Write, Read			Write, Read		
BITFIE	LD	BITS			DE	SCRIPTION			
FPSSRC_GPI	7:6	0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence.							
GPIO7UPSLT 5:3			3'b00 3'b01 3'b01 3'b10 3'b10 3'b10 3'b11	0 = Slot 0 1 = Slot 1 0 = Slot 2 1 = Slot 3 0 = Slot 4 1 = Slot 5 0 = Slot 6 1 = Slot 7					
GPIO7DNSLT 2:0			3'b00 3'b01 3'b01 3'b10 3'b10 3'b10 3'b11	0 = Slot 0 1 = Slot 1 0 = Slot 2 1 = Slot 3 0 = Slot 4 1 = Slot 5 0 = Slot 6 1 = Slot 7					

RSTIOFPS (0xAC)

BIT	7	6	5	4	5 4 3 2 1				
Field	FPSSRC_	SRC_RSTIO[1:0]		RST7UPSLT[2:0)]	F	RST7DNSLT[2:0]		
Reset	0	OTP		OTP			OTP		
Access Type	Write, Read			Write, Read			Write, Read		
BITFIEI	LD	BITS		DESCRIPTION					
FPSSRC_RST	10	7:6	0b01 0b10	0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence.					
RST7UPSLT 5:3			3'b00 3'b01 3'b01 3'b10 3'b10 3'b10 3'b11	00 = Slot 0 11 = Slot 1 0 = Slot 2 1 = Slot 3 10 = Slot 4 11 = Slot 5 0 = Slot 6 1 = Slot 7					

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
RST7DNSLT	2:0	3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7

SD0_CNFG1 (0x40)

BIT	7	6	6 5 4 3 2 1							
Field	RSVD		SD0VOUT[6:0]							
Reset	0b0		OTP							
Access Type	Write, Re	ad	Write, Read							
BITFIE	ELD	BITS	BITS DESCRIPTION							
RSVD		7	Rese	erved. Unutilize	ed bit. Write to (). Reads are d	on't care			
SD0VOUT		6:0	at 1.5 10m\	This 7-bit configuration is a linear transfer function that starts at 0.26V, orat 1.52V, with 10mV increments. VSD1 = 0.26V + ((SD0VOUT[6:0] - 1)10mV)Note: The 0x00 setting is reserved.						

SD1_CNFG1 (0x41)

BIT	7	6	6 5 4 3 2 1											
Field	RSVD				SD1VOUT[6:0)]	•	•						
Reset	0b0		OTP											
Access Type	Write, Re	ad	Write, Read											
BITF	BITFIELD BITS DESCRIPTION													
RSVD		7	Rese	erved. Unutilize	ed bit. Write to (). Reads are d	on't care							
SD1VOUT		6:0	at 1.4 10m	This 7-bit configuration is a linear transfer function that starts at 0.26V, at 1.52V, with 10mV increments. VSD1 = 0.26V + ((SD1VOUT[6:0] - 1) 10mV) Note: The 0x00 setting is reserved.					at 1.52V, with 10mV increments. VSD1 = 0.26V + ((SD1VOUT[6:0] - 10mV)					

SD2_CNFG1 (0x42)

BIT	7	6	5	4	3	2	1	0								
Field		÷		SD2VC	UT[7:0]	•	•									
Reset		OTP														
Access Type		Write, Read														
BITFIEI	D	BITS			DE	SCRIPTION										
SD2VOUT		7:0		This 8-bit configuration is a linear transfer function that starts at 0.6V, end 2.194V, with 6.25mV increments. VSD2 = 0.6V + (SD2VOUT[7:0] x 6.25m												

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

SD3_CNFG1 (0x43)

BIT	7	6	5	4	3	2	1	0			
Field				SD3VC	UT[7:0]						
Reset		OTP									
Access Type		Write, Read									
BITFIE	LD	BITS			DE	SCRIPTION					
SD3VOUT		7:0		This 8-bit configuration is a linear transfer function that starts at 0.6V, e 3.7875V, with 12.5mV increments. VSD3 = 0.6V + (SD3VOUT[7:0] x 12							

SD0_CNFG2 (0x44)

BIT	7	6	5		4	3	2	1	0
Field	RSVD	RSVD	SD0_S MF		RSVD	RSVD	SD0FSREN	SD0ADDIS	SD0FPWM EN
Reset	0b0	0b0	OT	Р	0b0	0b0	0b1	OTP	0b0
Access Type	Write, Rea	ad Write, Read	Write, I	Read	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read
BITFIELD BITS						DE	SCRIPTION		
RSVD		7		Rese	rved. Unutilized	d bit. Write to 0	. Reads are do	n't care.	
RSVD		6		Rese	rved. Unutilized	d bit. Write to 0	. Reads are do	n't care.	
SD0_SSRAMP 5 0 = 2.5mV/µs Ramp rate 1 = 10mV/µs Ramp rate This bit was changed from function to OTP only to avoid the BUCKOV iss when the ramp rate if changed on the fly, from 10mV to 2.5mV. Customer does not change this setting on the fly, and to avoid a false trigger this bit converted to OTP only.					Customer				
RSVD		4		Rese	rved. Unutilized	d bit. Write to 0	. Reads are do	n't care.	
RSVD		3		Rese	rved. Unutilized	d bit. Write to 0	. Reads are do	n't care.	
SD0FSREN 2 Image: SD0FSREN 3 Image: SD0FSREN 3 Image: SD0FSREN 4 Image: SD0FSREN 4 Image: SD0FS					sink current is a function voltage e external function of hal feedback oftage nt from the fixed for se, the PWM				

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
SD0ADDIS	1	0 = The active discharge function is enabled. When SD0 converter is disabled, an internal 100Ω discharge resistor is connected to the output to discharge the energy stored in the output capacitor. When SD0 converter is enabled, the discharge resistor is disconnected from the output. 1 = The active discharge function is disabled. When SD1 converter is disabled, the internal 100Ω discharge resistor is not connected to the output, and the discharge rate is dependent on the output capacitance and the load present.
SD0FPWMEN	0	 0 = SD0 converter automatically skips pulses under light load conditions and transfers to fixed frequency operation as the load current increases. 1 = SD0 converter operates with fixed frequency under all load conditions.

SD0_CNFG3 (0x45)

BIT	7	6	5	4	3	2	1	0		
Field	SD0_E	30_THR[1:0]	SD0_BO	_HYS[1:0]	RSVD	SD0_BO_PR[1:0]		SD0_OV_T HR		
Reset		OTP	C	TP	0x0	0b11		OTP		
Access Type	Wr	rite, Read	Write	Write, Read Write, Read Write, Read			Read	Write, Read		
BITFIEL	D	BITS			DES	CRIPTION				
SD0_BO_THR7:6This 2-bit configuration is a linear transfer function, expressed as a output voltage setting (SD0VOUT[6:0]), that starts at 75%, and end in 5% increments.SD0_BO_THR7:6Note: With 24µF of effective output capacitance and the 1.0V targe voltage, corner simulations show an undershoot of 180mV (6.5%) fo 3mA step in 4.8µs. For prototype margin testing, it is recommended the tighter 90% threshold to screen for potential issues. However, for production devices, it is recommended to use the 85% setting.2'b00 = 75%2'b01 = 80%2'b11 = 90%2'b11 = 90%						rget output) for a 10mA ended to use				
SD0_BO_HYS 5:4 This 2-bit configuration is a linear transfer function, expressed output voltage setting (SD0VOUT[6:0]), that starts at 5%, and 5% increments. SD0_BO_HYS 5:4 2'b00 = 5% 2'b01 = 10% 2'b10 = 15% 2'b11 = 20%										
RSVD		3	Rese	erved. Unutilized	d bit. Write to 0.	Reads are do	n't care.			
SD0_BO_PR 2:1			2'b0 2'b0 2'b1	This 2-bit configuration provides four settings for response time (and Iq). 2'b00 = Fast 2'b01 = Medium-fast 2'b10 = Medium-slow 2'b11 = Slow						

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
SD0_OV_THR	0	 This 1-bit configuration provides two options for SD0 output over-voltage comparator rising threshold, expressed as a % of the output voltage setting (SD0VOUT[6:0]). 0 = 108.3% 1 = 116.6% Note: With 24μF of effective output capacitance and the 1.0V target output voltage, corner simulations show an overshoot of 70mV (2.5%) for a 3A to 10mA step in 4.8μs. For prototype margin testing, it is recommended to use the tighter 108.3% threshold to screen for potential issues. However, for production devices, it is recommended to use the 116.6% setting.

SD1_CNFG2 (0x46)

BIT	7	6	5	4		3	2	1	0	
Field	RSVD	RSVD	SD1_SSRA MP	RSVD	RSVD RSVD		SD0FSREN	SD0ADDIS	SD0FPWM EN	
Reset	0b0	0b0	OTP	0b0		0b0	0b1	OTP	0b0	
Access Type	Write, Read	Write, Read	Write, Read	Write, Read Write, Rea			Write, Read	Write, Read	Write, Read	
BITFIELD	BITS		DESCRIPT	ION			D	ECODE		
RSVD	7		Reserved. Unutilized bit. Write to 0. Reads are don't care.							
RSVD	6		Reserved. Unutilized bit. Write to 0. Reads are don't care.							
SD1_SSRAM P	5	only to avoid ramp rate if 2.5mV. Cust setting on th	This bit was changed from function to OTP only to avoid the BUCKOV issue when the ramp rate if changed on the fly from 10mV to 2.5mV. Customer does not change this setting on the fly, and to avoid any false trigger, this bit is converted to OTP only.				mV/µs nV/µs Ramp ra	te		
RSVD	4		Reserved. Unutilized bit. Write to 0. Reads are don't care.							
RSVD	3		Reserved. Unutilized bit. Write to 0. Reads are don't care.							

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION	DECODE
SD0FSREN	2	0 = Active discharge disabled. SD0 is allowed to operate in skip mode during the time the output voltage decreases (only if SD1FPWMEN = 0). In skip mode, SD1 cannot sink current from the output capacitor and the output voltage falling slew rate is a function of the external load. If the external load is heavy, then the output voltage falling slew rate becomes the fixed output voltage ramp rate. If the external load is light, then the output voltage falling slew rate becomes a function of the output capacitance and the external load. Note that the internal feedback string always imposes a 2μ A load on the output. 1 = Active discharge enabled.	
		SD1 operates in forced PWM mode during the time the output voltage decreases. With forced PWM mode enabled, SD1 sinks current from the output capacitor to ensure that the output voltage falls at the rate fixed for output voltage ramp. To ensure a smooth output voltage decrease, the PWM mode remains engaged for 50µs after the output voltage decreases to its target voltage.	
SD0ADDIS	1	0 = The active discharge function is enabled. When the SD1 converter is disabled, an internal 100 Ω discharge resistor is connected to the output to discharge the energy stored in the output capacitor. When the SD1 converter is enabled, the discharge resistor is disconnected from the output. 1 = The active discharge function is disabled. When the SD1 converter is disabled, the internal 100 Ω discharge resistor is not connected to the output, and the discharge rate is dependent on the output capacitance and the load present.	
SD0FPWME N	0	 0 = SD0 converter automatically skips pulses under light load conditions and transfers to fixed frequency operation as the load current increases. 1 = SD0 converter operates with fixed frequency under all load conditions. 	

SD1_CNFG3 (0x47)

BIT	7	6	5	4	3	2	1	0
Field	SD1_BO	_THR[1:0]	SD1_BO_HYS[1:0]		RSVD	SD1_BO_PR[1:0]		SD1_OV_T HR
Reset	0.	OTP OTP		0b0	0b11		OTP	
Access Type	Write,	Read	Write, Read		Write, Read	Write, Read		Write, Read

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
SD1_BO_THR	7:6	This 2-bit configuration is a linear transfer function, expressed as a % of output voltage setting (SD1VOUT[6:0]), that starts at 75%, ends at 90% in 5% increments. Note: With 24µF of effective output capacitance and the 1.0V target output voltage, corner simulations show an undershoot of 180mV (6.5%) for a 10mA to 3mA step in 4.8µs. For prototype margin testings it is recommended to use the tighter 90% threshold to screen for potential issues. Howevers for production devices, it is recommended to use the 85% setting. 2'b00 = 75% 2'b10 = 85% 2'b11 = 90%
SD1_BO_HYS	5:4	This 2-bit configuration is a linear transfer function, expressed as a % of output voltage setting (SD1VOUT[6:0]), that starts at 5%, ends at 20% in 5% increments. 2'b00 = 5% 2'b01 = 10% 2'b10 = 15% 2'b11 = 20%
RSVD	3	Reserved. Unutilized bit. Write to 0. Reads are don't care.
SD1_BO_PR	2:1	This 2-bit configuration provides four settings for response time (and Iq). 2'b00 = Fast 2'b01 = Medium-fast 2'b10 = Medium-slow 2'b11 = Slow
SD1_OV_THR	0	 This 1-bit configuration provides two options for SD1 output over-voltage comparator rising threshold, expressed as a % of the output voltage setting (SD1VOUT[6:0]). 0 = 108.3% 1 = 116.6% Note: With 24µF of effective output capacitance and the 1.0V target output voltage, corner simulations show an overshoot of 70mV (2.5%) for a 3A to 10mA step in 4.8µs. For prototype margin testings it is recommended to use the tighter 108.3% threshold to screen for potential issues. Howevers for production devices, it is recommended to use the 116.6% setting.

SD2_CNFG2 (0x48)

BIT	7	6	5		4	3	2	1	0	
Field	RSVD	RSVD	RSVD		RSVD	RSVD	RSVD	SD2ADDIS	SD2FPWM EN	
Reset	0b0	0b0	0b	0	0b0	0b0	0b0	OTP	0b0	
Access Type	Write, Rea	d Write, Read	Write,	Read	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read	
BITFIE	LD	BITS		DESCRIPTION						
RSVD		7		Reserved. Unutilized bit. Write to 0. Reads are don't care.						
RSVD		6		Reserved. Unutilized bit. Write to 0. Reads are don't care.						
RSVD		5		Reserved. Unutilized bit. Write to 0. Reads are don't care.						

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
RSVD	4	Reserved. Unutilized bit. Write to 0. Reads are don't care.
RSVD	3	Reserved. Unutilized bit. Write to 0. Reads are don't care.
RSVD	2	Reserved. Unutilized bit. Write to 0. Reads are don't care.
SD2ADDIS	1	0 = The active discharge function is enabled. When the SD2 converter is disabled, an internal 100Ω discharge resistor is connected to the output to discharge the energy stored in the output capacitor. When the SD2 converter is enabled, the discharge resistor is disconnected from the output. 1 = The active discharge function is disabled. When the SD2 converter is disabled, the internal 100Ω discharge resistor is not connected to the output, and the discharge rate is dependent on the output capacitance and the load present.
SD2FPWMEN	0	 0 = SD2 converter automatically skips pulses under light load conditions and transfers to fixed frequency operation as the load current increases. 1 = SD2 converter operates with fixed frequency under all load conditions.

SD2_CNFG3 (0x49)

BIT	7	6	5	4	3	2	1	0		
Field	SD2_E	30_THR[1:0]	SD2_BO	_HYS[1:0]	RSVD	SD2_BO_PR[1:0]		SD2_OV_T HR		
Reset		OTP	0	TP	0b0	0	ГР	OTP		
Access Type	Wr	ite, Read	Write	Read	Write, Read	Write,	Read	Write, Read		
BITFIEL	BITS			DES	CRIPTION					
SD2_BO_THR		7:6	Note voltage to 3m the ti produ 2'b00 2'b01 2'b10	 DESCRIPTION Discription This 2-bit configuration is a linear transfer function, expressed as a % of output voltage setting (SD1VOUT[6:0]), that starts at 75%, ends at 90% in 5% increments. Note: With 24µF of effective output capacitance and the 1.0V target output voltage, corner simulations show an undershoot of 180mV (6.5%) for a 10mA to 3mA step in 4.8µs. For prototype margin testing, it is recommended to use the tighter 90% threshold to screen for potential issues. However, for production devices, it is recommended to use the 85% setting. 2'b00 = 75% 2'b10 = 85% 2'b11 = 90% 						
SD2_BO_HYS 5:4			outpu incre 2'b00 2'b01 2'b10		ion is a linear tr g (SD2VOUT[6					
RSVD		3	Rese	rved. Unutilized	d bit. Write to 0	Reads are do	n't care.			
SD2_BO_PR 2:1			2'b00 2'b01 2'b10	This 2-bit configuration provides four settings for response time (and Iq). 2'b00 = Fast 2'b01 = Medium-fast 2'b10 = Medium-slow 2'b11 = Slow						

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
SD2 OV THR	0	This 1-bit configuration provides two options for SD2 output over-voltage comparator rising threshold, expressed as a % of the output voltage setting (SD2VOUT[7:0]). 0 = 108.3% 1 = 116.6%
SD2_OV_THR	U	Note: With 13μ F of effective output capacitance and the 1.2V target output voltage, corner simulations show an overshoot of $133mV$ (11%) for a 2A to 10mA step in 3.2µs. For prototype margin testing, it is recommended to use the tighter 108.3% threshold to screen for potential issues. However, for production devices, it is recommended to use the 116.6% setting.

SD3_CNFG2 (0x4A)

BIT	7	6	5		4	3	2	1	0	
Field	RSVD	RSVD	RSV	/D	RSVD	RSVD	RSVD	SD3ADDIS	SD3FPWM EN	
Reset	0b0	0b0	0b	0	0b0	0b0	0b0	OTP	0b0	
Access Type	Write, Re	ad Write, Read	Write, I	Read	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read	
BITFIELD BITS DESCRIPTION										
				Blank. There is no physical bit at this location. Write to 0. Reads are don't care.						
RSVD		6		Blank. There is no physical bit at this location. Write to 0. Reads are don't care.						
RSVD		5		Blank care.	. There is no p	hysical bit at th	is location. Wr	te to 0. Reads	are don't	
RSVD		4	4		. There is no p	hysical bit at th	is location. Wr	te to 0. Reads	are don't	
RSVD	3 Reserved. Unutilized bit. Write to 0. Reads are don't care.									
RSVD	RSVD 2				Reserved. Unutilized bit. Write to 0. Reads are don't care.					
					0 = The active discharge function is enabled. When the SD3 converter is disabled, an internal 100 Ω discharge resistor is connected to the output to					

SD3ADDIS	D3ADDIS 1	disabled, an internal 100Ω discharge resistor is connected to the output to discharge the energy stored in the output capacitor. When the SD3 converter is enabled, the discharge resistor is disconnected from the output. 1 = The active discharge function is disabled. When the SD3 converter is disabled, the internal 100Ω discharge resistor is not connected to the output, and the discharge rate is dependent on the output capacitance and the load present.
SD3FPWMEN	0	 0 = SD3 converter automatically skips pulses under light load conditions and transfers to fixed frequency operation as the load current increases. 1 = SD3 converter operates with fixed frequency under all load conditions.

SD3_CNFG3 (0x4B)

BIT	7	6	5	4	3	2	1	0
Field	SD3_BO_THR[1:0]		SD3_BO_	_HYS[1:0]	RSVD	SD3_BO_PR[1:0]		SD3_OV_T HR
Reset	0	TP	0.	TP	0b0	0b11		OTP
Access Type	Write, Read		Write, Read		Write, Read	Write, Read		Write, Read

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
SD3_BO_THR	7:6	 This 2-bit configuration is a linear transfer function, expressed as a % of output voltage setting (SD1VOUT[6:0]), that starts at 75%, ends at 90% in 5% increments. Note: With 24µF of effective output capacitance and the 1.0V target output voltage, corner simulations show an undershoot of 180mV (6.5%) for a 10mA to 3mA step in 4.8µs. For prototype margin testing, it is recommended to use the tighter 90% threshold to screen for potential issues. However, for production devices, it is recommended to use the 85% setting. 2'b00 = 75% 2'b01 = 80% 2'b10 = 85% 2'b11 = 90%
SD3_BO_HYS	5:4	This 2-bit configuration is a linear transfer function, expressed as a % of output voltage setting (SD3VOUT[6:0]), that starts at 5%, ends at 20% in 5% increments. 2'b00 = 5% 2'b01 = 10% 2'b10 = 15% 2'b11 = 20%
RSVD	3	Reserved. Unutilized bit. Write to 0. Reads are don't care.
SD3_BO_PR	2:1	This 2-bit configuration provides four settings for response time (and Iq). 2'b00 = Fast 2'b01 = Medium-fast 2'b10 = Medium-slow 2'b11 = Slow
SD3_OV_THR	0	This 1-bit configuration provides two options for SD3 output over-voltage comparator rising threshold, expressed as a % of the output voltage setting (SD2VOUT[7:0]). 0 = 108.3% 1 = 116.6% Note: With 13µF of effective output capacitance and the 1.2V target output voltage, corner simulations show an overshoot of 133mV (11%) for a 2A to 10mA step in 3.2µs. For prototype margin testing, it is recommended to use the tighter 108.3% threshold to screen for potential issues. However, for production devices, it is recommended to use the 116.6% setting.

LDO_CNFG1_L0 (0x50)

BIT	7	6	5	4	3	2	1	0		
Field	RSVD	RSVD	VOUT_LDO_L0[5:0]							
Reset	0b0	0b0		OTP						
Access Type	Write, Rea	d Write, Read		Write, Read						
BITFIELD BITS				DESCRIPTION						
RSVD		7	Rese	erved. Unutilize	d bit. Write to 0). Reads are do	on't care.			
RSVD		6	Rese	erved. Unutilize	d bit. Write to 0). Reads are do	on't care.			
VOUT_LDO_L0 5:0 This 6-bit configuration is a linear transfer function that starts at 0 ends at 2.375V, with 25mV increments. VLDO = 0.8V + (VOUT_L 25mV).										

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

LDO_CNFG2_L0 (0x51)

BIT	7	6	5		4	3	2	1	0	
Field	OVCLMP N_L0	_E ALPM_EN_ L0	RSV	/D	RSVD	POK_L0	RSVD	ADE_L0	SS_L0	
Reset	OTP	OTP	0b	0	0b0	0b0	0b0	OTP	OTP	
Access Type	Write, Re	ad Write, Read	Write,	Read	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read	
BITFIE	LD	BITS DESCRIPTION								
OVCLMP_EN_	CLMP_EN_L0 7 0 = Overvoltage clamp disabled. 1 = Overvoltage clamp enabled (default).									
ALPM_EN_L0		6		0 = Auto low-power mode is disabled (default).1 = Auto low-power mode is enabled.						
RSVD		5		Rese	rved. Unutilized	bit. Write to 0	. Reads are do	n't care.		
RSVD		4 Reserved. Unutilized bit. Write to 0. Reads are don't care.								
POK_L0		3				ge is less than the POK threshold. ge is above the POK threshold.				
RSVD		2		Rese	rved. Unutilized	bit. Write to 0	. Reads are do	n't care.		
ADE_L0		1		 0 = The active discharge function is disabled. When the regulator is disabled, the internal active-discharge resistor is not connected to its output and the output voltage decays at a rate that is determined by the output capacitance and the external load. When the regulator is enabled, the internal active-discharge resistor is not connected to its output. 1 = The active discharge function is enabled. When the regulator is disabled, an internal active-discharge resistor is connected to its output which discharges the energy stored in the output capacitance. When this regulator is enabled, the internal active-discharge resistor is disconnected from its output. 					ut and the capacitance I active- is disabled, nich is regulator is	
SS_LO 0				 (Applies to both start-up and output voltage setting changes) 0 = Fast start-up and dynamic voltage change = 100mV/μs. 1 = Slow start-up and dynamic voltage change = 5mV/μs. 						

LDO_CNFG1_L1 (0x52)

BIT	7	6	5	4	3	2	1	0			
Field	RSVD	RSVD	VOUT_LDO_L1[5:0]								
Reset	0b0	0b0	OTP								
Access Type	Write, Read	Write, Read		Write, Read							
BITFI	BITFIELD BITS			DESCRIPTION							
RSVD		7	Rese	erved. Unutilized bit. Write to 0. Reads are don't care.							
RSVD	6		Rese	erved. Unutilized	d bit. Write to 0	. Reads are do	n't care.				
VOUT_LDO_L1 5:0				This 6-bit configuration is a linear transfer function that starts at 0.8V and ends at 2.375V, with 25mV increments. VLDO = $0.8V + (VOUT_LDO[5:0] \times 25mV)$.							

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

LDO_CNFG2_L1 (0x53)

BIT	7	6	5		4	3	2	1	0	
Field	OVCLMP N_L1	E ALPM_EN_ L1 RSVI		/D	RSVD	POK_L1	RSVD	ADE_L1	SS_L1	
Reset	OTP	OTP 0b0		0	0b0	0b0	0b0	OTP	OTP	
Access Type	Write, Re	ad Write, Read	ad Write, Read Write, R		Write, Read	Write, Read	Write, Read	Write, Read	Write, Read	
BITFIE	LD	BITS		DESCRIPTION						
OVCLMP_EN_L1 7 0 = Overvoltage clamp disabled. 1 = Overvoltage clamp enabled (default).										
ALPM_EN_L1		6	0 = Auto low-power mode is disabled (default). 1 = Auto low-power mode is enabled.							
RSVD		5		Rese	rved. Unutilized	d bit. Write to 0	. Reads are do	n't care.		
RSVD	/D 4				rved. Unutilized	d bit. Write to 0	. Reads are do	n't care.		
POK_L1		3			0 = The voltage is less than the POK threshold. 1 = The voltage is above the POK threshold.					
RSVD		2		Rese	rved. Unutilized	d bit. Write to 0	. Reads are do	n't care.		
ADE_L1		1		 0 = The active discharge function is disabled. When the regulator is disabled the internal active-discharge resistor is not connected to its output and the output voltage decays at a rate that is determined by the output capacitance and the external load. When the regulator is enabled, the internal active-discharge resistor is not connected to its output. 1 = The active discharge function is enabled. When the regulator is disable an internal active-discharge resistor is connected to its output which discharges the energy stored in the output capacitance. When this regulator enabled, the internal active-discharge resistor is disconnected form its output capacitance. 				ut and the capacitance I active- is disabled, nich is regulator is		
SS_L1		0		0 = F	ies to both star ast start-up and low start-up an	d dynamic volta	age change = 1	00mV/µs.		

LDO_CNFG1_L2 (0x54)

BIT	7	6	5	4	3	2	1	0			
Field	RSVD	RSVD		VOUT_LDO_L2[5:0]							
Reset	0b0	0b0	OTP								
Access Type	Write, Read	Write, Read	Write, Read								
BITFI	BITFIELD BITS			DESCRIPTION							
RSVD	RSVD		Rese	rved. Unutilized	d bit. Write to 0	. Reads are do	n't care.				
RSVD	′D 6			rved. Unutilized	d bit. Write to 0	. Reads are do	n't care.				
VOUT_LDO_	_L2	5:0	This 6-bit configuration is a linear transfer function that starts at 0.8V an ends at 3.95V, with 50mV increments. VLDO = 0.8V + (VOUT_LDO[5:0] 50mV).								

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

LDO_CNFG2_L2 (0x55)

BIT	7	6	5	4	3	2	1	0	
Field	OVCLMP_ N_L2	E ALPM_EN_ L2	COMP_L2[1:0]		POK_L2	RSVD	ADE_L2	SS_L2	
Reset	OTP	OTP	0	TP	0b0	0b0	OTP	OTP	
Access Type	Write, Rea	d Write, Read	Write, Read Write, Read Write, Read W				Write, Read	Write, Read	
BITFIE	LD	BITS			DE	SCRIPTION			
OVCLMP_EN_L2 7 0 = Overvoltage clamp disabled. 1 = Overvoltage clamp enabled (default).									
ALPM_EN_L2		6		uto low-power uto low-power					
COMP_L2		5:4	wher 50m capa remo	$0b00 =$ Fast transconductance setting for internal amplifier. Use this setting when the LDO output capacitor loop has a series R-L-C output impedance o 50mW, 5nH, and \geq COUT_x. This output impedance corresponds to an output capacitor that is placed directly at the output pins of the LDO (i.e., not remote). Load transient performance with this setting is 55mV typical betwee OUTxx and GND (default).					
POK_L2		3		he voltage is le he voltage is a					
RSVD		2	Rese	rved. Unutilize	d bit. Write to 0	. Reads are do	n't care.		
ADE_L2		1	 0 = The active discharge function is disabled. When the regulator is disable the internal active-discharge resistor is not connected to its output and the output voltage decays at a rate that is determined by the output capacitan and the external load. When the regulator is enabled, the internal active-discharge resistor is not connected to its output. 1 = The active discharge function is enabled. When the regulator is disable an internal active-discharge resistor is connected to its output which discharges the energy stored in the output capacitance. When this regulate enabled, the internal active-discharge resistor is disconnected from its output when the regulator is disconnected from its output enabled. 						
SS_L2		0	0 = F	lies to both star ast start-up an low start-up ar	d dynamic volta	age change = 1	00mV/µs.	-	

LDO_CNFG1_L3 (0x56)

BIT	7	6	5 4 3 2 1 0										
Field	RSVD	RSVD		VOUT_LDO_L3[5:0]							VOUT_		·
Reset	0b0	0b0	OTP										
Access Type	Write, Read	Write, Read		Write, Read									
BITFIELD BITS DESCRI					SCRIPTION	PTION							
RSVD		7	Rese	erved. Unutilize	d bit. Write to	0. Reads are do	on't care.						
RSVD		6	Rese	erved. Unutilize	d bit. Write to (0. Reads are do	on't care.						
VOUT_LDO_I	L3	5:0	This 6-bit configuration is a linear transfer function that starts at 0.8V a ends at 3.95V, with 50mV increments. VLDO = 0.8V + (VOUT_LDO[5: 50mV).										

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

LDO_CNFG2_L3 (0x57)

BIT	7	6	5	4	3	2	1	0	
Field	OVCLMP_ N_L3	_E ALPM_EN_ L3	COMP_L3[1:0]		POK_L3	RSVD	ADE_L3	SS_L3	
Reset	OTP	OTP	0	TP	0b0	0b0	OTP	OTP	
Access Type	Write, Rea	ad Write, Read	Write, Read Write, Read Write, Read Write, Read				Write, Read	Write, Read	
BITFIE	LD	BITS			DE	SCRIPTION			
OVCLMP_EN_L3 7 0 = Overvoltage clamp disabled. 1 = Overvoltage clamp enabled (default).									
ALPM_EN_L3		6		uto low-power uto low-power					
COMP_L3		5:4	wher 50m capa remo	0b00 = Fast transconductance setting for internal amplifier. Use this setting when the LDOs output capacitor loop has a series R-L-C output impedance of 50mW, 5nH, and ≥ COUT_x. This output impedance corresponds to an output capacitor that is placed directly at the output pins of the LDO (i.e., not remote). Load transient performance with this setting is 55mV typical betwee OUTxx and GND (default).					
POK_L3		3		he voltage is le he voltage is a					
RSVD		2	Rese	erved. Unutilize	d bit. Write to 0	. Reads are do	n't care.		
ADE_L3		1	 0 = The active discharge function is disabled. When the regulator is disable the internal active-discharge resistor is not connected to its output and the output voltage decays at a rate that is determined by the output capacitance and the external load. When the regulator is enabled, the internal active-discharge resistor is not connected to its output. 1 = The active discharge function is enabled. When the regulator is disable an internal active-discharge resistor is connected to its output which discharges the energy stored in the output capacitance. When this regulate enabled, the internal active-discharge resistor is disconnected from its output enabled. 						
SS_L3		0	0 = F	lies to both star ast start-up an Now start-up ar	d dynamic volta	age change = 1	00mV/µs.		

LDO_CNFG1_L4 (0x58)

BIT	7	6	5 4 3 2 1 0								
Field	RSVD	RSVD		VOUT_LDO_L4[5:0]							
Reset	0b0	0b0		OTP							
Access Type	Write, Read	Write, Read	Write, Read								
BITFIE	BITFIELD BITS				DESCRIPTION						
RSVD		7		erved. Unutilized	d bit. Write to (). Reads are do	on't care.				
RSVD	6		Rese	Reserved. Unutilized bit. Write to 0. Reads are don't care.							
VOUT_LDO_L	.4	5:0	This 6-bit configuration is a linear transfer function that starts at 0.4V ar ends at 1.275V, with 12.5mV increments.								

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

LDO_CNFG2_L4 (0x59)

BIT	7	6	5	4	3	2	1	0
Field	OVCLMP_ N_L4	E ALPM_EN_ L4	COMP_L4[1:0]		POK_L4	RSVD	ADE_L4	SS_L4
Reset	OTP	OTP	0	TP	0b0	0b0	OTP	OTP
Access Type	Write, Rea	d Write, Read	Write	, Read	Write, Read	Write, Read	Write, Read	Write, Read
BITFIE	LD	BITS			DE	SCRIPTION		
OVCLMP_EN_L4 7 0 = Overvoltage clamp disabled. 1 = Overvoltage clamp enabled (default).								
ALPM_EN_L4		6			mode is disable mode is enable			
COMP_L4		5:4	0b00 = Fast transconductance setting for internal amplifier. Use this setting when the LDOs output capacitor loop has a series R-L-C output impedance 50mW, 5nH, and \geq COUT_4. This output impedance corresponds to an output capacitor that is placed directly at the output pins of the LDO (i.e., no remote). Load transient performance with this setting is 55mV typical betwee OUTxx and GND (default),					
POK_L4		3		•	ess than the PC bove the POK t			
RSVD		2	Rese	rved. Unutilize	d bit. Write to 0	. Reads are do	n't care.	
ADE_L4		1	 0 = The active discharge function is disabled. When the regulator is disable the internal active-discharge resistor is not connected to its output and the output voltage decays at a rate that is determined by the output capacitan and the external load. When the regulator is enabled, the internal active-discharge resistor is not connected to its output. 1 = The active discharge function is enabled. When the regulator is disable an internal active-discharge resistor is connected to its output which discharges the energy stored in the output capacitance. When this regulate enabled, the internal active-discharge resistor is disconnected from its output when the regulate enabled. 					ut and the capacitance I active- is disabled, nich is regulator is
SS_L4		0	(Applies to both start-up and output voltage setting changes)					

LDO_CNFG1_L5 (0x5A)

BIT	7	6	5	5 4 3 2 1 0													
Field	RSVD	RSVD		VOUT_LDO_L5[5:0]							VOUT_LDO_L5[5:0]						
Reset	0b0	0b0	OTP														
Access Type	Write, Read	Write, Read		Write, Read													
BITFIE	LD	BITS		DESCRIPTION													
RSVD		7	Rese	rved. Unutilized	bit. Write to 0	. Reads are do	on't care.										
RSVD		6		rved. Unutilized	bit. Write to 0	. Reads are do	on't care.										
VOUT_LDO_L	OUT_LDO_L5 5:0		ends	This 6-bit configuration is a linear transfer function that starts at 0.8V and ends at 3.95V, with 50mV increments. VLDO = 0.8V + (VOUT_LDO[5:0] 50mV).													

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

LDO_CNFG2_L5 (0x5B)

BIT	7	6	5	4	3	2	1	0	
Field	OVCLMP_ N_L5	_E ALPM_EN_ L5	COMP_L5[1:0]		POK_L5	RSVD	ADE_L5	SS_L5	
Reset	OTP	OTP	0	TP	0b0	0b0	OTP	OTP	
Access Type	Write, Rea	ad Write, Read	Write, Read Write, Read Write, Read Write,				Write, Read	Write, Read	
BITFIE	LD	BITS			DE	SCRIPTION			
OVCLMP_EN_L5 7 0 = Overvoltage clamp disabled. 1 = Overvoltage clamp enabled (default).									
ALPM_EN_L5		6			mode is disable mode is enable				
COMP_L5		5:4	wher 50m capa remo	$0b00 =$ Fast transconductance setting for internal amplifier. Use this setting when the LDOs output capacitor loop has a series R-L-C output impedance of 50mW, 5nH, and \geq COUT_x. This output impedance corresponds to an output capacitor that is placed directly at the output pins of the LDO (i.e., not remote). Load transient performance with this setting is 55mV typical betwee OUTxx and GND (default).					
POK_L5		3		•	ess than the PC bove the POK t				
RSVD		2	Rese	erved. Unutilize	d bit. Write to 0	. Reads are do	n't care.		
ADE_L5		1	 0 = The active discharge function is disabled. When the regulator is disable the internal active-discharge resistor is not connected to its output and the output voltage decays at a rate that is determined by the output capacitance and the external load. When the regulator is enabled, the internal active-discharge resistor is not connected to its output. 1 = The active discharge function is enabled. When the regulator is disable an internal active-discharge resistor is connected to its output which discharges the energy stored in the output capacitance. When this regulate enabled, the internal active-discharge resistor is disconnected from its output when the regulate the energy stored in the output capacitance. When this regulate enabled, the internal active-discharge resistor is disconnected from its output when the regulate enabled. 						
SS_L5		0	0 = F	ast start-up an	t-up and outpu d dynamic volta d dynamic volt	age change = 1	00mV/µs.		

LDO_CNFG1_L6 (0x5C)

BIT	7	6	5	5 4 3 2 1 0													
Field	RSVD	RSVD		VOUT_LDO_L6[5:0]							VOUT_LDO_L6[5:0]						
Reset	0b0	0b0	OTP														
Access Type	Write, Read	Write, Read		Write, Read													
BITFIE	BITFIELD BITS				DESCRIPTION												
RSVD		7	Rese	rved. Unutilized	d bit. Write to 0	. Reads are do	on't care.										
RSVD		6		Reserved. Unutilized bit. Write to 0. Reads are don't care.													
VOUT_LDO_I	T_LDO_L6 5:0			This 6-bit configuration is a linear transfer function that starts at 0.8V and ends at 3.95V, with 50mV increments. VLDO = 0.8V + (VOUT_LDO[5:0] 50mV).													

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

LDO_CNFG2_L6 (0x5D)

BIT	7	6	5	4	3	2	1	0		
Field	OVCLMP_ N_L6	_E ALPM_EN_ L6	COMP_L6[1:0]		POK_L6	RSVD	ADE_L6	SS_L6		
Reset	OTP	OTP	0	TP	0b0	0b0	OTP	OTP		
Access Type	Write, Rea	ad Write, Read	Write	, Read	Write, Read	Write, Read	Write, Read	Write, Read		
BITFIE	LD	BITS			DE	SCRIPTION				
OVCLMP_EN_	_L6	7		Overvoltage clar Overvoltage clar	mp disabled. mp enabled (de	efault).				
ALPM_EN_L6		6			mode is disable mode is enable					
COMP_L6		5:4	0b00 = Fast transconductance setting for internal amplifier. Use this when the LDOs output capacitor loop has a series R-L-C output imper 50mW, 5nH, and ≥ COUT_x. This output impedance corresponds to capacitor that is placed directly at the output pins of the LDO (i.e., nor remote). Load transient performance with this setting is 55mV typica OUTxx and GND (default).				impedance of s to an output ., not			
POK_L6		3		•	ess than the PC bove the POK t					
RSVD		2	Rese	erved. Unutilize	d bit. Write to 0	. Reads are do	n't care.	n't care.		
ADE_L6 1				nternal active-d ut voltage deca he external loa arge resistor is he active disch ternal active-di- arges the ener	arge function is ischarge resisto ys at a rate tha d. When the re not connected arge function is scharge resisto gy stored in the I active-dischar	or is not connect t is determined gulator is enab to its output. s enabled. Whe r is connected output capaci	cted to its output by the output of led, the internation on the regulator to its output wh tance. When the	ut and the capacitance I active- is disabled, nich is regulator is		
SS_L6		0	 enabled, the internal active-discharge resistor is disconnected from its (Applies to both start-up and output voltage setting changes) 0 = Fast startup and dynamic voltage change = 100mV/μs. 1 = Slow startup and dynamic voltage change = 5mV/μs. 							

LDO_CNFG1_L7 (0x5E)

BIT	7	6	5	4	3	2	1	0		
Field	RSVD	RSVD	VOUT_LDO_L7[5:0]							
Reset	0b0	0b0			0.	TP				
Access Type	Write, Rea	d Write, Read	Write, Read							
BITFIE	LD	BITS		DESCRIPTION						
RSVD		7	Rese	Reserved. Unutilized bit. Write to 0. Reads are don't care.						
RSVD		6	Rese	Reserved. Unutilized bit. Write to 0. Reads are don't care.						
VOUT_LDO_L	.7	5:0	ends	This 6-bit configuration is a linear transfer function that starts at 0.8V and ends at $3.95V$, with 50mV increments. VLDO = $0.8V + (VOUT_LDO[5:0] \times 50mV)$.						

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

LDO_CNFG2_L7 (0x5F)

BIT	7	6	5	4	3	2	1	0			
Field	OVCLMP_ N_L7	E ALPM_EN_ L7	COMP_L7[1:0]		POK_L7	RSVD	ADE_L7	SS_L7			
Reset	OTP	OTP	0	TP	0b0	0b0	OTP	OTP			
Access Type	Write, Rea	d Write, Read	Write	, Read	Write, Read	Write, Read	Write, Read	Write, Read			
BITFIE	LD	BITS			DE	SCRIPTION					
OVCLMP_EN	_L7	7		Overvoltage clar Overvoltage clar		efault).					
ALPM_EN_L7		6		uto low-power uto low-power							
COMP_L7		5:4	0b00 = Fast transconductance setting for internal amplifier. Use t when the LDOs output capacitor loop has a series R-L-C output 50mW, 5nH, and ≥ COUT_x. This output impedance correspond capacitor that is placed directly at the output pins of the LDO (i.e remote). Load transient performance with this setting is 55mV typ OUTxx and GND (default).				ut capacitor loop has a series R-L-C output impedar OUT_x. This output impedance corresponds to an c ed directly at the output pins of the LDO (i.e., not ent performance with this setting is 55mV typical bet				
POK_L7		3		0 = The voltage is less than the POK threshold.1 = The voltage is above the POK threshold.							
RSVD		2	Rese	Reserved. Unutilized bit. Write to 0. Reads are don't care.							
ADE_L7 1			the ir outpu and t disch 1 = T an in disch	The active disch nternal active-d ut voltage deca the external loa arge resistor is The active disch ternal active-di- narges the ener led, the interna	ischarge resiste ys at a rate tha d. When the re not connected arge function is scharge resiste gy stored in the	or is not connect t is determined gulator is enab to its output. s enabled. Whe r is connected output capaci	cted to its output by the output of led, the internation on the regulator to its output wh tance. When the	ut and the capacitance I active- r is disabled, hich his regulator is			
SS_L7		0	enabled, the internal active-discharge resistor is disconnect (Applies to both start-up and output voltage setting changes 0 = Fast startup and dynamic voltage change = 100mV/µs. 1 = Slow startup and dynamic voltage change = 5mV/µs.				00mV/µs.				

LDO_CNFG1_L8 (0x60)

BIT	7	6	5	4	3	2	1	0		
Field	RSVD	RSVD		VOUT_LDO_L8[5:0]				·		
Reset	0b0	0b0			C	TP				
Access Type	Write Read		Write, Read							
BITFIE	LD	BITS		DESCRIPTION						
RSVD		7	Rese	Reserved. Unutilized bit. Write to 0. Reads are don't care.						
RSVD		6	Rese	Reserved. Unutilized bit. Write to 0. Reads are don't care.						
VOUT_LDO_I	L8	5:0	ends	This 6-bit configuration is a linear transfer function that starts at 0.8V and ends at 3.95V, with 50mV increments. VLDO = 0.8V +(VOUT_LDO[5:0] x 50mV).						

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

LDO_CNFG2_L8 (0x61)

BIT	7	6	5	4	3	2	1	0			
Field	OVCLMP N_L8	_E ALPM_EN_ L8	RSV	D[1:0]	POK_L8	RSVD	ADE_L8	SS_L8			
Reset	OTP	OTP	Ot	000	0b0	0b0	OTP	OTP			
Access Type	Write, Re	ad Write, Read	Write	, Read	Write, Read	Write, Read	Write, Read	Write, Read			
BITFIE	LD	BITS			DE	SCRIPTION					
OVCLMP_EN_	_L8	7)vervoltage clar)vervoltage clar		fault).					
ALPM_EN_L8		6		0 = Auto low-power mode is disabled (default). 1 = Auto low-power mode is enabled.							
RSVD		5:4 Reserved. Unutilized bit. Write to 0. Reads are don't care.									
POK_L8		3		0 = The voltage is less than the POK threshold.1 = The voltage is above the POK threshold.							
RSVD		2	Rese	Reserved. Unutilized bit. Write to 0. Reads are don't care.							
ADE_L8 1				he active disch nternal active-di ut voltage deca he external loa arge resistor is he active disch ternal active-dis arges the ener led, the interna	scharge resistorys at a rate that d. When the render the connected arge function is scharge resistory gy stored in the	or is not connect t is determined gulator is enab to its output. s enabled. Whe r is connected output capaci	cted to its output by the output of led, the internation on the regulator to its output wh tance. When the	ut and the capacitance I active- is disabled, nich is regulator is			
SS_L8	8 0			 (Applies to both start-up and output voltage setting changes) 0 = Fast startup and dynamic voltage change = 100mV/μs. 1 = Slow startup and dynamic voltage change = 5mV/μs. 							

LDO_CNFG3 (0x62)

BIT	7	6	5	4	3	2	1	0	
Field				RSVD[6:0]				L_B_EN	
Reset		0b000000 0b0							
Access Type		Write, Read Write, Read							
BITFIEI	D	BITS			DE	SCRIPTION			
RSVD		7:1	Rese	erved. Unutilized	bit. Write to	0. Reads are d	on't care.		
L_B_EN		0 = Bias is disabled if all LDOs are disabled (default). 1 = Bias is enabled.							

CNFG_GPIO0 (0x70)

BIT	7	6	5	4	3	2	1	0
Field	DBNC	0[1:0]	REFE_I	RQ[1:0]	DO0	DI0	DIR0	PPDRV0
Reset	Ot	00	01	00	0b0	0b0	0b0	0b0
Access Type	Write,	Read	Write,	Read	Write, Read	Write, Read	Write, Read	Write, Read

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
		When set for GPO (DIRx = 0): DBNCx are don't care when GPO.
DBNC0	7:6	When set for GPI (DIRx = 1): Debounce configuration. GPIx has the following debounce times for both rising and falling edges. 0b00 = No debounce 0b01 = 8ms 0b10 = 16ms 0b11 = 32ms
		When set for GPO (DIRx = 0): REFE_IRQx are don't care when GPO.
REFE_IRQ	5:4	When set for GPI (DIRx = 1): Rising edge and falling edge interrupt configuration. GPIx has the interrupt behavior which is programmed with REFE_IRQx. 0b00 = Mask interrupt 0b01 = Falling edge interrupt 0b10 = Rising edge interrupt 0b11 = Falling and rising edge interrupt
D00		When set for GPO (DIRx = 0): GPO output drive level is programmed with DOx. 0 = Logic low 1 = Logic high (DRVx = 1) and open-drain (DRVx = 0)
	3	When set for GPI (DIRx = 1): 0 = Clear DOx to 0 and set PUEx to 1 to enable the internal pull-up. 1 = Set DOx to 1 and set PDEx to 1 to enable the internal pull-down. See the <i>GPIO Programming Matrix</i> section for more information.
		When set for GPO (DIRx = 0): DIx is a don't care when GPO.
DIO	2	When set for GPI (DIRx = 1): Input Drive Level. GPIOx input logic level is specified by DIx. 0 = Input logic-low 1 = Input logic-high When DIRx = 1, this bit is read only, writes to this bit are ignored.
		When AMEx = 0: GPIOx direction. 0 = General purpose output (GPO) 1 = General purpose input (GPI)
DIRO	1	When AMEx = 1: When GPIO1/2/3/4 is set as an alternate mode output, write DIR1/2/3/4 (respectively) to 0 but note that the output is internally set to be active-high. When GPIO0/5/6 is set as an alternate mode input, DIR0/5/6 (respectively) determines if the signal is active high or active low. 0 = Active-low 1 = Active-high
PPDRV0	0	When set for GPO (DIRx = 0): Push-pull output drive. GPIO output configuration is determined by PPDRVx. 0 = Open-drain 1 = Push-pull
		When set for GPI (DIRx = 1): PPDRVx is a don't care when GPI.

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

CNFG_GPIO1 (0x71)

BIT	7	6	5	4	3	2	1	0		
Field	DBN	C1[1:0]	REFE_	IRQ[1:0]	DO1	DI1	DIR1	PPDRV1		
Reset	C)b0	0	b0	0b0	0b0	0b0	0b0		
Access Type	Write	e, Read	Write	, Read	Write, Read	Write, Read	Write, Read	Write, Read		
BITFIE	LD	BITS			DE	SCRIPTION				
DBNC1		7:6	When set for GPO (DIRx = 0): DBNCx are don't care when GPO. When set for GPI (DIRx = 1): Debounce configuration. GPIx has the following debounce times for brising and falling edges. 0b00 = No debounce 0b01 = 8ms 0b10 = 16ms 0b11 = 32ms							
REFE_IRQ		5:4	When set for GPO (DIRx = 0): REFE_IRQx are don't care when GPO. When set for GPI (DIRx = 1): Rising edge and falling edge interrupt configuration. GPIx has the inter behavior which is programmed with REFE_IRQx. 0b00 = Mask interrupt 0b01 = Falling edge interrupt 0b10 = Rising edge interrupt 0b11 = Falling and rising edge interrupt					e interrupt		
DO1	001 3 When set for GPO ([GPO output drive lev 0 = Logic low 1 = Logic high (DRV) 0 = Clear DOx to 0 a 1 = Set DOx to 1 and					hen set for GPO (DIRx = 0): PO output drive level is programmed with DOx. = Logic low = Logic high (DRVx = 1) and open-drain (DRVx = 0) hen set for GPI (DIRx = 1): = Clear DOx to 0 and set PUEx to 1 to enable the internal pull-up. = Set DOx to 1 and set PDEx to 1 to enable the internal pull-down. see the <i>GPIO Programming Matrix</i> section for more information.				
DI1 2				When set for GPO (DIRx = 0): DIx is a don't care when GPO. When set for GPI (DIRx = 1): Input Drive Level. GPIOx input logic level is specified by DIx. 0 = Input logic-low 1 = Input logic-high When DIRx = 1, this bit is read only, writes to this bit are ignored.						

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
DIR1	1	When AMEx = 0: GPIOx direction. 0 = General purpose output (GPO) 1 = General purpose input (GPI) When AMEx = 1: When GPIO1/2/3/4 is set as an alternate mode output, write DIR1/2/3/4 (respectively) to 0 but note that the output is internally set to be active-high. When GPIO0/5/6 is set as an alternate mode input, DIR0/5/6 (respectively) determines if the signal is active high or active low. 0 = Active-low 1 = Active-high
PPDRV1	0	When set for GPO (DIRx = 0): Push-pull output drive. GPIO output configuration is determined by PPDRVx. 0 = Open-drain 1 = Push-pull When set for GPI (DIRx = 1): PPDRVx is a don't care when GPI.

CNFG_GPIO2 (0x72)

BIT	7	(6	5	4	3	2	1	0		
Field	DB	NC2[1:0]		REFE_I	RQ[1:0]	DO2	DI2	DIR2	PPDRV2		
Reset		0b0		Ot	00	0b0	0b0	0b0	0b0		
Access Type	Wr	ite, Read		Write,	Read	Write, Read	Write, Read	Write, Read	Write, Read		
BITFIE	LD	D BITS				DE	SCRIPTION				
DBNC2			7:6	DBN0 Wher Debo rising 0b00 0b01 0b10	When set for GPO (DIRx = 0): DBNCx are don't care when GPO. When set for GPI (DIRx = 1): Debounce configuration. GPIx has the following debounce times for borrising and falling edges. 0b00 = No debounce 0b01 = 8ms 0b10 = 16ms 0b11 = 32ms						
REFE_IRQ 5:4				REFE Wher Rising behav 0b00 0b01 0b10	When set for GPO (DIRx = 0): REFE_IRQx are don't care when GPO. When set for GPI (DIRx = 1): Rising edge and falling edge interrupt configuration. GPIx has the interrupt behavior which is programmed with REFE_IRQx. 0b00 = Mask interrupt 0b01 = Falling edge interrupt 0b10 = Rising edge interrupt 0b11 = Falling and rising edge interrupt						

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
DO2	3	 When set for GPO (DIRx = 0): GPO output drive level is programmed with DOx. 0 = Logic low 1 = Logic high (DRVx = 1) and open-drain (DRVx = 0) When set for GPI (DIRx = 1): 0 = Clear DOx to 0 and set PUEx to 1 to enable the internal pull-up. 1 = Set DOx to 1 and set PDEx to 1 to enable the internal pull-down. See the <i>GPIO Programming Matrix</i> section for more information.
DI2	2	 When set for GPO (DIRx = 0): DIx is a don't care when GPO. When set for GPI (DIRx = 1): Input Drive Level. GPIOx input logic level is specified by DIx. 0 = Input logic-low 1 = Input logic-high When DIRx = 1, this bit is read only, writes to this bit are ignored.
DIR2	1	When AMEx = 0: GPIOx direction. 0 = General purpose output (GPO) 1 = General purpose input (GPI) When AMEx = 1: When GPI01/2/3/4 is set as an alternate mode output, write DIR1/2/3/4 (respectively) to 0 but note that the output is internally set to be active-high. When GPI00/5/6 is set as an alternate mode input, DIR0/5/6 (respectively) determines if the signal is active high or active low. 0 = Active-low 1 = Active-high
PPDRV2	0	When set for GPO (DIRx = 0): Push-pull output drive. GPIO output configuration is determined by PPDRVx. 0 = Open-drain 1 = Push-pull When set for GPI (DIRx = 1): PPDRVx is a don't care when GPI.

CNFG_GPIO3 (0x73)

BIT	7	6	5	4	3	2	1	0
Field	DBI	NC3[1:0]	REFE_I	RQ[1:0]	DO3	DI3	DIR3	PPDRV3
Reset		0b0	01	00	0b0	0b0	0b0	0b0
Access Type	Writ	te, Read	Write,	Write, Read		Write, Read	Write, Read	Write, Read
BITFIEI	LD	BITS			DE	SCRIPTION		
DBNC3		7:6	DBN0 Wher Debo rising 0b00 0b01 0b10	n set for GPO (I Cx are don't can n set for GPI (D unce configura and falling edg = No debounce = 8ms = 16ms = 32ms	re when GPO. IRx = 1): tion. GPIx has ges.	the following d	ebounce times	for both

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
REFE_IRQ	5:4	When set for GPO (DIRx = 0): REFE_IRQx are don't care when GPO. When set for GPI (DIRx = 1): Rising edge and falling edge interrupt configuration. GPIx has the interrupt behavior which is programmed with REFE_IRQx. 0b00 = Mask interrupt 0b01 = Falling edge interrupt 0b10 = Rising edge interrupt 0b11 = Falling and rising edge interrupt
DO3	3	 When set for GPO (DIRx = 0): GPO output drive level is programmed with DOx. 0 = Logic low 1 = Logic high (DRVx = 1) and open-drain (DRVx = 0) When set for GPI (DIRx = 1): 0 = Clear DOx to 0 and set PUEx to 1 to enable the internal pull-up. 1 = Set DOx to 1 and set PDEx to 1 to enable the internal pull-down. See the <i>GPIO Programming Matrix</i> section for more information.
DI3	2	 When set for GPO (DIRx = 0): DIx is a don't care when GPO. When set for GPI (DIRx = 1): Input Drive Level. GPIOx input logic level is specified by DIx. 0 = Input logic-low 1 = Input logic-high When DIRx = 1, this bit is read only, writes to this bit are ignored.
DIR3	1	 When AMEx = 0: GPIOx direction. 0 = General purpose output (GPO) 1 = General purpose input (GPI) When AMEx = 1: When GPIO1/2/3/4 is set as an alternate mode output, write DIR1/2/3/4 (respectively) to 0 but note that the output is internally set to be active-high. When GPIO0/5/6 is set as an alternate mode input, DIR0/5/6 (respectively) determines if the signal is active high or active low. 0 = Active-low 1 = Active-high
PPDRV3	0	When set for GPO (DIRx = 0): Push-pull output drive. GPIO output configuration is determined by PPDRVx. 0 = Open-drain 1 = Push-pull When set for GPI (DIRx = 1): PPDRVx is a don't care when GPI.

CNFG_GPIO4 (0x74)

BIT	7	6	5	4	3	2	1	0
Field	DBNC	24[1:0]	REFE_IRQ[1:0]		DO4	DI4	DIR4	PPDRV4
Reset	01	00	0b0		0b0	0b0	0b0	0b0
Access Type	Write,	Read	Write,	Write, Read		Write, Read	Write, Read	Write, Read

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
		When set for GPO (DIRx = 0): DBNCx are don't care when GPO.
DBNC4	7:6	When set for GPI (DIRx = 1): Debounce configuration. GPIx has the following debounce times for both rising and falling edges. 0b00 = No debounce 0b01 = 8ms 0b10 = 16ms 0b11 = 32ms
		When set for GPO (DIRx = 0): REFE_IRQx are don't care when GPO.
REFE_IRQ	5:4	When set for GPI (DIRx = 1): Rising edge and falling edge interrupt configuration. GPIx has the interrupt behavior which is programmed with REFE_IRQx. 0b00 = Mask interrupt 0b01 = Falling edge interrupt 0b10 = Rising edge interrupt 0b11 = Falling and rising edge interrupt
DO4	_	When set for GPO (DIRx = 0): GPO output drive level is programmed with DOx. 0 = Logic low 1 = Logic high (DRVx = 1) and open-drain (DRVx = 0)
	3	When set for GPI (DIRx = 1): 0 = Clear DOx to 0 and set PUEx to 1 to enable the internal pull-up. 1 = Set DOx to 1 and set PDEx to 1 to enable the internal pull-down. See the <i>GPIO Programming Matrix</i> section for more information.
		When set for GPO (DIRx = 0): DIx is a don't care when GPO.
DI4	2	When set for GPI (DIRx = 1): Input Drive Level. GPIOx input logic level is specified by DIx. 0 = Input logic-low 1 = Input logic-high When DIRx = 1, this bit is read only, writes to this bit are ignored.
		When AMEx = 0: GPIOx direction. 0 = General purpose output (GPO) 1 = General purpose input (GPI)
DIR4	1	When AMEx = 1: When GPIO1/2/3/4 is set as an alternate mode output, write DIR1/2/3/4 (respectively) to 0 but note that the output is internally set to be active-high. When GPIO0/5/6 is set as an alternate mode input, DIR0/5/6 (respectively) determines if the signal is active high or active low. 0 = Active-low 1 = Active-high
PPDRV4	0	When set for GPO (DIRx = 0): Push-pull output drive. GPIO output configuration is determined by PPDRVx. 0 = Open-drain 1 = Push-pull
		When set for GPI (DIRx = 1): PPDRVx is a don't care when GPI.

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

CNFG_GPIO5 (0x75)

BIT	7	6	5	4	3	2	1	0	
Field	DBN	IC5[1:0]	REFE_	IRQ[1:0]	DO5	DI5	DIR5	PPDRV5	
Reset		0b0	0	b0	0b0	0b0	0b0	0b0	
Access Type	Write	e, Read	Write	, Read	Write, Read	Write, Read	Write, Read	Write, Read	
BITFIE	LD	BITS			DE	SCRIPTION			
DBNC5		7:6	When set for GPO (DIRx = 0): DBNCx are don't care when GPO. When set for GPI (DIRx = 1): Debounce configuration. GPIx has the following debounce times for rising and falling edges. 0b00 = No debounce 0b01 = 8ms 0b10 = 16ms 0b11 = 32ms					for both	
REFE_IRQ		5:4	When set for GPO (DIRx = 0): REFE_IRQx are don't care when GPO. When set for GPI (DIRx = 1): Rising edge and falling edge interrupt configuration. GPIx has the inter-					e interrupt	
DO5		3	When set for GPO (DIRx = 0): GPO output drive level is programmed with DOx. 0 = Logic low 1 = Logic high (DRVx = 1) and open-drain (DRVx = 0)						
DI5		2	When DIx is When Input 0 = Ir 1 = Ir	When set for GPO (DIRx = 0): DIx is a don't care when GPO. When set for GPI (DIRx = 1): Input Drive Level. GPIOx input logic level is specified by DIx. 0 = Input logic-low 1 = Input logic-high When DIRx = 1, this bit is read only, writes to this bit are ignored.					

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
DIR5	1	 When AMEx = 0: GPIOx direction. 0 = General purpose output (GPO) 1 = General purpose input (GPI) When AMEx = 1: When GPIO1/2/3/4 is set as an alternate mode output, write DIR1/2/3/4 (respectively) to 0 but note that the output is internally set to be active-high. When GPIO0/5/6 is set as an alternate mode input, DIR0/5/6 (respectively) determines if the signal is active high or active low. 0 = Active-low 1 = Active-high
PPDRV5	0	When set for GPO (DIRx = 0): Push-pull output drive. GPIO output configuration is determined by PPDRVx. 0 = Open-drain 1 = Push-pull When set for GPI (DIRx = 1): PPDRVx is a don't care when GPI.

CNFG_GPIO6 (0x76)

BIT	7		6	5	4	3	2	1	0
Field	DB	NC6[1:0]		REFE_	IRQ[1:0]	DO6	DI6	DIR6	PPDRV6
Reset		0b0		01	b0	0b0	0b0	0b0	0b0
Access Type	Wri	ite, Read		Write,	Read	Write, Read	Write, Read	Write, Read	Write, Read
BITFIE	LD		BITS			DE	SCRIPTION		
DBNC6			7:6	When set for GPO (DIRx = 0): DBNCx are don't care when GPO. When set for GPI (DIRx = 1): Debounce configuration. GPIx has the following debounce times rising and falling edges. 0b00 = No debounce 0b01 = 8ms 0b10 = 16ms 0b11 = 32ms				for both	
REFE_IRQ			5:4	REFE Wher Risin beha 0b00 0b01 0b10	When set for GPO (DIRx = 0): REFE_IRQx are don't care when GPO. When set for GPI (DIRx = 1): Rising edge and falling edge interrupt configuration. GPIx has the interrupt behavior which is programmed with REFE_IRQx. 0b00 = Mask interrupt 0b01 = Falling edge interrupt 0b10 = Rising edge interrupt 0b11 = Falling and rising edge interrupt				e interrupt

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
DO6	3	 When set for GPO (DIRx = 0): GPO output drive level is programmed with DOx. 0 = Logic low 1 = Logic high (DRVx = 1) and open-drain (DRVx = 0) When set for GPI (DIRx = 1): 0 = Clear DOx to 0 and set PUEx to 1 to enable the internal pull-up. 1 = Set DOx to 1 and set PDEx to 1 to enable the internal pull-down. See the <i>GPIO Programming Matrix</i> section for more information.
DI6	2	 When set for GPO (DIRx = 0): DIx is a don't care when GPO. When set for GPI (DIRx = 1): Input Drive Level. GPIOx input logic level is specified by DIx. 0 = Input logic-low 1 = Input logic-high When DIRx = 1, this bit is read only, writes to this bit are ignored.
DIR6	1	 When AMEx = 0: GPIOx direction. 0 = General purpose output (GPO) 1 = General purpose input (GPI) When AMEx = 1: When GPIO1/2/3/4 is set as an alternate mode output, write DIR1/2/3/4 (respectively) to 0 but note that the output is internally set to be active-high. When GPIO0/5/6 is set as an alternate mode input, DIR0/5/6 (respectively) determines if the signal is active high or active low. 0 = Active-low 1 = Active-high
PPDRV6	0	When set for GPO (DIRx = 0): Push-pull output drive. GPIO output configuration is determined by PPDRVx. 0 = Open-drain 1 = Push-pull When set for GPI (DIRx = 1): PPDRVx is a don't care when GPI.

CNFG_GPIO7 (0x77)

BIT	7	6	5	4	3	2	1	0
Field	DBN	NC7[1:0]	REFE_I	RQ[1:0]	DO7	DI7	DIR7	PPDRV7
Reset		0b0	01	00	0b0	0b0	0b0	0b0
Access Type	Writ	e, Read	Write,	Write, Read		Write, Read	Write, Read	Write, Read
BITFIEI	D	BITS			DE	SCRIPTION		
DBNC7		7:6	DBN0 Wher Debo rising 0b00 0b01 0b10	n set for GPO (I Cx are don't can n set for GPI (D unce configura and falling edg = No debounce = 8ms = 16ms = 32ms	re when GPO. IRx = 1): tion. GPIx has ges.	the following d	ebounce times	for both

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
REFE_IRQ	5:4	When set for GPO (DIRx = 0): REFE_IRQx are don't care when GPO. When set for GPI (DIRx = 1): Rising edge and falling edge interrupt configuration. GPIx has the interrupt behavior which is programmed with REFE_IRQx. 0b00 = Mask interrupt 0b01 = Falling edge interrupt 0b10 = Rising edge interrupt 0b11 = Falling and rising edge interrupt
DO7	3	 When set for GPO (DIRx = 0): GPO output drive level is programmed with DOx. 0 = Logic low 1 = Logic high (DRVx = 1) and open-drain (DRVx = 0) When set for GPI (DIRx = 1): 0 = Clear DOx to 0 and set PUEx to 1 to enable the internal pull-up. 1 = Set DOx to 1 and set PDEx to 1 to enable the internal pull-down. See the <i>GPIO Programming Matrix</i> section for more information.
DI7	2	 When set for GPO (DIRx = 0): DIx is a don't care when GPO. When set for GPI (DIRx = 1): Input Drive Level. GPIOx input logic level is specified by DIx. 0 = Input logic-low 1 = Input logic-high When DIRx = 1, this bit is read only, writes to this bit are ignored.
DIR7	1	 When AMEx = 0: GPIOx direction. 0 = General purpose output (GPO) 1 = General purpose input (GPI) When AMEx = 1: When GPIO1/2/3/4 is set as an alternate mode output, write DIR1/2/3/4 (respectively) to 0 but note that the output is internally set to be active-high. When GPIO0/5/6 is set as an alternate mode input, DIR0/5/6 (respectively) determines if the signal is active high or active low. 0 = Active-low 1 = Active-high
PPDRV7	0	When set for GPO (DIRx = 0): Push-pull output drive. GPIO output configuration is determined by PPDRVx. 0 = Open-drain 1 = Push-pull When set for GPI (DIRx = 1): PPDRVx is a don't care when GPI.

PUE_GPIO (0x78)

BIT	7	6	5	4	3	2	1	0
Field	PUE7	PUE6	PUE5	PUE4	PUE3	PUE2	PUE1	PUE0
Reset	0b0							
Access Type	Write, Read							

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
		GPOIx Pullup Enable 0 = Pullup disabled 1 = Pullup enabled
PUE7	7	See the GPIO Programming Matrix section for more information.
		It is recommended that users disable the pullup and pulldown resistors for GPIO7 when it operates in alternate mode.
		GPOIx Pullup Enable 0 = Pullup disabled 1 = Pullup enabled
PUE6	6	See the GPIO Programming Matrix section for more information.
		It is recommended that users disable the pullup and pulldown resistors for GPIO7 when it operates in alternate mode.
		GPOIx Pullup Enable 0 = Pullup disabled 1 = Pullup enabled
PUE5	5	See the GPIO Programming Matrix section for more information.
		It is recommended that users disable the pullup and pulldown resistors for GPIO7 when it operates in alternate mode.
		GPOIx Pullup Enable 0 = Pullup disabled 1 = Pullup enabled
PUE4	4	See the GPIO Programming Matrix section for more information.
		It is recommended that users disable the pullup and pulldown resistors for GPIO7 when it operates in alternate mode.
		GPOIx Pullup Enable 0 = Pullup disabled 1 = Pullup enabled
PUE3	3	See the GPIO Programming Matrix section for more information.
		It is recommended that users disable the pullup and pulldown resistors for GPIO7 when it operates in alternate mode.
		GPOIx Pullup Enable 0 = Pullup disabled 1 = Pullup enabled
PUE2	2	See the GPIO Programming Matrix section for more information.
		It is recommended that users disable the pullup and pulldown resistors for GPIO7 when it operates in alternate mode.
		GPOIx Pullup Enable 0 = Pullup disabled 1 = Pullup enabled
PUE1	1	See the GPIO Programming Matrix section for more information.
		It is recommended that users disable the pullup and pulldown resistors for GPIO7 when it operates in alternate mode.

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
		GPOlx Pullup Enable 0 = Pullup disabled 1 = Pullup enabled
PUE0	0	See the GPIO Programming Matrix section for more information.
		It is recommended that users disable the pullup and pulldown resistors for GPIO7 when it operates in alternate mode.

PDE_GPIO (0x79)

BIT	7	6	5	4	3	2	1	0
Field	PDE7	PDE6	PDE5	PDE4	PDE3	PDE2	PDE1	PDE0
Reset	0b0							
Access Type	Write, Read							

BITFIELD	BITS	DESCRIPTION
PDE7	7	 GPOIx Pulldown Enable 0 = Pulldown disabled 1 = Pulldown enabled See the <i>GPIO Programming Matrix</i> section for more information. It is recommended that users disable the pullup and pulldown resistors for GPIO7 when it operates in alternate mode.
PDE6	6	 GPOIx Pulldown Enable 0 = Pulldown disabled 1 = Pulldown enabled See the <i>GPIO Programming Matrix</i> section for more information. It is recommended that users disable the pullup and pulldown resistors for GPIO7 when it operates in alternate mode.
PDE5	5	 GPOIx Pulldown Enable 0 = Pulldown disabled 1 = Pulldown enabled See the <i>GPIO Programming Matrix</i> section for more information. It is recommended that users disable the pullup and pulldown resistors for GPI07 when it operates in alternate mode.
PDE4	4	 GPOIx Pulldown Enable 0 = Pulldown disabled 1 = Pulldown enabled See the <i>GPIO Programming Matrix</i> section for more information. It is recommended that users disable the pullup and pulldown resistors for GPI07 when it operates in alternate mode.

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
	_	GPOIx Pulldown Enable 0 = Pulldown disabled 1 = Pulldown enabled
PDE3	3	See the <i>GPIO Programming Matrix</i> section for more information. It is recommended that users disable the pullup and pulldown resistors for
		GPIO7 when it operates in alternate mode.
		GPOIx Pulldown Enable 0 = Pulldown disabled 1 = Pulldown enabled
PDE2	2	See the GPIO Programming Matrix section for more information.
		It is recommended that users disable the pullup and pulldown resistors for GPIO7 when it operates in alternate mode.
		GPOIx Pulldown Enable 0 = Pulldown disabled 1 = Pulldown enabled
PDE1	1	See the GPIO Programming Matrix section for more information.
		It is recommended that users disable the pullup and pulldown resistors for GPIO7 when it operates in alternate mode.
		GPOlx Pulldown Enable 0 = Pulldown disabled 1 = Pulldown enabled
PDE0	0	See the GPIO Programming Matrix section for more information.
		It is recommended that users disable the pullup and pulldown resistors for GPIO7 when it operates in alternate mode.

AME_GPIO (0x7A)

BIT	7	6	5		4	3	2	1	0
Field	AME7	AME6	AME5	5	AME4	AME3	AME2	AME1	AME0
Reset	OTP	OTP	OTP		OTP	OTP	OTP	OTP	OTP
Access Type	Write, Read	d Write, Read	Write, Re	ead	Write, Read				
BITFIEI	D	BITS	TS DESCRIPTION						
AME7		7	Alternate Mode Enable for GPIO7. 0 = Standard GPI or GPO as programmed by DIR1. 1 = Flexible power sequencer active-high Output.						
AME6		6	0	Alternate Mode Enable for GPIO6. 0 = Standard GPI or GPO as programmed by DIR4. 1 = 32kHz output (32k_OUT1)					
AME5		5	0	Alternate Mode Enable for GPIO5. 0 = Standard GPI or GPO as programmed by DIR4. 1 = 32kHz output (32k_OUT1)					
AME4	4			Alternate Mode Enable for GPIO4. 0 = Standard GPI or GPO as programmed by DIR4. 1 = 32kHz output (32k_OUT1)					

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION	
AME3	3	Alternate Mode Enable for GPIO3. 0 = Standard GPI or GPO as programmed by DIR4. 1 = ACOK input	
AME2	2	Alternate Mode Enable for GPIO2. 0 = Standard GPI or GPO as programmed by DIR1. 1 = Flexible power sequencer active-high output.	
AME1	1	Alternate Mode Enable for GPIO1. 0 = Standard GPI or GPO as programmed by DIR1. 1 = Flexible power sequencer active-high output.	
AME0	0	Alternate Mode Enable for GPIO0. 0 = Standard GPI or GPO as programmed by DIR1. 1 = Flexible power sequencer active-high output.	

CID0 (0xB0)

BIT	7	6	5	4	3	2	1	0		
Field				SR	7:0]					
Reset	OTP									
Access Type		Write, Read								
BITFIEI	D	BITS			DE	SCRIPTION				
SR		7:0	SR[2	SR[23:16] + SR[15:8] + SR[7:0] form a 24-bit serial number.						

CID1 (0xB1)

BIT	7	6	5	4	3	2	1	0		
Field				SR[[*]	15:8]					
Reset	OTP									
Access Type		Write, Read								
BITFIEI	LD	BITS			DE	SCRIPTION				
SR		7:0	SR[2	SR[23:16] + SR[15:8] + SR[7:0] form a 24-bit serial number.						

CID2 (0xB2)

BIT	7	6	5	4	3	2	1	0			
Field				SR[2	3:16]						
Reset		OTP									
Access Type		Write, Read									
BITFIEI	LD	BITS			DE	SCRIPTION					
SR		7:0	SR[23	SR[23:16] + SR[15:8] + SR[7:0] form a 24-bit serial number.							

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

CID3 (0xB3)

BIT	7	6	5	4	3	2	1	0		
Field		DIDM	4[3:0]		DIDO[3:0]					
Reset		Metal \	/ersion			0	TP			
Access Type		Write,	Read		Write, Read					
BITFIEI	LD BITS DESCRIPTION									
DIDM		7:4	4'b0	4'b0000 = Initial metal mask (device version 1) 4'b0001 = First metal revision (device version 2) 4'b0010 and above are reserved for future revisions.						
DIDO		3:0	0x1 0x2	0x0 = Preproduction device 0x1 = Production device 0x2 = Experimental device 0x3 and above are reserved for future uses.						

<u>CID4 (0xB4)</u>

BIT	7	6	5	4	3	2	1	0		
Field				DRV	/[7:0]					
Reset		OTP								
Access Type		Write, Read								
BITFIE	LD	BITS			DE	SCRIPTION				
DRV		7:0	Thes	These bits track the OTP configuration for each part.						

CNFG_BBC (0x80)

BIT	7	6	5		4	3	2	1	0		
Field	BBCRS[1:0]		BBCLOWIE N		BBCV	BBCVS[1:0]		BBCCS[1:0]			
Reset		0b01		0	Ob	00	Ot	00	0b0		
Access Type	Write, Read		Write, I	Read	Write, Read		Write	Write, Read			
BITFIELD BITS				DESCRIPTION							
BBCRS 7:6				$\begin{array}{l} 0 x 0 0 = 0.1 k \Omega \\ 0 x 0 1 = 1 k \Omega \\ 0 x 0 2 = 3 k \Omega \\ 0 x 0 3 = 6 k \Omega \end{array}$							
BBCLOWIEN		5		0 = E 1 = D	nable isable						
BBCVS 4:3			0x01 0x02	= 2.5V = 3.0V = 3.3V = 3.5V							

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION		
BBCCS	2:1	BBCLOWIEN = 0 0x00 = 50µA 0x01 = 50µA 0x02 = 50µA 0x03 = 100µA BBCLOWIEN = 1 0x00 = 200µA 0x01 = 600µA 0x10 = 800µA 0x11 = 400µA		
BBCEN	0	0 = Backup battery charger off 1 = Backup battery charger on		

<u>I2C_CTRL1 (0xC0)</u>

BIT	7	6	5	;	4	3	2	1	0		
Field	RSVD	RSVD	RSVD		PAIR	RSVD	RSVD	WD_EN	HS_EXT		
Reset	0b0	0b0	0b	0	0b0	0b0	0b0	0b0	0b0		
Access Type	Write, Rea	ad Write, Read	Write,	Read	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read		
BITFIE	LD	BITS			DESCRIPTION						
RSVD		7	Reserved. Unutilized bit. Write to 0. Reads are don't care.								
RSVD		6	Reserved. Unutilized bit. Write to 0. Reads are don't care.								
RSVD		5	Reserved. Unutilized bit. Write to 0. Reads are don't care.								
PAIR		4	 0 = Pair address mode is disabled and sequential mode is used for multiple register write protocol. 1 = Pair address mode is enabled for multiple register write protocol. 								
RSVD		3	Reserved. Unutilized bit. Write to 0. Reads are don't care.								
RSVD		2 R			Reserved. Unutilized bit. Write to 0. Reads are don't care.						
WD_EN		1	1 0 = Watchdog function is disabled (I ² C Rev 4.0 compliant) 1 = Watchdog function is enabled (SMBus compatible)								
HS_EXT	0			0 = HS-mode extension is disabled (I ² C Rev 4.0 compliant) 1 = HS-mode extension is enabled. HS-mode is enabled without HS-mode entrace code and keeps HS-mode during and after STOP condition.							

<u>I2C_CTRL2 (0xC1)</u>

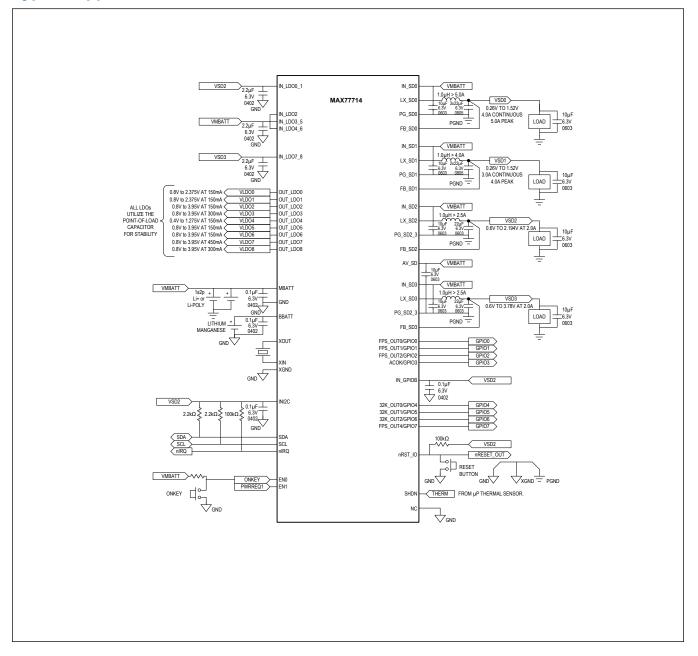
BIT	7		6	5		4	3	2	1	0
Field	RSVD		RSVD	RS	٧D	RSVD	RSVD	RSVD	RSVD	I2CWP
Reset	0b0		0b0	0b0		0b0	0b0	0b0	0b0	0b0
Access Type	Write, Re	ad	d Write, Read		Read	Write, Read	Write, Read	Write, Read	Write, Read	Write, Read
BITFIELD BITS			DESCRIPTION							
RSVD		7			Reserved. Unutilized bit. Write to 0. Reads are don't care.					
RSVD		6		Reserved. Unutilized bit. Write to 0. Reads are don't care.						
RSVD		5		Reserved. Unutilized bit. Write to 0. Reads are don't care.						
RSVD		4		Reserved. Unutilized bit. Write to 0. Reads are don't care.						
RSVD		3		Rese	rved. Unutilized	bit. Write to 0	. Reads are do	n't care.		

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

BITFIELD	BITS	DESCRIPTION
RSVD	2	Reserved. Unutilized bit. Write to 0. Reads are don't care.
RSVD	1	Reserved. Unutilized bit. Write to 0. Reads are don't care.
I2CWP	0	 0 = Disable write protect for all registers in the PMIC. Writes to any register through the I²C write protocol results in the data value being written to the register. 1 = Enable write protect for all registers in the PMIC. Writes to any register through the I²C write protocol does NOT result in the data value being written to the register. The STOP condition at the end of an I²C transaction resets this bit back to its default value.

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Typical Application Circuit



Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Ordering Information

PART NUMBER	TEMP. RANGE	PIN-PACKAGE
MAX77714EWC+T	-40°C to +85°C	70-Bump, 0.4mm Pitch, WLP, 4.1mm x 3.25mm x 0.7mm; CID4 = 0x01
MAX77714FEWC+T	-40°C to +85°C	70-Bump, 0.4mm Pitch, WLP, 4.1mm x 3.25mm x 0.7mm; CID4 = 0x06
MAX77714FEWC+	-40°C to +85°C	70-Bump, 0.4mm Pitch, WLP, 4.1mm x 3.25mm x 0.7mm; CID4 = 0x06
MAX77714GEWC+	-40°C to +85°C	70-Bump, 0.4mm Pitch, WLP, 4.1mm x 3.25mm x 0.7mm; CID4 = 0x08
MAX77714GEWC+T	-40°C to +85°C	70-Bump, 0.4mm Pitch, WLP, 4.1mm x 3.25mm x 0.7mm; CID4 = 0x08

+Denotes a lead(Pb)-free/RoHS-compliant package.

T = Tape and reel.

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	4/18	Initial release	—
1	7/19	Updated <i>Simplified Block Diagram</i> and TOC36, added MAX77714F to the <i>Ordering Information</i> table, and indicated which bits are OTP programmable in the <i>Register Map</i> tables	2, 39, 81–83, 97, 100–104, 106–119, 121, 123–150, 163–166, 170
2	2/22	Updated Ordering Information table	166
3	11/22	Updated Table 1	42, 43



Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.